INCH-POUND
MIL-M-38510/315D
27 October 2003
SUPERSEDING
MIL-M-38510/315C
17 JANUARY 1984

MILITARY SPECIFICATION

MICROCIRCUITS, DIGITAL, LOW-POWER SCHOTTKY TTL, COUNTERS, MONOLITHIC SILICON

Inactive for new design after 18 April 1997.

This specification is approved for use by all Departments and Agencies of the Department of Defense.

The requirements for acquiring the product herein shall consist of this specification sheet and MIL-PRF 38535

1. SCOPE

1.1 Scope. This specification covers the detail requirements for monolithic silicon, low power Schottky TTL, binary and decade counters. Two product assurance classes and a choice of case outlines/lead finish are provided for each type and are reflected in the complete part number. For this product, the requirements of MIL-M-38510 have been superseded by MIL-PRF-38535, (see 6.3).

1.2 Part or Identifying Number (PIN). The PIN should be in accordance with MIL-PRF-38535, and as specified herein.

1.2.1 Device types. The device types should be as follows:

Device type	Circuit
01	Decade counter
02	4-bit binary counter
03	Synchronous 4-bit decade counter (asynchronous clear)
04	Synchronous 4-bit binary counter (asynchronous clear)
05	Synchronous 4-bit up/down decade counter
06	Synchronous 4-bit up/down binary counter
07	Synchronous 4-bit up/down decade counter (with clear)
08	Synchronous 4-bit up/down binary counter (with clear)
09	Synchronous 4-bit up/down binary counter (with mode control)
10	Divide-by-twelve counter
11	Synchronous 4-bit decade counter (with synchronous clear)
12	Synchronous 4-bit binary counter (with synchronous clear)
13	Synchronous 4-bit decade counter (with mode control)

1.2.2 Device class. The device class should be the product assurance level as defined in MIL-PRF-38535.

Comments, suggestions, or questions on this document should be addressed to: Commander, Defense Supply Center Columbus, ATTN: DSCC-VAS, 3990 East Broad St., Columbus, OH 43216-5000, or emailed to bipolar@dscc.dla.mil. Since contact information can change, you may want to verify the currency of this address information using the ASSIST Online database at www.dodssp.daps.mil.

1.2.3 Case outlines. The case outlines should be as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	Terminals	Package style
A	GDFP5-F14 or CDFP6-F14	14	Flat pack
B	GDFP4-F14	14	Flat pack
C	GDIP1-T14 or CDIP2-T14	14	Dual-in-line
D	GDFP1-F14 or CDFP2-F14	14	Flat pack
E	GDIP1-T16 or CDIP2-T16	16	Dual-in-line
F	GDFP2-F16 or CDFP3-F16	16	Flat pack
2	CQCC1-N20	20	Square leadless chip carrier

1.3 Absolute maximum ratings.

Supply voltage range ..... -0.5 V dc to 7.0 V dc
Input voltage range ..... -1.2 V dc at -18 mA to 5.5 V dc
Storage temperature range ..... -65° to +150°C
Maximum power dissipation, (P_D) 1/ :
  Device type 05, 06, 07, 08..... 187 mW
  Device type 01, 02, 10..... 83 mW
  Device type 03, 04, 11, 12..... 176 mW
  Device type 09, 13 ..... 193 mW
Lead temperature (soldering, 10 seconds) ..... 300°C
Thermal resistance, junction to case (θ_{JC}):
  Cases A, B, C, D, E, F, and 2 (See MIL-STD-1835)
Junction temperature (T_J) 3/..... 175°C

1.4 Recommended operating conditions. 2/

Maximum low level output current (I_{oL}) ..... 4.0 mA
Supply voltage (V_{CC}) ..... 4.5 V dc minimum to 5.5 V dc maximum
Minimum high-level input voltage (V_{IH}) ..... 2.0 V dc
Maximum low-level input voltage (V_{IL}) ..... 0.7 V dc
Normalized fanout (each output)
  Types 01, 02, 05, 06, 07, 08, 10..... 10 maximum
  Types 03, 04, 09, 11, 12, 13.....
    Low-level ..... 10 maximum
    High-level ..... 20 maximum
Width of input count pulse, t_p(IN)
  Types 01, 02, 10
    Input A, reset..... 15 ns minimum
    Input B..... 30 ns minimum
  Types 07, 08 ..... 20 ns minimum
Width of reset pulse, t_p(reset)
  Types 01, 02, 10 ..... 25 ns minimum
Count enable time
  Type 09, enable ..... 40 ns minimum

1/ Must withstand the added P_D due to short-circuit test (e.g., I_{OS}).
2/ A change of states on the U/$\overline{D}$ input for device types 09 and 13 is not recommended when the clock input is low. This may result in an erroneous count.
3/ Maximum junction temperature shall not be exceeded except for allowable short duration burn-in screening conditions in accordance with MIL-PRF-38535.

Input clock frequency, f_{clock}
- Types 01, 02, 10
  - Input A ..... 0 to 29 MHz
- Types 03, 04, 11, 12 ..... 0 to 22 MHz
- Types 09, 13 ..... 0 to 18 MHz
- Types 07, 08 ..... 0 to 20 MHz
- Types 05, 06 ..... 0 to 25 MHz

Width of clock pulse, t_w(clock)
- Types 03, 06, 09, 11, 12, 13 ..... 25 ns minimum
- Types 04 ..... 30 ns minimum
- Types 05 ..... 20 ns minimum

Width of clear pulse, t_w (clear)
- Types 03, 04, 05, 06, 07, 08, 11, 12 ..... 20 ns minimum

Setup time, $t_{(setup)}$
- Types 03, 11, 12
  - Enable P ..... 25 ns minimum
  - Load ..... 25 ns minimum
  - Clear (types 11 and 12 only) ..... 20 ns minimum
- Type 04
  - Enable P ..... 35 ns minimum
  - Load ..... 35 ns minimum
  - Data inputs
    - Types 03, 09, 11, 12, 13 ..... 20 ns minimum
    - Type 04 ..... 25 ns minimum
    - Types 07, 08 ..... 30 ns minimum
- Type 05
  - Data, L inputs ..... 15 ns minimum
  - $U/\overline{D}$ input ..... 30 ns minimum
  - EP, ET inputs ..... 15 ns minimum
- Type 06
  - Data, L inputs ..... 25 ns minimum
  - $U/\overline{D}$ input ..... 30 ns minimum
  - EP, ET, inputs ..... 25 ns minimum

Hold time at any input, $t_{(hold)}$
- Types 09, 13 ..... 0 ns minimum
- Types 07, 08 ..... 10 ns minimum
- Types 05, 06
  - Data, EP, ET inputs ..... 5 ns minimum
  - L, $U/\overline{D}$ inputs ..... 0 ns minimum
- Types 03, 04, 11, 12 ..... 10 ns minimum
- Types 03, 04, 11, 12 t_W (clear) ..... 0 ns minimum

Case operating temperature range (T_c) ..... -55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 General. The documents listed in this section are specified in sections 3, 4, or 5 of this specification. This section does not include documents cited in other sections of this specification or recommended for additional information or as examples. While every effort has been made to ensure the completeness of this list, document users are cautioned that they must meet all specified requirements of documents cited in sections 3, 4, or 5 of this specification, whether or not they are listed.

2.2 Government documents.

2.2.1 Specifications and Standards. The following specifications and standards form a part of this specification to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATIONS

MIL-PRF-38535 - Integrated Circuits (Microcircuits) Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard for Microelectronics.
MIL-STD-1835 - Interface Standard Electronic Component Case Outlines

(Copies of these documents are available online at http://assist.daps.dla.mil;quicksearch/ or www.dodssp.daps.mil or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.3 Order of precedence. In the event of a conflict between the text of this specification and the references cited herein, the text of this document takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Qualification. Microcircuits furnished under this specification shall be products that are manufactured by a manufacturer authorized by the qualifying activity for listing on the applicable qualified manufacturers list before contract award (see 4.3 and 6.4).

3.2 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

3.3 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein.

3.3.1 Terminal connections and logic diagrams. The terminal connections and logic diagrams shall be as specified on figures 1 and 2.

3.3.2 Truth tables. The truth tables and logic equations shall be as specified on figure 3.

3.3.4 Schematic circuits. The schematic circuits shall be maintained by the manufacturer and made available to the qualifying activity and the preparing activity (DSCC-VAS) upon request.

3.3.5 Case outlines. The case outlines shall be as specified in 1.2.3.

3.4 Lead material and finish. The lead material and finish shall be in accordance with MIL-PRF-38535 (see 6.6).

3.5 Electrical performance characteristics. The electrical performance characteristics are as specified in table I, and apply over the full recommended case operating temperature range, unless otherwise specified.

3.6 Electrical test requirements. The electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.

3.7 Marking. Marking shall be in accordance with MIL-PRF-38535.

3.8 Microcircuit group assignment. The devices covered by this specification shall be in microcircuit group number 12 (see MIL-PRF-38535, appendix A).

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not effect the form, fit, or function as described herein.

4.2 Screening. Screening shall be in accordance with MIL-PRF-38535 and shall be conducted on all devices prior to qualification and quality conformance inspection. The following additional criteria shall apply:

a. The burn-in test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.

b. Interim and final electrical test parameters shall be as specified in table II, except interim electrical parameters test prior to burn-in is optional at the discretion of the manufacturer.

c. Additional screening for space level product shall be as specified in MIL-PRF-38535, appendix B.

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions $-55°C \leq T_C \leq +125°C$ unless otherwise specified	Device types	Limits		Unit
				Min	Max	
Low-level output voltage	V_{OL}	V_{CC} = 4.5 V, V_{IH} = 2.0 V V_{IL} = 0.7 V, I_{OL} = 4 mA 1/	All	-	0.4	V
High-level output voltage	V_{OH}	V_{CC} = 4.5 V, V_{IH} = 2.0 V V_{IL} = 0.7 V, I_{OH} = -400m µA	All	2.5	-	V
Input clamp voltage	V_{IC}	T_C = 25°C, V_{CC} = 4.5 V I_{IN} = -18 mA	All	-	-1.5	V
Low-level input current at reset inputs	I_{IL1}	V_{CC} = 5.5 V, V_{IN} = 0.4 V	01, 02, 10	-30	-400	µA
Low-level input current at input A	I_{IL2}		01, 02, 10	-0.5	-2.4	mA
Low-level input current at input B	I_{IL3}		01, 10	-0.4	-3.2	mA
			02	-0.4	-1.6	mA
Low-level input current at data, clear, EnP	I_{IL4}		03, 04	-30	-400	µA
Low-level input current at data, EnP	I_{IL4}		01, 12	-30	-400	µA
Low-level input current at clear	I_{IL4}		01, 12	-30	-760	µA
Low-level input current at load	I_{IL5}		03, 04, 11, 12	-30	-800	µA
Low-level input current at EnT	I_{IL5}		03, 04, 11, 12	-30	-860	µA
Low-level input current at clock	I_{IL6}		03, 04,	0	-.630	mA
			11, 12			
Low-level input current at EnG	I_{IL7}		09	-.15	-1.08	mA
			13	-.36	-1.08	
Low-level input current at data, clock, down/up	I_{IL8}		09, 13	-120	-400	µA
Low-level input current at load	I_{IL8}		09, 13	-100	-400	µA
Low-level input current at data	I_{IL9}		07, 08	-100	-400	µA
Low-level input current at load	I_{IL10}		07, 08	-100	-400	µA
Low-level input current at clear, count up, count down	I_{IL11}		07, 08	-120	-400	µA
Low-level input current at data	I_{IL12}		05, 06	-3.0	-400	µA
Low-level input current at clock, down/up	I_{IL13}		05, 06	-135	-370	µA
Low-level input current at EP	I_{IL14}		05, 06	-150	-385	µA
Low-level input current at ET	I_{IL15}		05, 06	-280	-760	µA

See footnotes at end of table.

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions $-55°C \leq T_C \leq +125°C$ unless otherwise specified	Device types	Limits		Unit
				Min	Max	
High-level input current at reset inputs	I_{IH1}	V_{CC} = 5.5 V, V_{IN} = 2.7 V	01, 02 10	-	20	µA
High-level input current at reset inputs	I_{IH2}	V_{CC} = 5.5 V, V_{IN} = 5.5 V	01, 02 10	-	100	µA
High-level input current at input A	I_{IH3}	V_{CC} = 5.5 V, V_{IN} = 2.7 V	01, 02 10	-	80	µA
High-level input current at input A	I_{IH4}	V_{CC} = 5.5 V, V_{IN} = 5.5 V	01, 02, 10	-	400	µA
High-level input current at input B	I_{IH5}	V_{CC} = 5.5 V, V_{IN} = 2.7 V	01	-	160	µA
			02, 10	-	80	
High-level input current at input B	I_{IH6}	V_{CC} = 5.5 V, V_{IN} = 5.5 V	01	-	800	µA
			02, 10	-	400	
High-level input current at load, clock, EnT	I_{IH9}	V_{CC} = 5.5 V, V_{IN} = 2.7 V	03, 04, 11, 12	-	40	µA
High-level input current at load, clock, EnT	I_{IH10}	V_{CC} = 5.5 V, V_{IN} = 5.5 V	03, 04, 11, 12	-	200	µA
High-level input current at data, EnP	I_{IH11}	V_{CC} = 5.5 V, V_{IN} = 2.7 V	03, 04, 11, 12	-	20	µA
High-level input current at data, EnP	I_{IH12}	V_{CC} = 5.5 V, V_{IN} = 5.5 V	03, 04, 11, 12	-	100	µA
High-level input current at clear	I_{IH13}	V_{CC} = 5.5 V, V_{IN} = 2.7 V	03, 04,	-	20	µA
			11, 12	-	40	
High-level input current at clear	I_{IH14}	V_{CC} = 5.5 V, V_{IN} = 5.5 V	03, 04	-	100	µA
			11, 12	-	200	
High-level input current at EnG	I_{IH15}	V_{CC} = 5.5 V, V_{IN} = 2.7 V	09, 13	-	60	µA
High-level input current at EnG	I_{IH16}	V_{CC} = 5.5 V, V_{IN} = 5.5 V	09, 13	-	300	µA
High-level input current at data, load, clear, count up, count down, clock, down/up	I_{IH17}	V_{CC} = 5.5 V, V_{IN} = 2.7 V	05, 06 07, 08 09, 13	-	20	µA
High-level input current at data, load, clear, count up, count down, clock, down/up	I_{IH18}	V_{CC} = 5.5 V, V_{IN} = 5.5 V	05, 06 07, 08 09, 13	-	100	µA
High-level input current at ET	I_{IH19}	V_{CC} = 5.5 V, V_{IN} = 2.7 V	05, 06	-	40	µA

See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions $-55°C \le T_C \le +125°C$ unless otherwise specified	Device types	Limits		Unit
				Min	Max	
High-level input current at ET	I_{IH20}	V_{CC} = 5.5 V, V_{IN} = 5.5 V	05, 06	-	200	µA
Short circuit output current	I_{OS}	V_{CC} = 5.5 V 2/	All	-15	-130	mA
Supply current	I_{CC}	V_{CC} = 5.5 V	01,02,10		15	mA
			05,06,07,08		34	
			09, 13		35	
High-level supply current	I_{CCH}	V_{CC} = 5.5 V, 3/	03, 04, 11, 12	-	31	mA
High-level supply current	I_{CCH}	V_{CC} = 5.5 V, 3/	03, 04 11, 12	-	31	mA
Low-level supply current	I_{CCL}	V_{CC} = 5.5 V, 4/	03, 04 11, 12	-	32	mA
Maximum input A, clock, or count up frequency	F_{MAX}	V_{CC} = 5.0 V, C_L = 50 pF, ±10% R_L = 2 kΩ	05, 06 01, 02, 10	25 29	-	MHz
			03, 04, 07, 08, 11, 12	22		
			09, 13	18	-	
Propagation delay time, high to low, A to Q_C	t_{PHL1}		01,02,10	3	81	ns
Propagation delay time, low to high, A to Q_C	t_{PLH1}		01, 10	3	74	ns
			02	3	74	
Propagation delay time, high to low, B to Q_D	t_{PHL2}		01, 10	3	56	ns
			02	3	78	
Propagation delay time, low to high, B to Q_D	t_{PLH2}		01, 10	3	52	ns
			02	3	78	
Propagation delay time, low to high, clock to carry	t_{PLH4}		03, 04, 11, 12	3	56	ns
Propagation delay time, high to low, clock to carry	t_{PHL4}		03, 04, 11, 12	3	56	ns

See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions $-55°C \le T_C \le +125°C$ unless otherwise specified	Device types	Limits		Unit
				Min	Max	
Propagation delay time, low to high, clock to Q	t_{PLH5}	V_{CC} = 5.0 V, C_L = 50 pF, ±10% R_L = 2 kΩ	03, 04, 11, 12	3	41	ns
Propagation delay time, high to high, clock to Q	t_{PHL5}		03, 04, 11, 12	3	45	ns
Propagation delay time, low to high, clock to Q	t_{PLH5}		05, 06	3	26	ns
Propagation delay time, high to low, clock to Q	t_{PHL5}		05	3	26	ns
			06	3	36	
Propagation delay time, low to high, clock (data) to Q	t_{PLH6}		03, 04, 11, 12	3	42	ns
Propagation delay time, high to low, clock (data) to Q	t_{PHL6}		03, 04, 11, 12	3	48	ns
Propagation delay time, low to high, EnT to carry	t_{PLH7}		03, 04, 11, 12	3	28	ns
Propagation delay time, high to low, EnT to carry	t_{PHL7}		03, 04, 11, 12	3	28	ns
Propagation delay time, low to high, ET to RC	t_{PLH7}		05	3	18	ns
			06	3	28	
Propagation delay time, high to low, ET to RC	t_{PHL7}		05	3	28	ns
			06	3	32	
Propagation delay time, high to low, clear to Q	t_{PHL8}		03, 04, 11, 12	3	46	ns
Propagation delay time, low to high, load to Q	t_{PLH8}		07, 08	3	63	ns
Propagation delay time, high to low, load to Q	t_{PHL10}		07, 08	3	63	ns
Propagation delay time, low to high, counts up and down to Q, U/$\overline{D}$ to RC	t_{PLH9}		07, 08	3	60	ns
			05	3	26	
			06	3	32	

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions $-55°C \leq T_C \leq +125°C$ unless otherwise specified	Device types	Limits		Unit
				Min	Max	
Propagation delay time, high to low, counts up and down to Q, U/$\overline{D}$ to RC	t_{PHL11}	V_{CC} = 5.0 V, C_L = 50 pF, ±10% R_L = 2 kΩ	07, 08	3	73	ns
			05	3	33	
			06	3	37	
Propagation delay time, high to low, clear to Q	t_{PHL12}		07, 08	3	56	ns
Propagation delay time, low to high, load to Q	t_{PLH10}		09, 13	3	53	ns
Propagation delay time, high to low, load to Q	t_{PHL13}		09, 13	3	77	ns
Propagation delay time, low to high, clock to Q	t_{PLH11}		09, 13	3	41	ns
Propagation delay time, high to low, clock to Q	t_{PHL14}		09, 13	3	57	ns
Propagation delay time, low to high, clock to Max Min	t_{PLH12}		09, 13	3	66	ns
Propagation delay time, low to high, clock to ripple carry	t_{PLH12}		05	3	35	ns
			06	3	38	
Propagation delay time, high to low, clock to Max Min	t_{PHL15}		09, 13	3	80	ns
Propagation delay time, high to low, clock to ripple carry	t_{PHL15}		05	3	37	ns
			06	3	40	

1/ Use $I_{OL} + I_{IL3(Max)}$ for V_{OL} test on Q_A.

2/ Not more than one output should be shorted at a time.

3/ I_{CCH} is measured : (a) With the load input high; and (b) Then again with the load input low with all other inputs high and all outputs open.

4/ I_{CCL} is measured: (a) With the clock input high; and (b) Then again with the clock input low with all other inputs low and all outputs open.

TABLE II. Electrical test requirements.

MIL-PRF-38535 test requirements	Subgroups (see table III)	
	Class S devices	Class B devices
Interim electrical parameters	1	1
Final electrical test parameters	1*, 2, 3, 7, 9, 10, 11	1*, 2, 3, 7, 9
Group A test requirements	1, 2, 3, 7, 8, 9, 10, 11	1, 2, 3, 7, 8, 9, 10, 11
Group B test when using the method 5005 QCI option	1, 2, 3, 7 8, 9, 10, 11	N/A
Group C end-point electrical parameters	1, 2, 3, 7, 8 9, 10, 11	1, 2, 3
Group D end-point electrical parameters	1, 2, 3	1, 2, 3

*PDA applies to subgroup 1.

4.3 Qualification inspection. Qualification inspection shall be in accordance with MIL-PRF-38535 .

4.4 Technology Conformance inspection (TCI). Technology conformance inspection shall be in accordance with MIL-PRF-38535 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).

4.4.1 Group A inspection. Group A inspection shall be in accordance with table III of MIL-PRF-38535 and as follows:

a. Tests shall be as specified in table II herein.

b. Subgroups 4, 5, and 6 shall be omitted.

4.4.2 Group B inspection. Group B inspection shall be in accordance with table II MIL-PRF-38535.

4.4.3 Group C inspection. Group C inspection shall be in accordance with table IV of MIL-PRF-38535 and as follows:

a. End-point electrical parameters shall be as specified in table II herein.

b. The steady-state life test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.

4.4.4 Group D inspection. Group D inspection shall be in accordance with table V of MIL-PRF-38535. End-point electrical parameters shall be as specified in table II herein.

4.5 Methods of inspection. Methods of inspection shall be specified and as follows:

4.5.1 Voltage and current. All voltages given are referenced to the microcircuit ground terminal. Currents given are conventional and positive when flowing into the referenced terminal.

Pin number	Device type 01		Device type 02		Device type 03		Device type 04	
	CASES							
	A, B, C, and D	2	A, B, C, and D	2	E,F	2	E,F	2
1	BD INPUT	N/C	INPUT B	N/C	CLEAR	N/C	CLEAR	N/C
2	$R_O^{(1)}$	BD INPUT	$R_{O(1)}$	INPUT B	CLOCK	CLEAR	CLOCK	CLEAR
3	$R_O^{(2)}$	$R_O^{(1)}$	$R_{O(2)}$	$R_O^{(1)}$	INPUT A	CLOCK	INPUT A	CLOCK
4	NC	$R_O^{(2)}$	NC	$R_O^{(2)}$	INPUT B	INPUT A	INPUT B	INPUT A
5	V_{CC}	N/C	V_{CC}	N/C	INPUT C	INPUT B	INPUT C	INPUT B
6	$R_{9(1)}$	N/C	NC	N/C	INPUT D	N/C	INPUT D	N/C
7	$R_{9(2)}$	N/C	NC	N/C	ENABLE P	INPUT C	ENABLE P	INPUT C
8	OUTPUT C	V_{CC}	OUTPUT C	V_{CC}	GND	INPUT D	GND	INPUT D
9	OUTPUT B	$R_9^{(1)}$	OUTPUT B	N/C	LOAD	ENABLE P	LOAD	ENABLE P
10	GND	$R_9^{(2)}$	GND	N/C	ENABLE T	GND	ENABLE T	GND
11	OUTPUT D	N/C	OUTPUT D	N/C	Q_D	N/C	Q_D	N/C
12	OUTPUT A	OUTPUT C	OUTPUT A	OUTPUT C	Q_C	LOAD	Q_C	LOAD
13	NC	OUTPUT B	NC	OUTPUT B	Q_B	T	Q_B	T
14	INPUT A	GND	INPUT A	GND	Q_A	Q_D	Q_A	Q_D
15		N/C		N/C	CARRY OUTPUT	Q_C	CARRY OUTPUT	Q_C
16		OUTPUT D		OUTPUT D	V_{CC}	N/C	V_{CC}	N/C
17		N/C		N/C		Q_B		Q_B
18		OUTPUT A		OUTPUT A		Q_A		Q_A
19		N/C		N/C		CARRY OUTPUT		CARRY OUTPUT
20		INPUT A		INPUT A		V_{CC}		V_{CC}

FIGURE 1. Terminal connections.

Pin number	Device type 05		Device type 06		Device type 07		Device type 08	
	CASES							
	E, F	2	E, F	2	E, F	2	E, F	2
1	$U/\overline{D}$	N/C	$U/\overline{D}$	N/C	DATA B INPUT	N/C	DATA B INPUT	N/C
2	CK	$U/\overline{D}$	CK	$U/\overline{D}$	Q_B	DATA B INPUT	Q_B	DATA B INPUT
3	INPUT A	CK	INPUT A	CK	Q_A	Q_B	Q_A	Q_B
4	INPUT B	INPUT A	INPUT B	INPUT A	COUNT DOWN	Q_A	COUNT DOWN	Q_A
5	INPUT C	INPUT B	INPUT C	INPUT B	COUNT UP	COUNT DOWN	COUNT UP	COUNT DOWN
6	INPUT D	N/C	INPUT D	N/C	Q_C	N/C	Q_C	N/C
7	ENABLE P	INPUT C	ENABLE P	INPUT C	Q_D	COUNT UP	Q_D	COUNT UP
8	GND	INPUT D	GND	INPUT D	GND	Q_C	GND	Q_C
9	LOAD	ENABLE P	LOAD	ENABLE P	DATA D	Q_D	DATA D	Q_D
10	ENABLE T	GND	ENABLE T	GND	DATA C	GND	DATA C	GND
11	Q_D	N/C	Q_D	N/C	LOAD	N/C	LOAD	N/C
12	Q_C	LOAD	Q_C	LOAD	CARRY	DATA D	CARRY	DATA D
13	Q_B	ENABLE T	Q_B	ENABLE T	BORROW	DATA C	BORROW	DATA C
14	Q_A	Q_D	Q_A	Q_D	CLEAR	LOAD	CLEAR	LOAD
15	RIPPLE CARRY OUTPUT	Q_C	RIPPLE CARRY OUTPUT	Q_C	DATA A	CARRY	DATA A	CARRY
16	V_{CC}	N/C	V_{CC}	N/C	V_{CC}	N/C	V_{CC}	N/C
17		Q_B		Q_B		BORROW		BORROW
18		Q_A		Q_A		CLEAR		CLEAR
19		RC OUTPUT		RC OUTPUT		DATA A		DATA A
20		V_{CC}		V_{CC}		V_{CC}		V_{CC}

FIGURE 1. Terminal connections - Continued.

Pin number	Device type 09		Device type 10		Device type 11		Device type 12	
	CASES							
	E, F	2	A,B C, and D	2	E, F	2	E, F	2
1	DATA B	N/C	INPUT BC	N/C	CLEAR	N/C	CLEAR	N/C
2	Q_B	DATA B	NC	INPUT BC	CLOCK	CLEAR	CLOCK	CLEAR
3	Q_A	Q_B	NC	N/C	INPUT A	CLOCK	INPUT A	CLOCK
4	ENABLE G	Q_A	NC	N/C	INPUT B	INPUT A	INPUT B	INPUT A
5	DOWN UP	ENABLE G	V_{CC}	N/C	INPUT C	INPUT B	INPUT C	INPUT B
6	Q_C	N/C	$R_{O(1)}$	N/C	INPUT D	N/C	INPUT D	N/C
7	Q_D	DOWN UP	$R_{O(2)}$	N/C	ENABLE P	INPUT C	ENABLE P	INPUT C
8	GND	Q_C	OUTPUT D	V_{CC}	GND	INPUT D	GND	INPUT D
9	DATA D	Q_D	OUTPUT C	R_O (1)	LOAD	ENABLE P	LOAD	ENABLE P
10	DATA C	GND	GND	R_O (2)	ENABLE T	GND	ENABLE T	GND
11	LOAD	N/C	OUTPUT B	N/C	Q_D	N/C	Q_D	N/C
12	MAX/ MIN	DATA D	OUTPUT A	OUTPUT D	Q_C	LOAD	Q_C	LOAD
13	RIPPLE CLOCK	DATA C	NC	OUTPUT C	Q_B	T	Q_B	T
14	CLOCK	LOAD	INPUT A	GND	Q_A	Q_D	Q_A	Q_D
15	DATA A	MAX/ MIN		N/C	CARRY OUTPUT	Q_C	CARRY OUTPUT	Q_C
16	V_{CC}	N/C		OUTPUT B	V_{CC}	N/C	V_{CC}	N/C
17		R_C		N/C		Q_B		Q_B
18		CLOCK		OUTPUT A		Q_A		Q_A
19		DATA A		N/C		CARRY OUTPUT		CARRY OUTPUT
20		V_{CC}		INPUT A		V_{CC}		V_{CC}

FIGURE 1. Terminal connections - Continued.

Pin number	Device type 13	
	CASES	
	E, F	2
1	DATA B	N/C
2	Q_B	DATA B
3	Q_A	Q_B
4	ENABLE G	Q_A
5	DOWN UP	ENABLE G
6	Q_C	N/C
7	Q_D	DOWN UP
8	GND	Q_C
9	DATA D	Q_D
10	DATA C	GND
11	LOAD	N/C
12	MAX/ MIN	DATA D
13	RIPPLE CLOCK	DATA C
14	CLOCK	LOAD
15	DATA A	MAX/ MIN
16	V_{CC}	N/C
17		R_C
18		CLOCK
19		DATA A
20		V_{CC}

FIGURE 1. Terminal connections - Continued

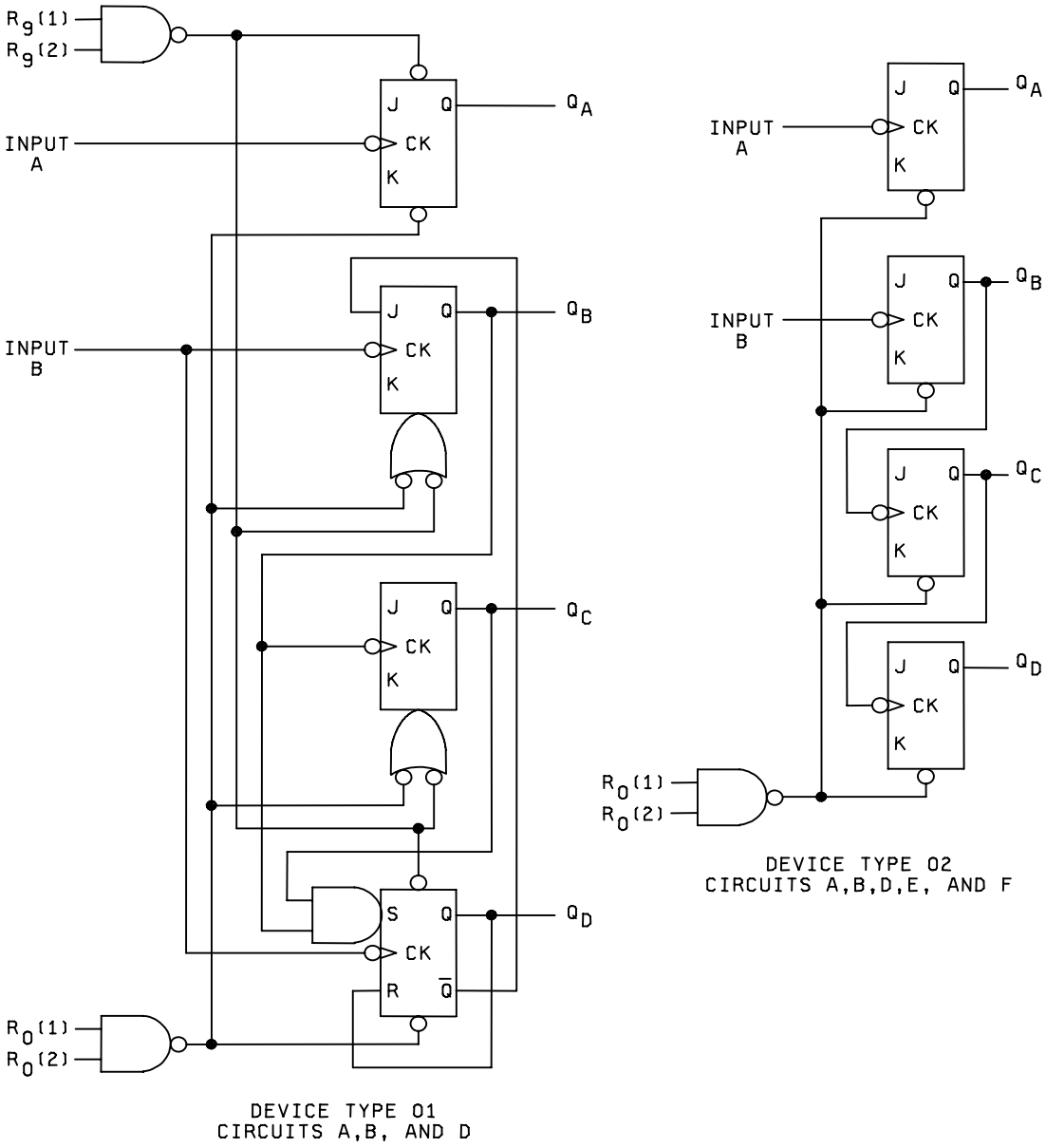


FIGURE 2. Logic diagrams

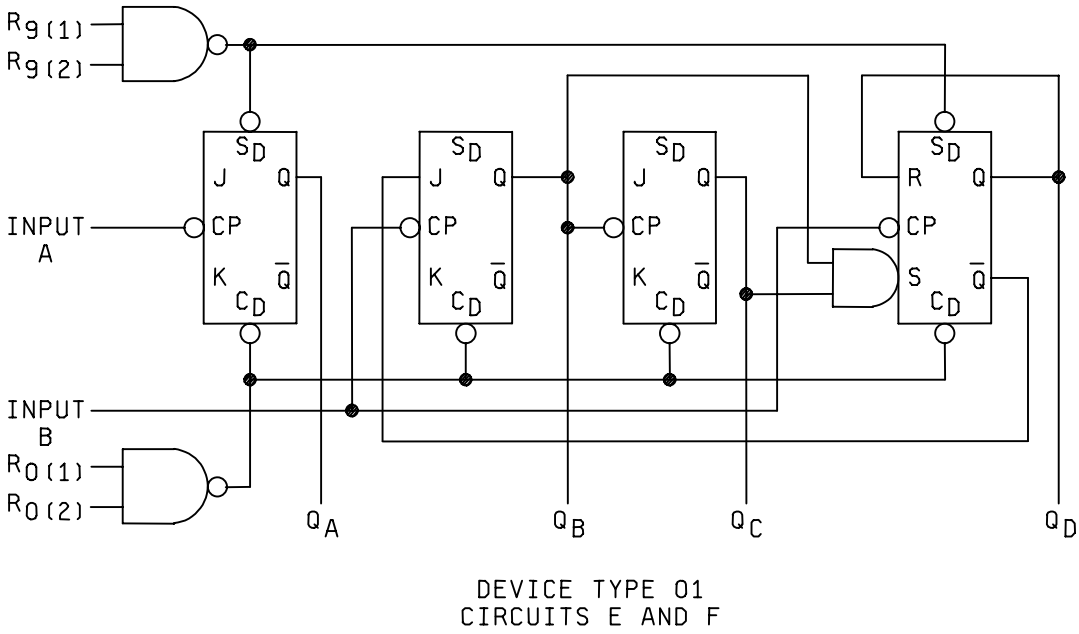
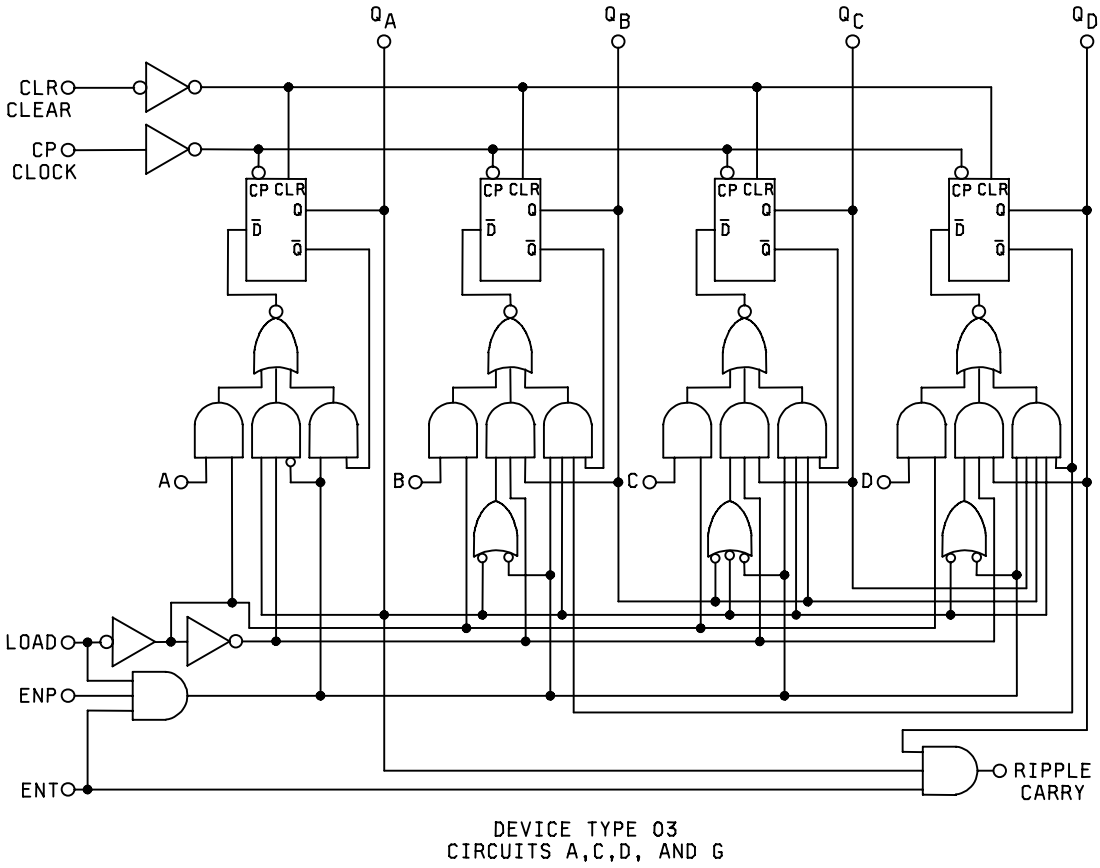


FIGURE 2. Logic diagrams – Continued.



DEVICE TYPE 03
CIRCUITS A,C,D, AND G

FIGURE 2. Logic diagrams – Continued.

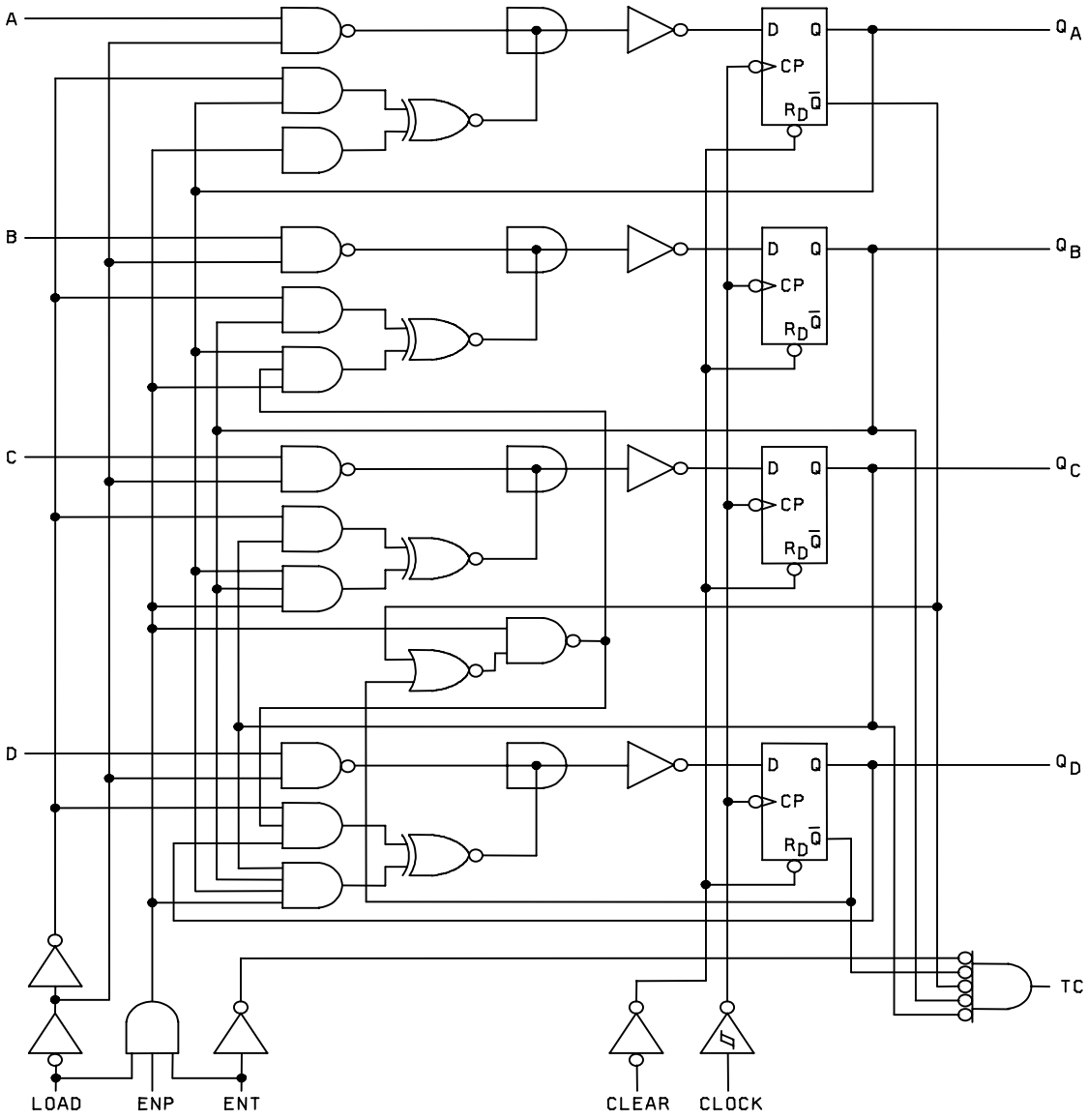


FIGURE 2. Logic diagrams – Continued.

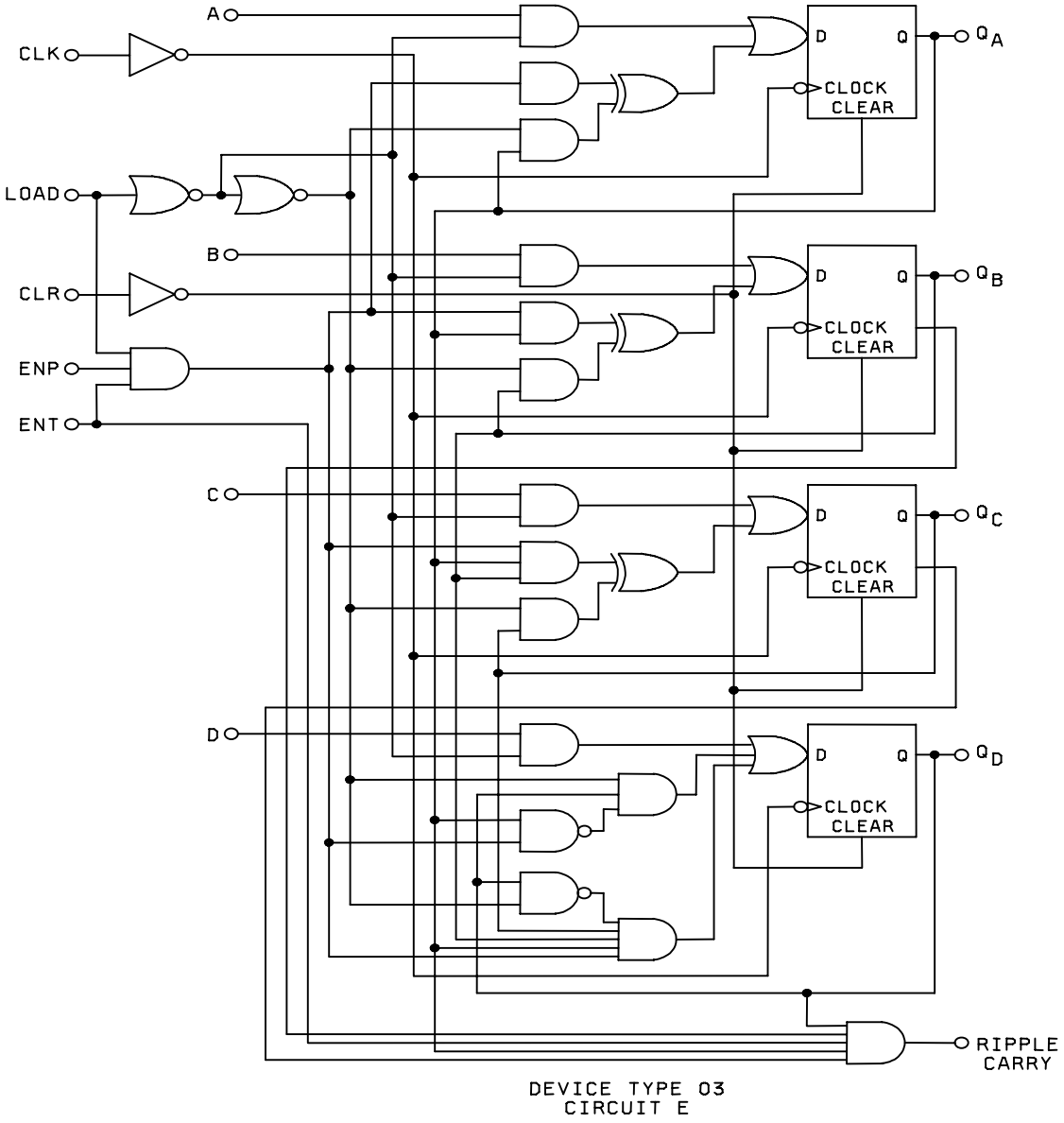


FIGURE 2. Logic diagrams – Continued.

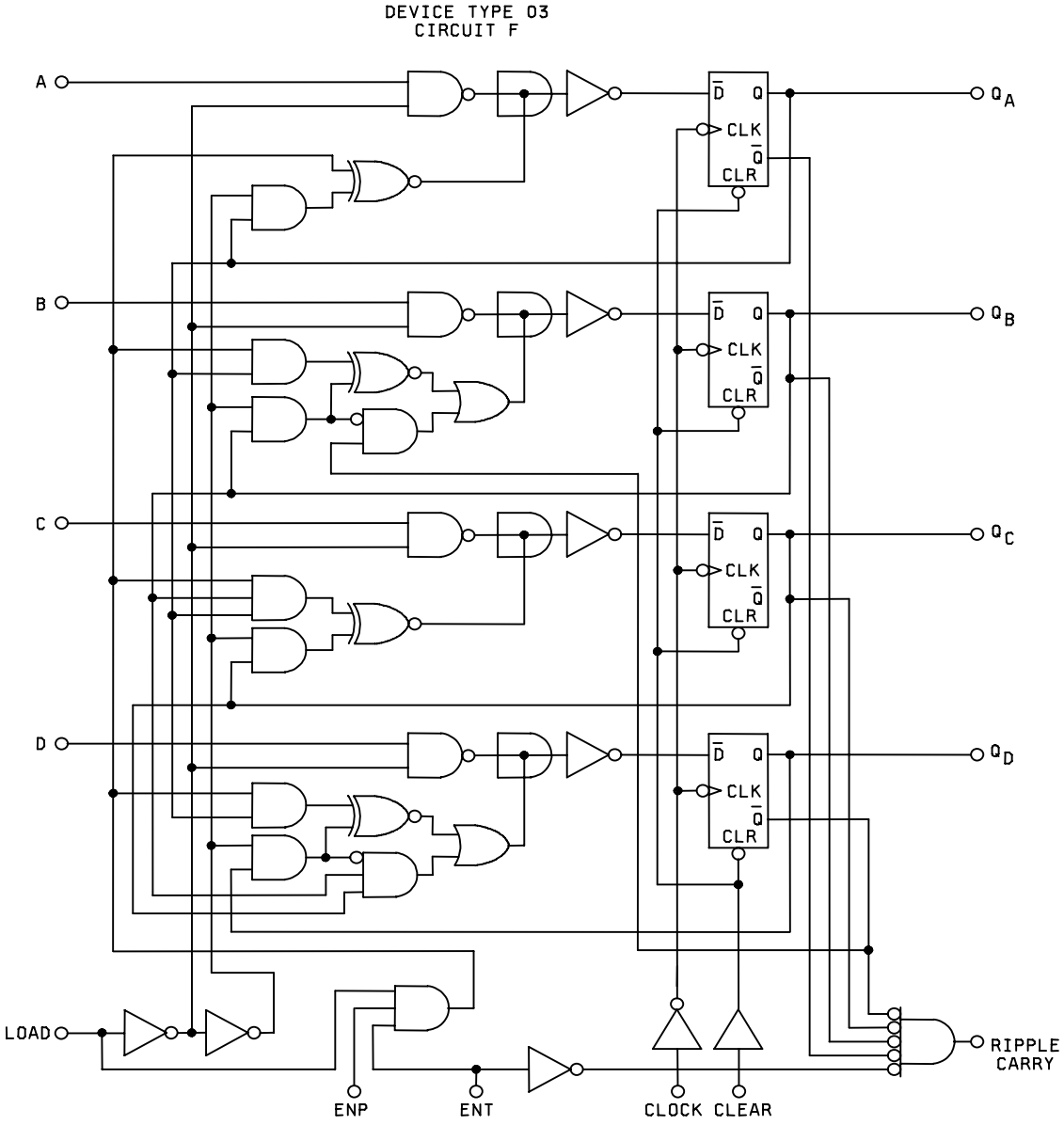
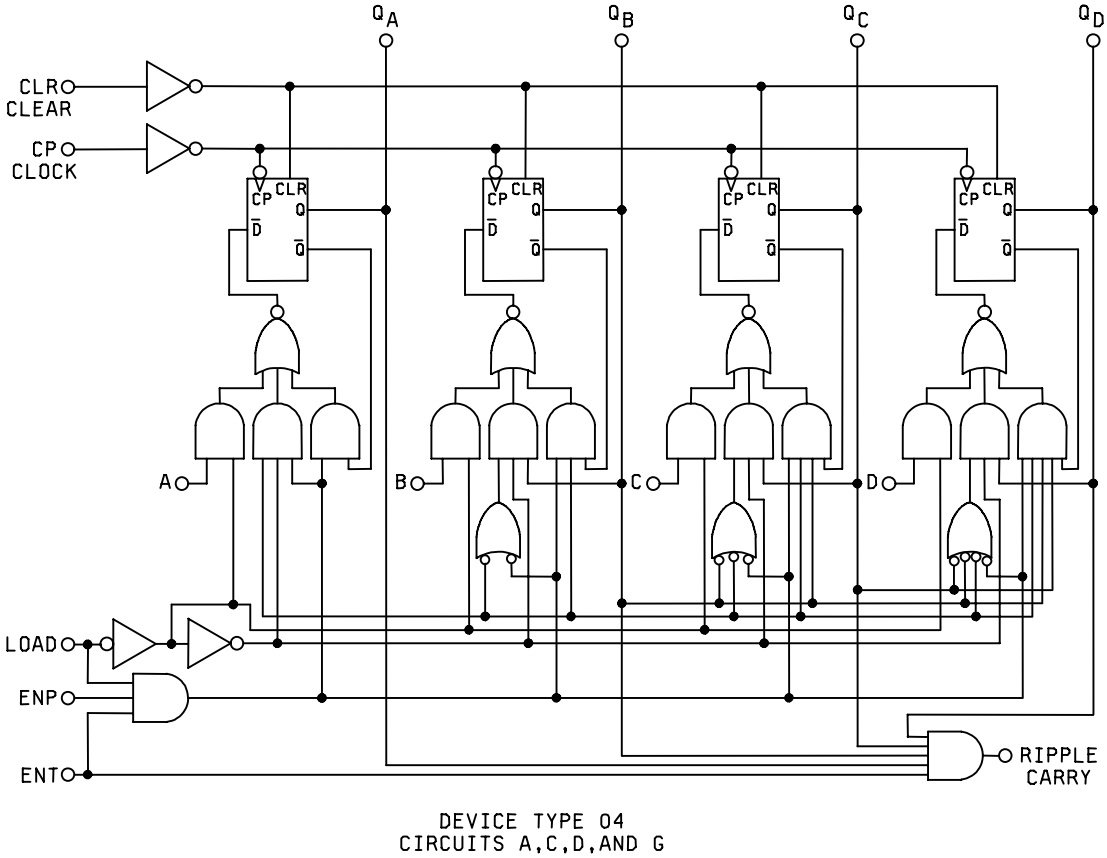


FIGURE 2. Logic diagrams – Continued.



DEVICE TYPE 04
CIRCUITS A,C,D,AND G

FIGURE 2. Logic diagrams – Continued.

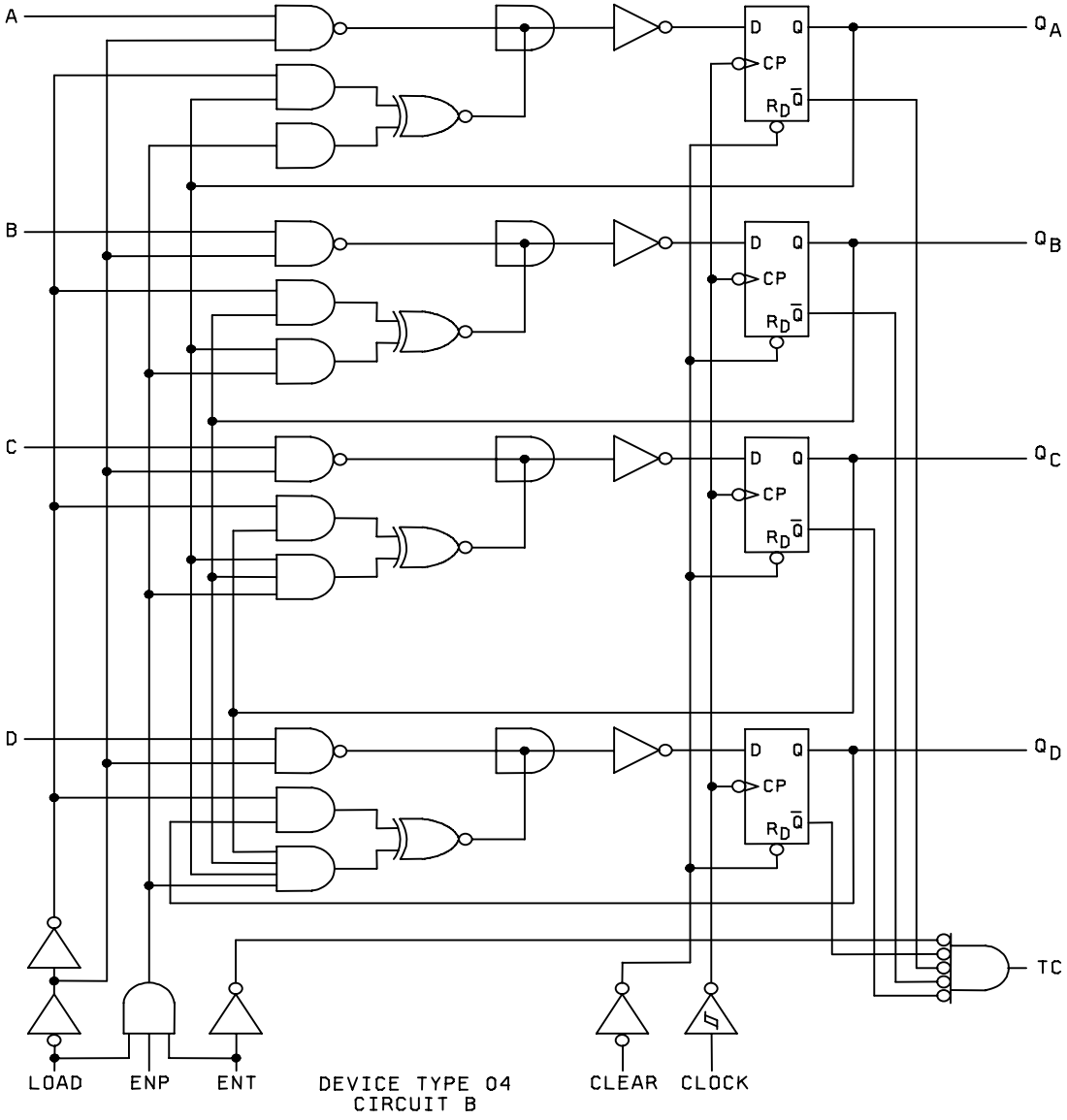


FIGURE 2. Logic diagrams – Continued.

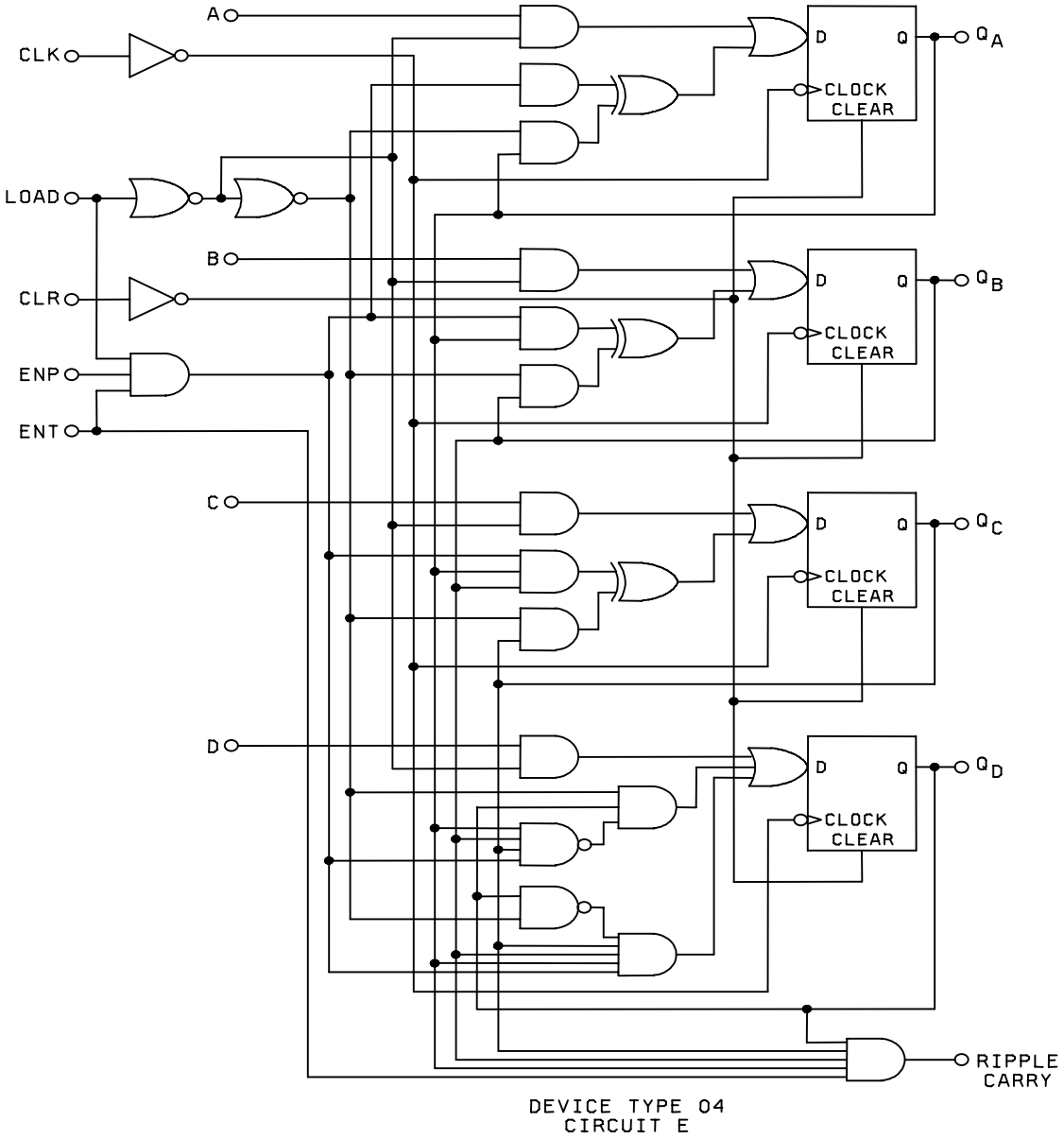


FIGURE 2. Logic diagrams – Continued.

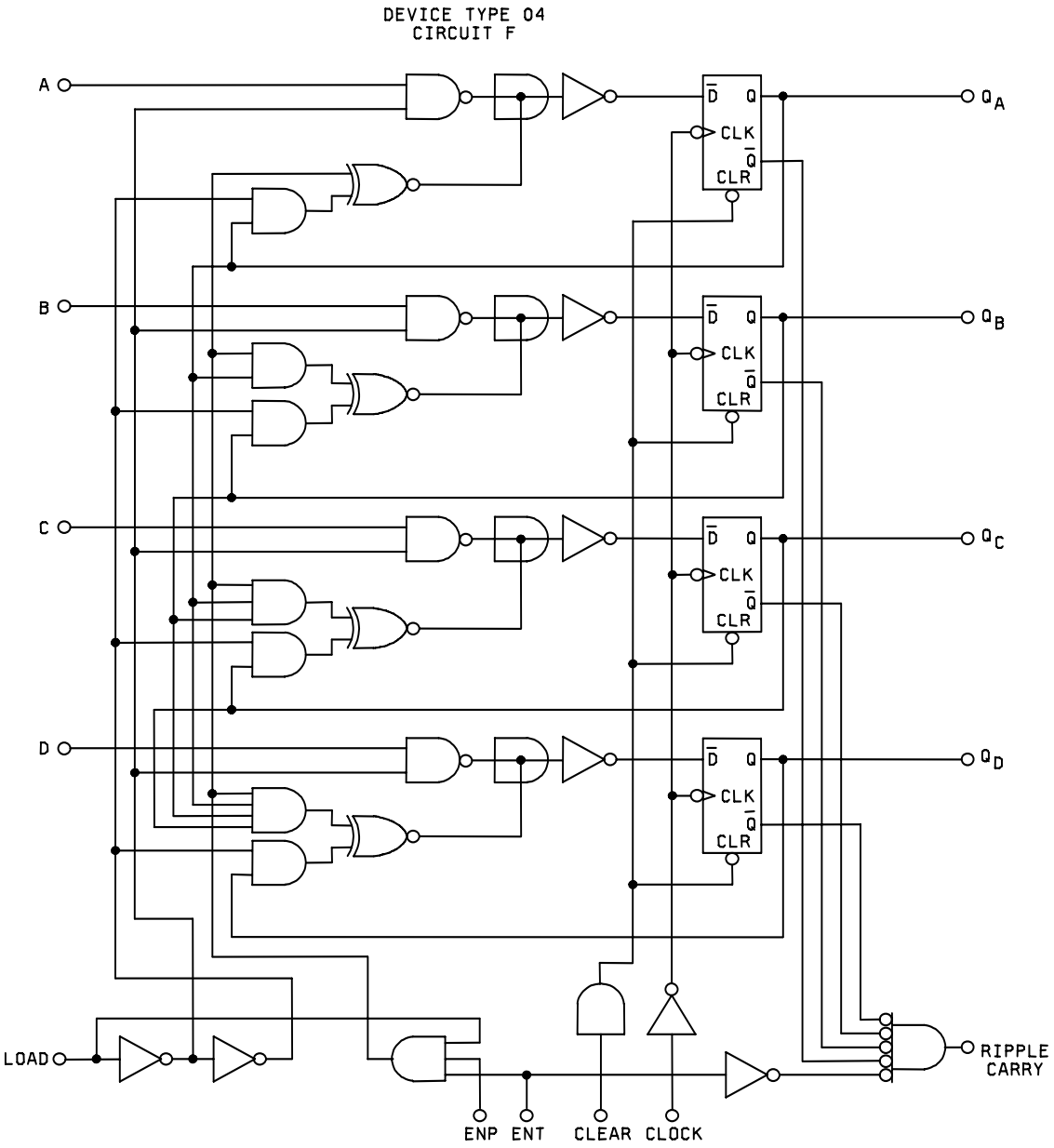


FIGURE 2. Logic diagrams – Continued.

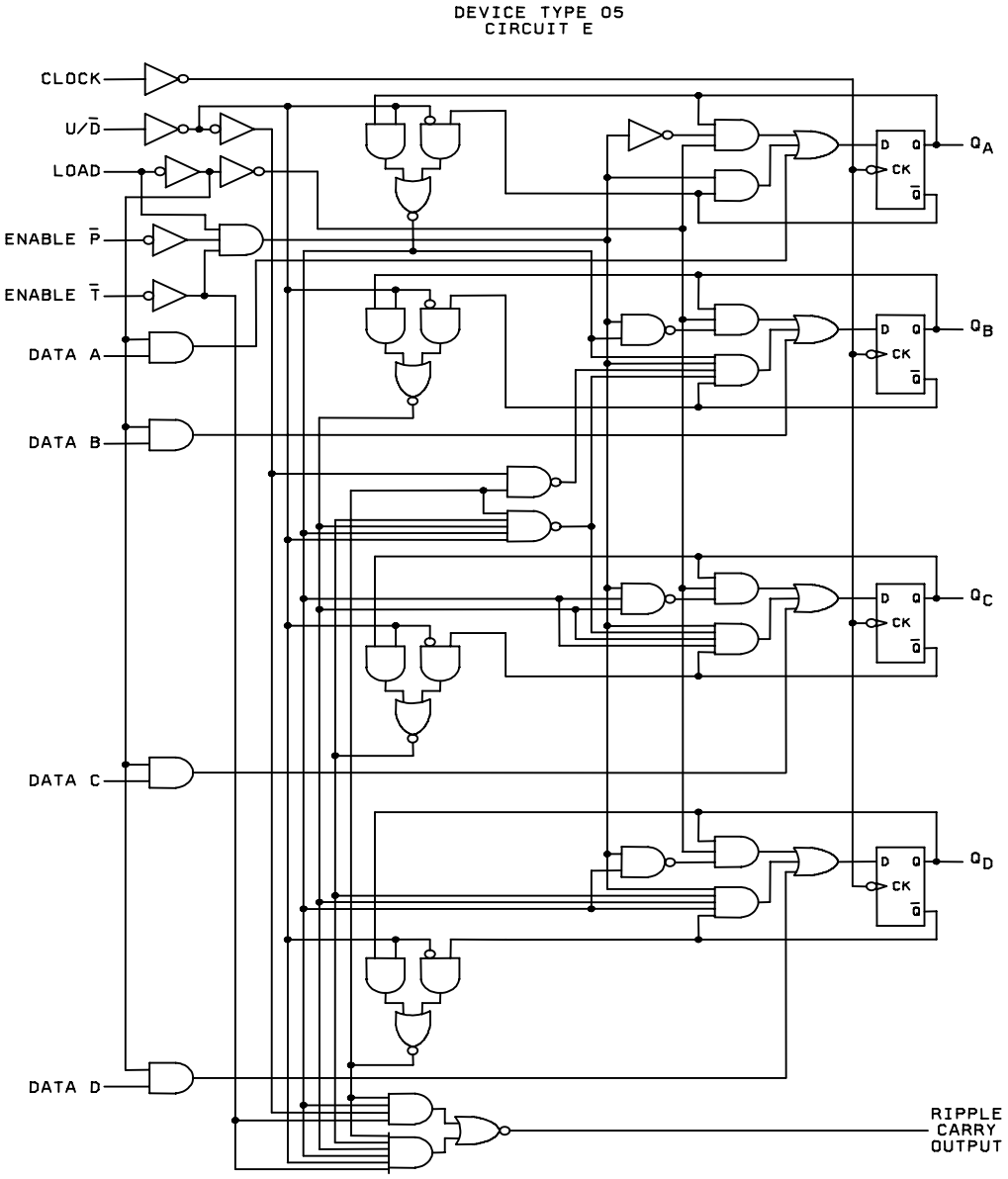


FIGURE 2. Logic diagrams – Continued.

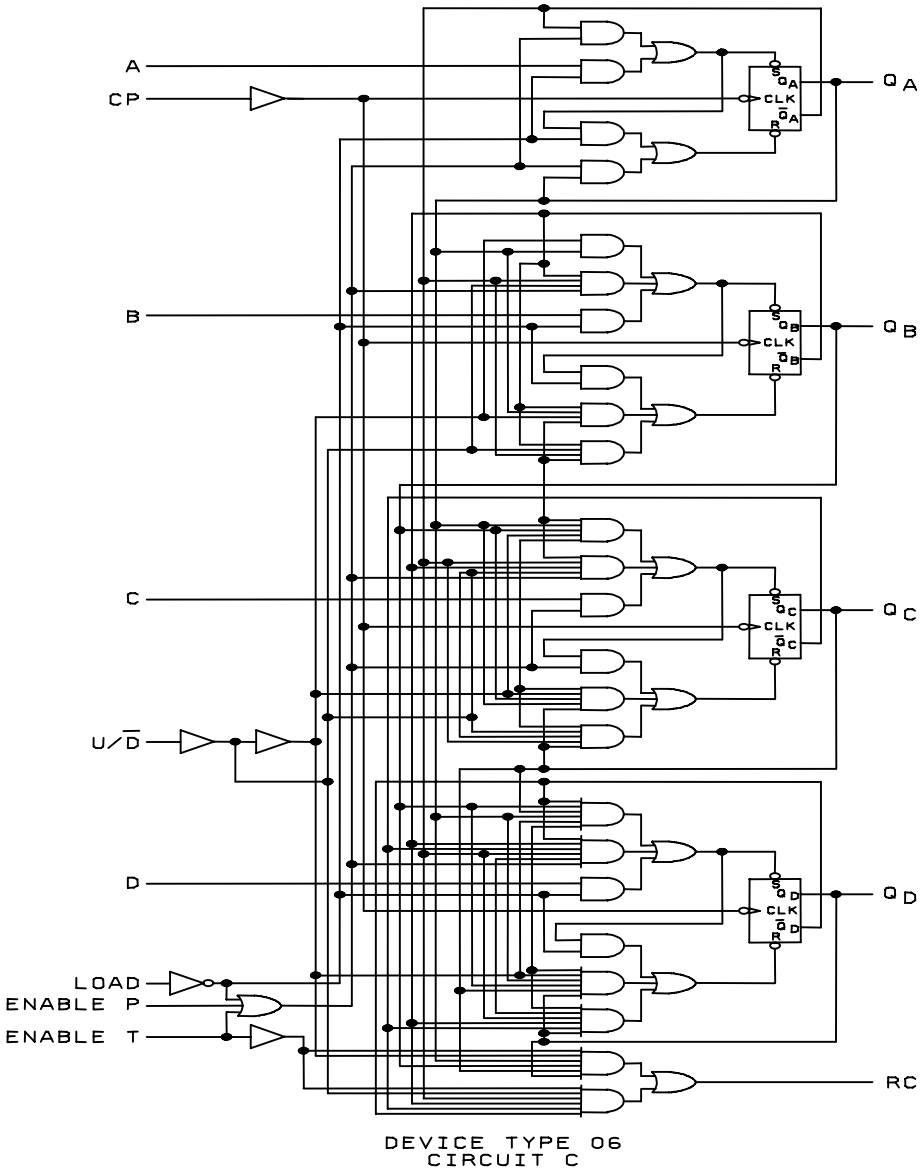


FIGURE 2. Logic diagrams – Continued.

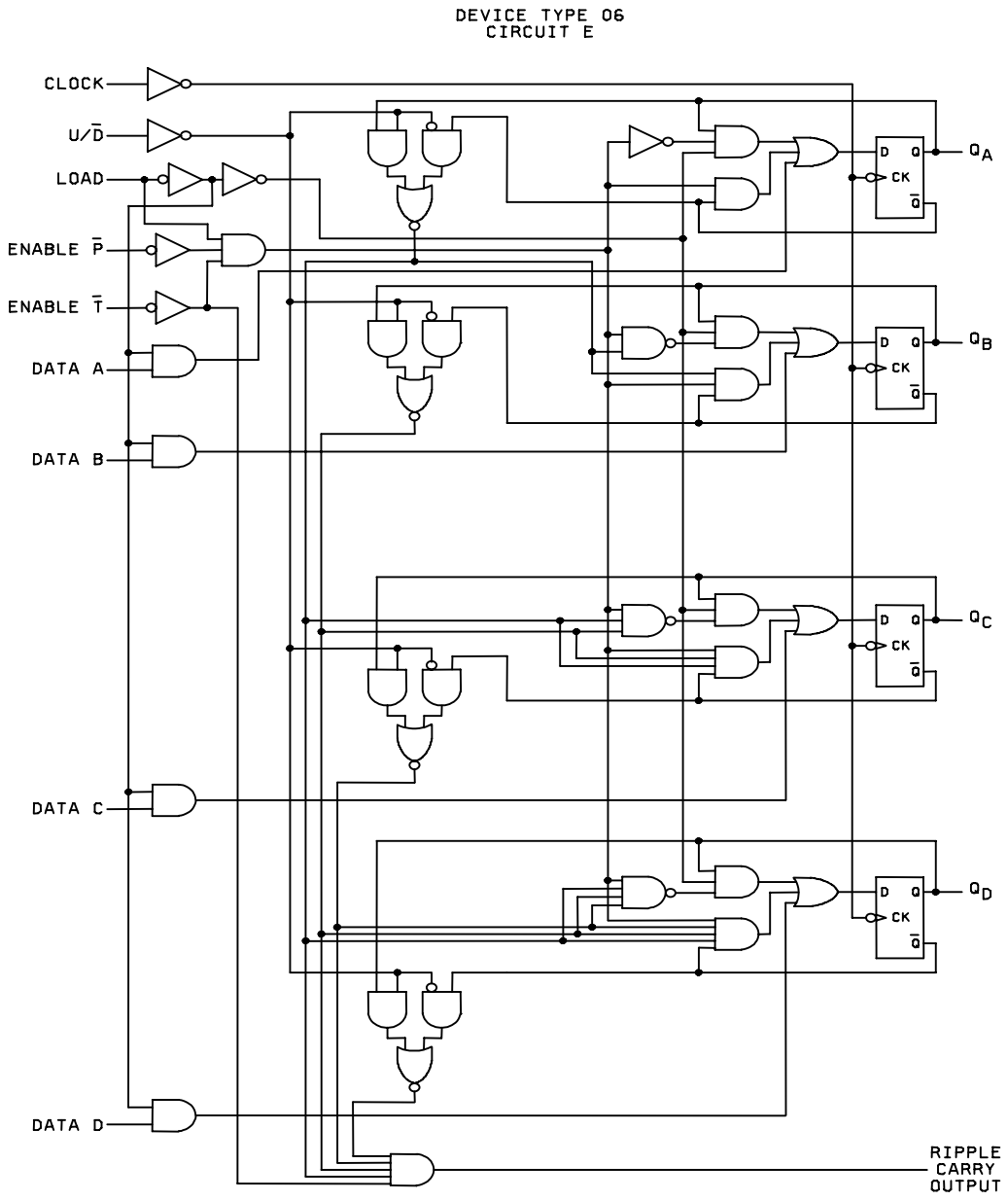


FIGURE 2. Logic diagrams – Continued.

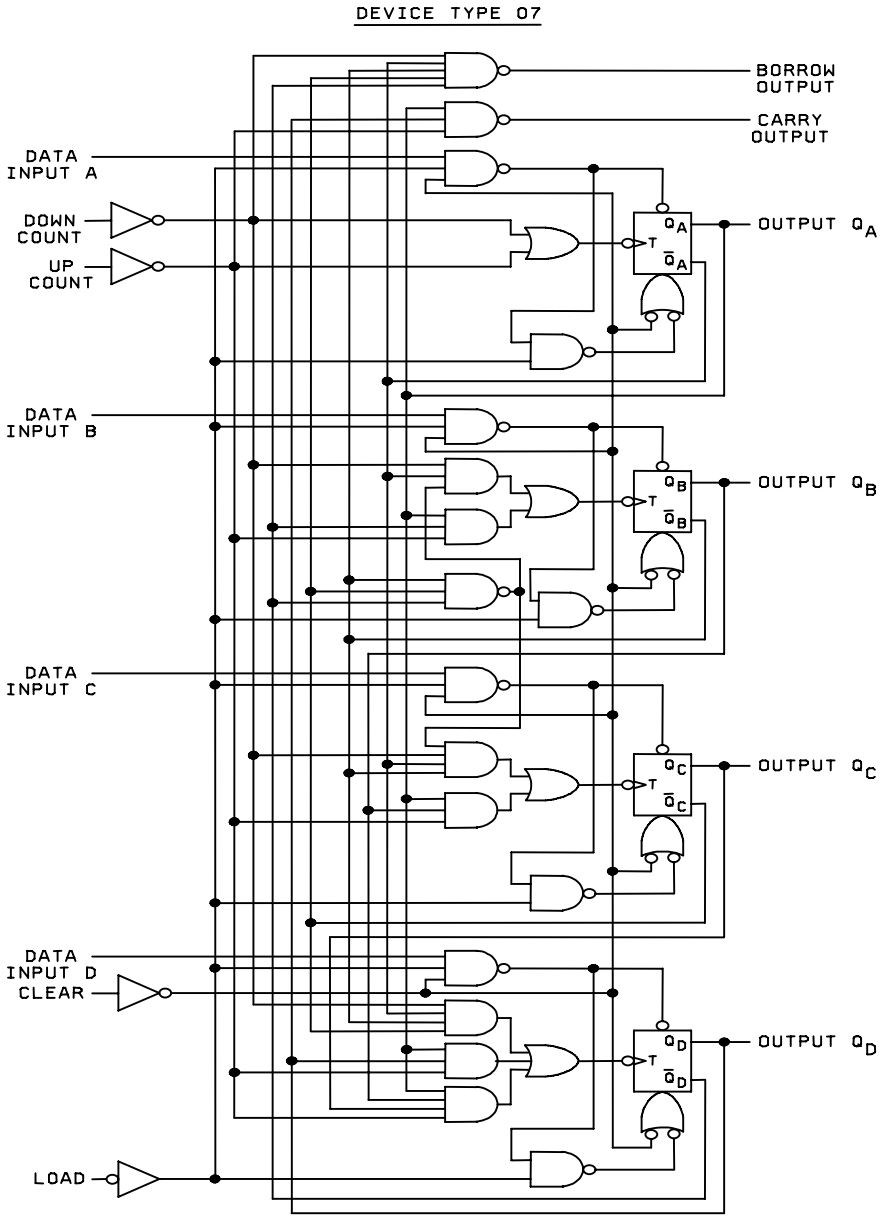


FIGURE 2. Logic diagrams – Continued.

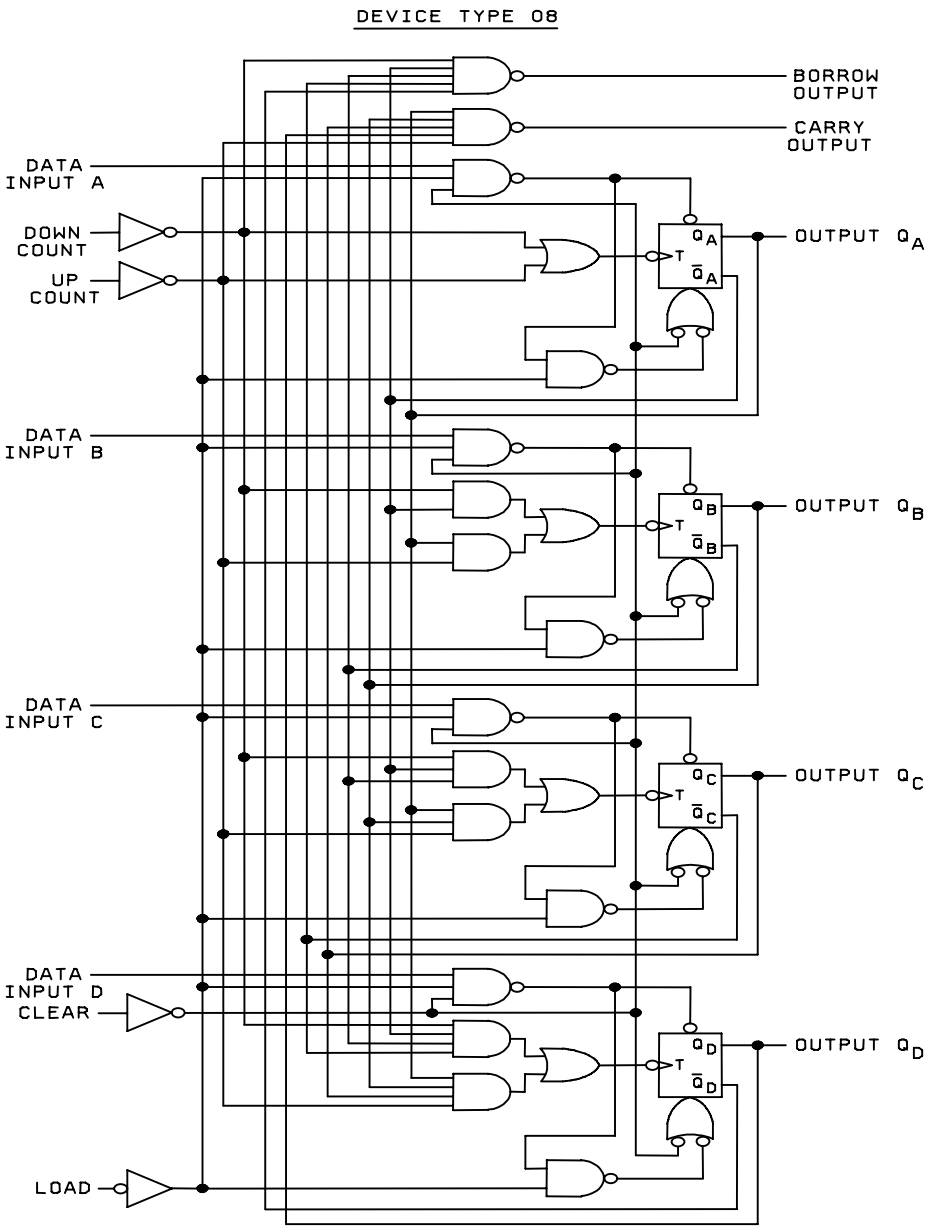


FIGURE 2. Logic diagrams – Continued.

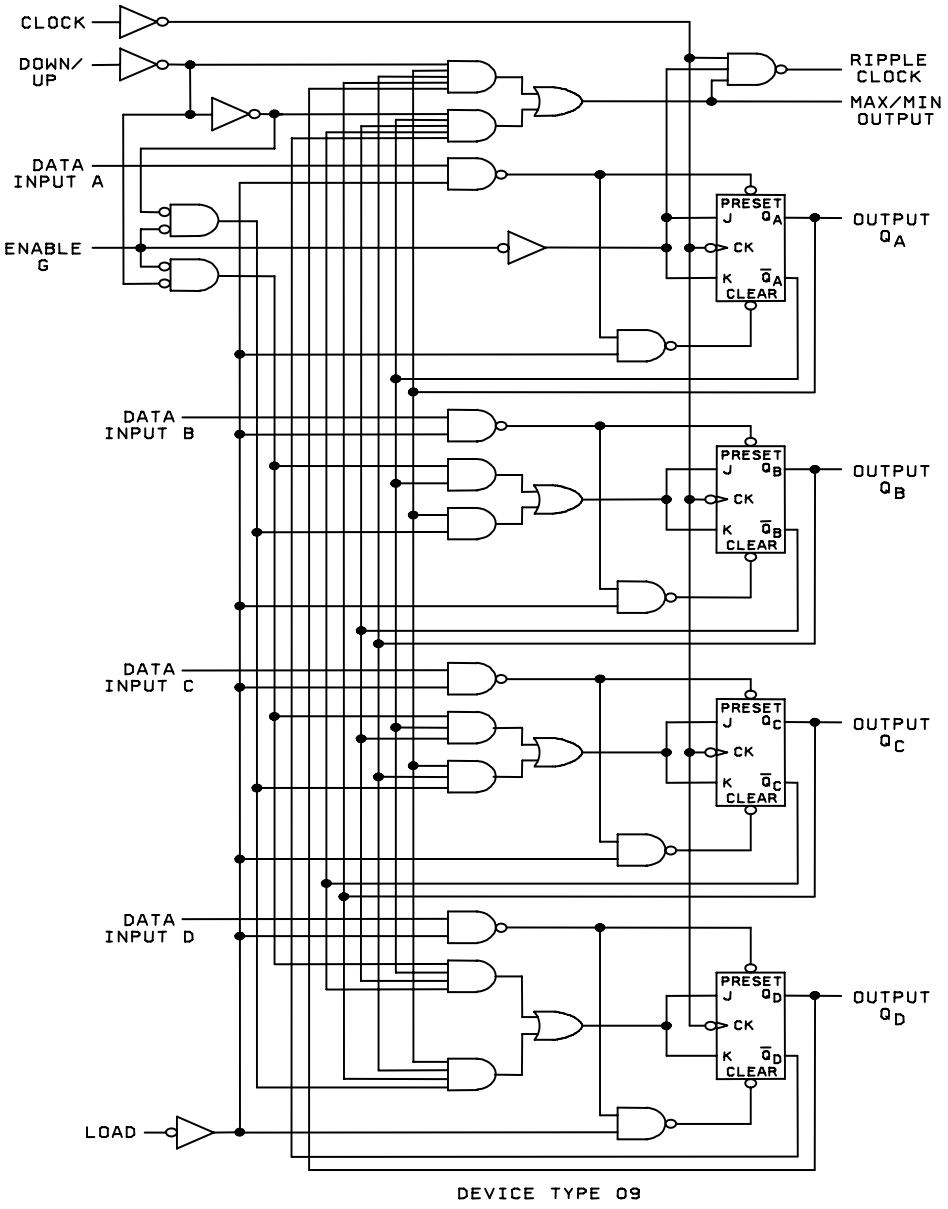


FIGURE 2. Logic diagrams – Continued.

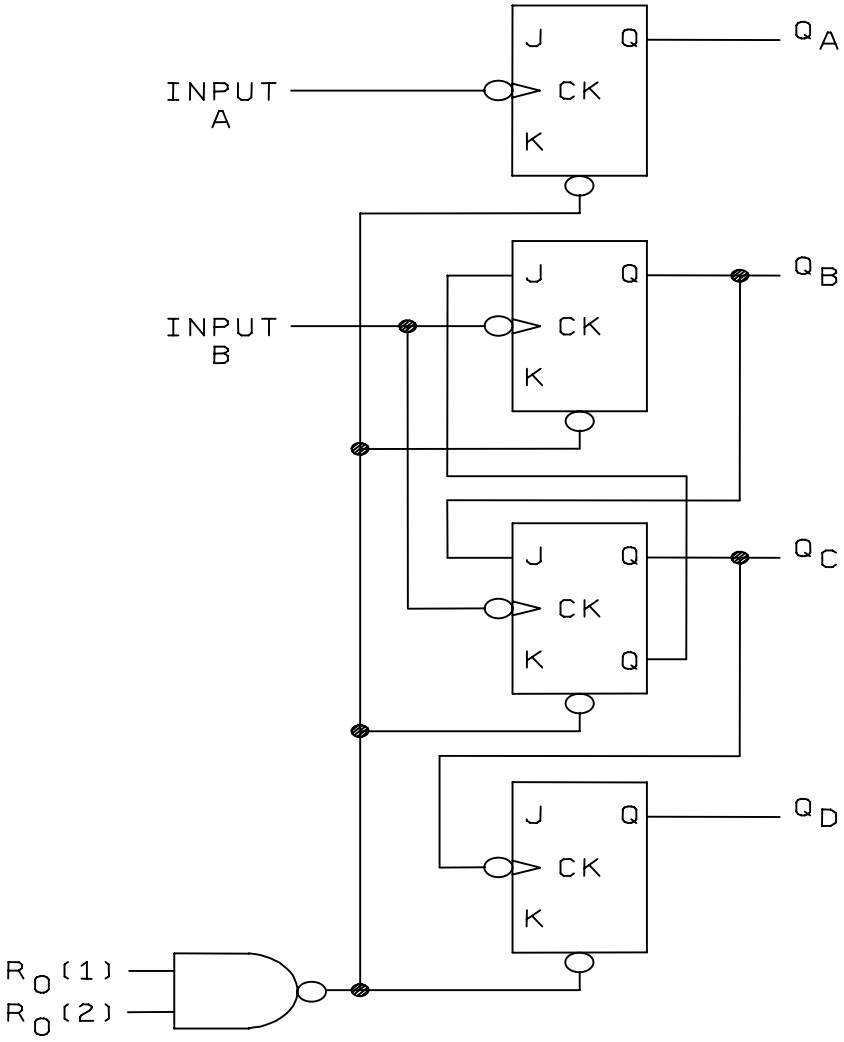
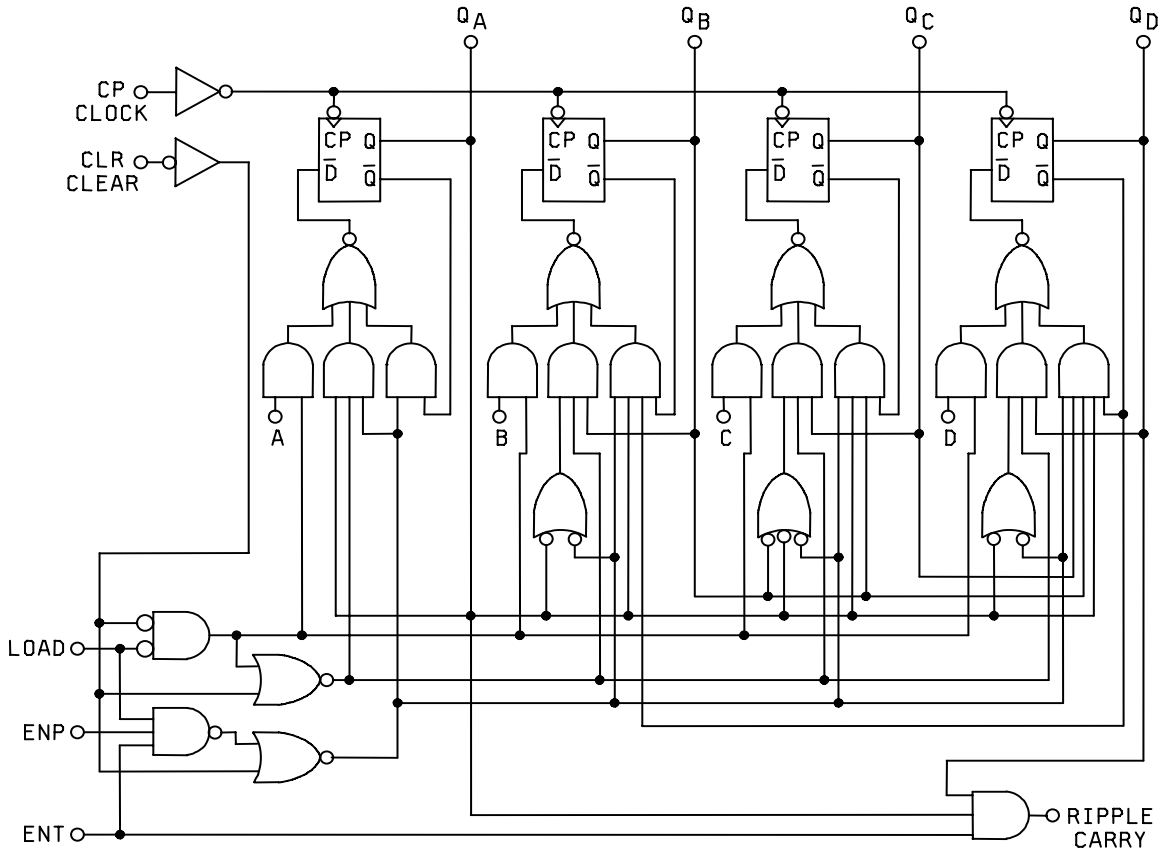


FIGURE 2. Logic diagrams – Continued.



DEVICE TYPE 11
CIRCUITS A,C,D, AND G

FIGURE 2. Logic diagrams – Continued.

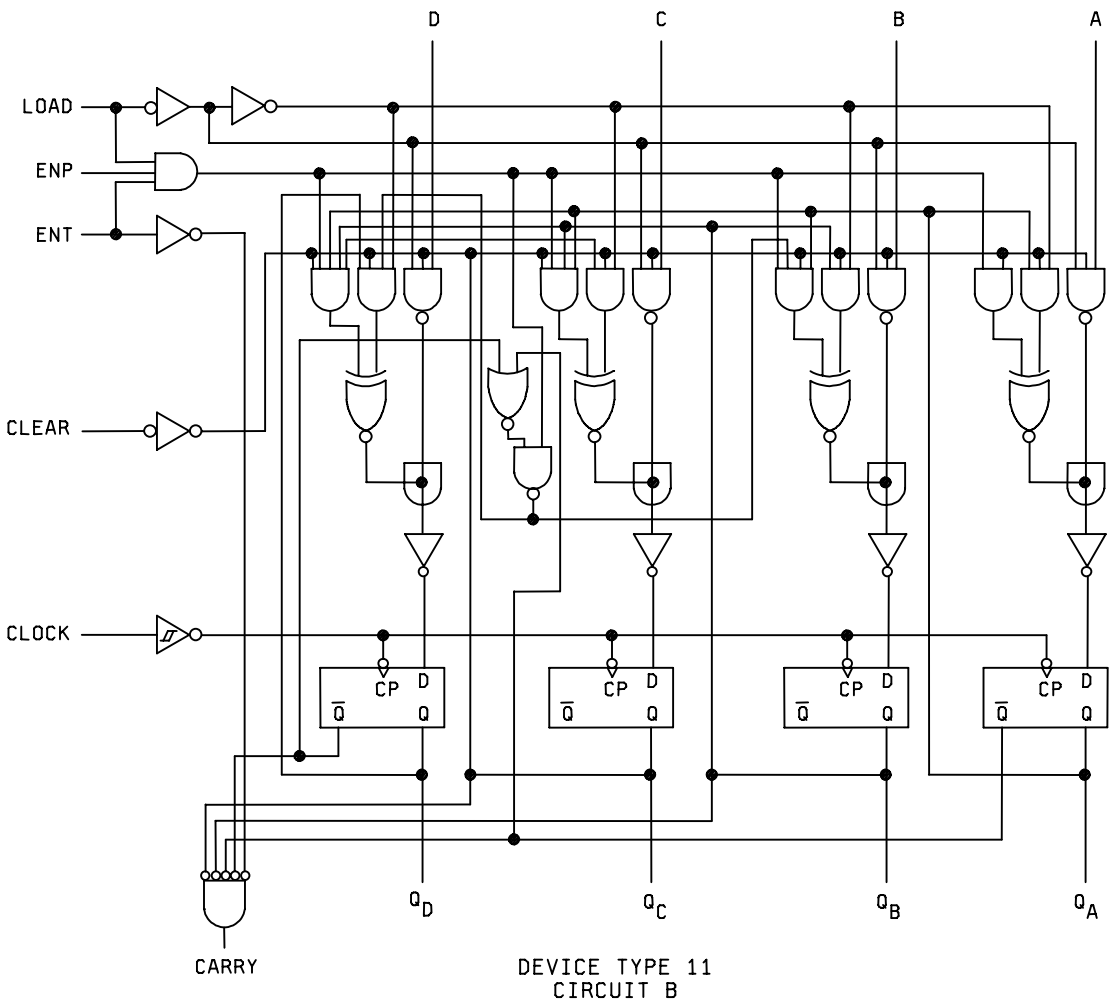


FIGURE 2. Logic diagrams – Continued.

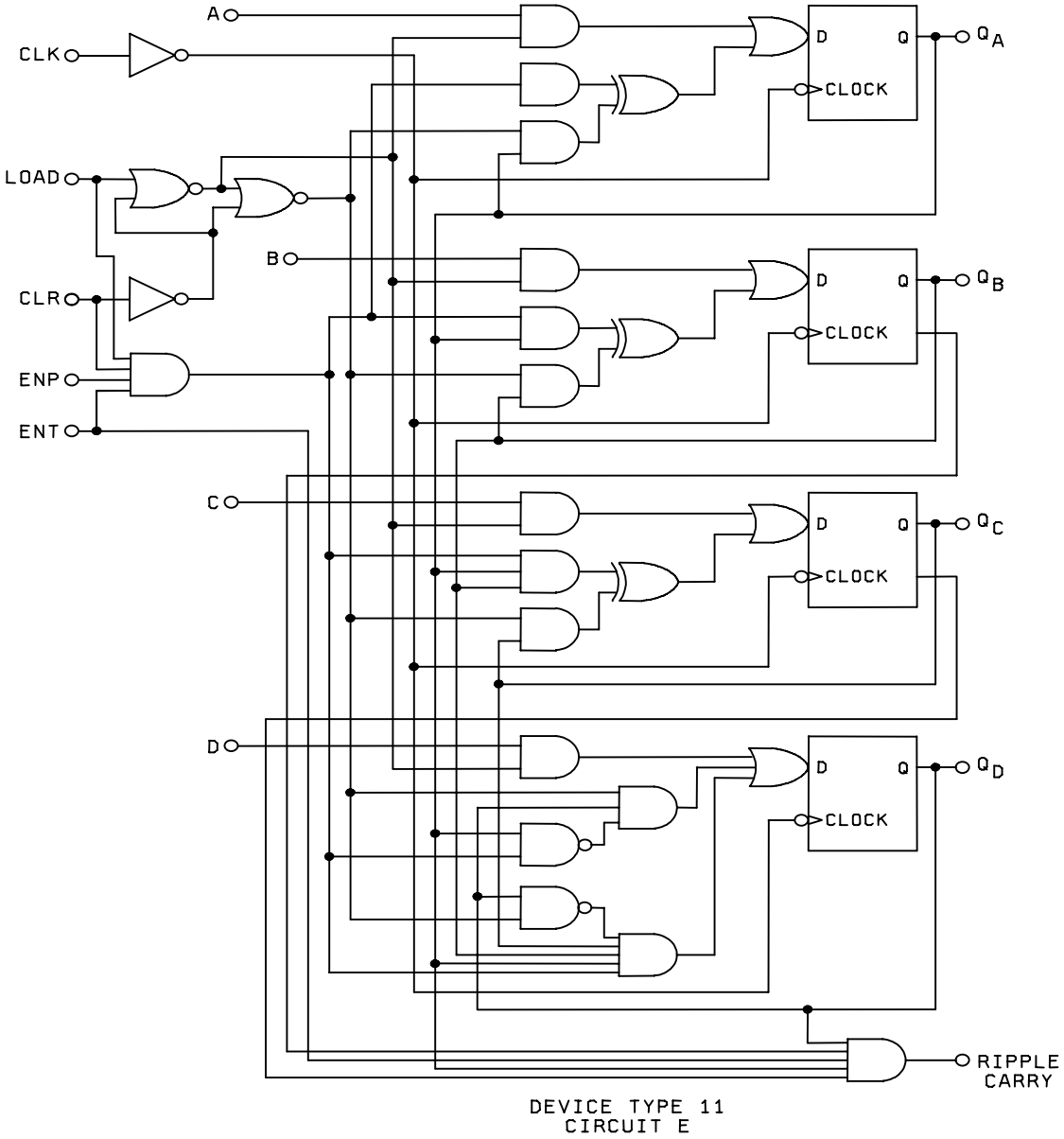


FIGURE 2. Logic diagrams – Continued.

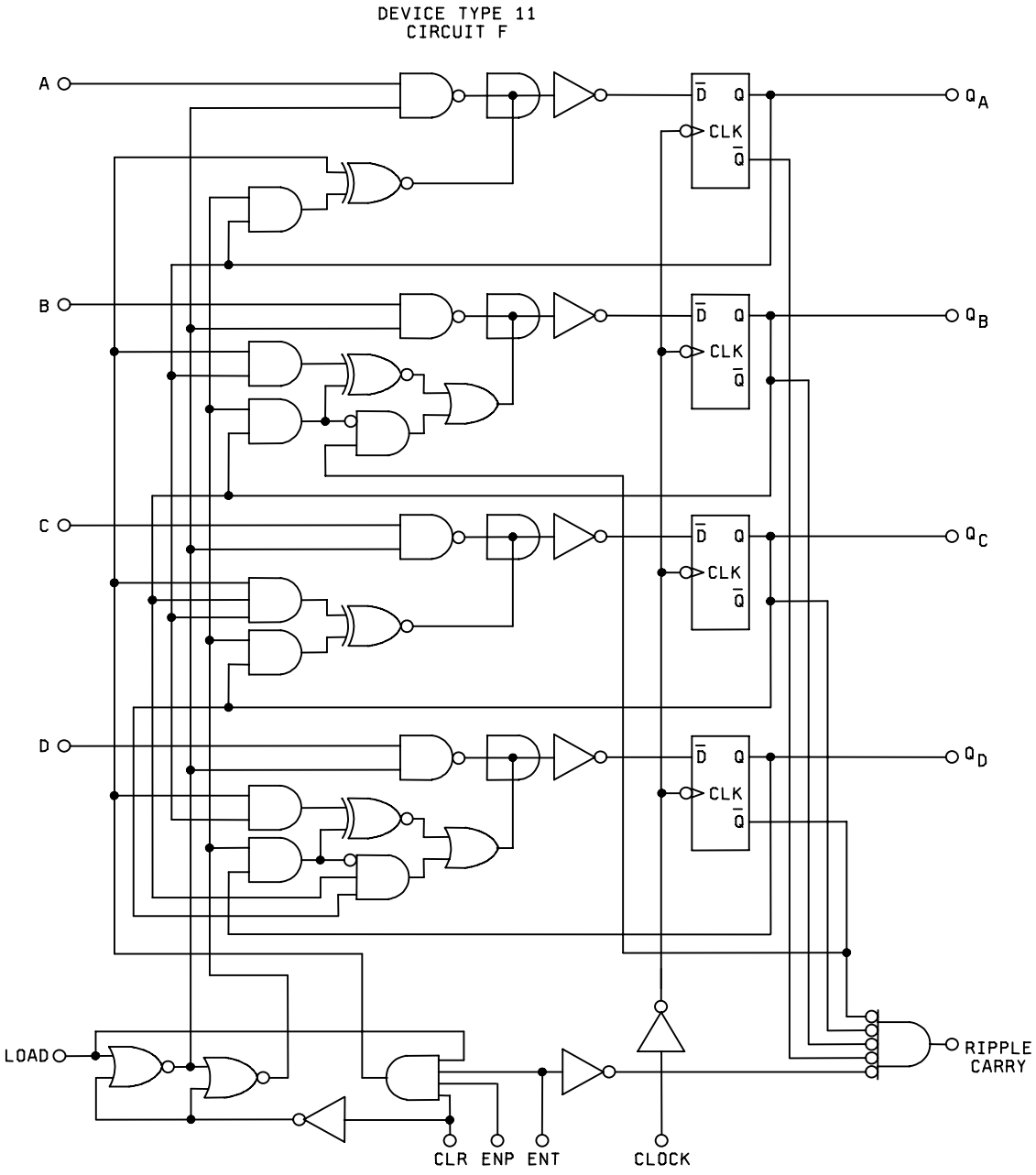
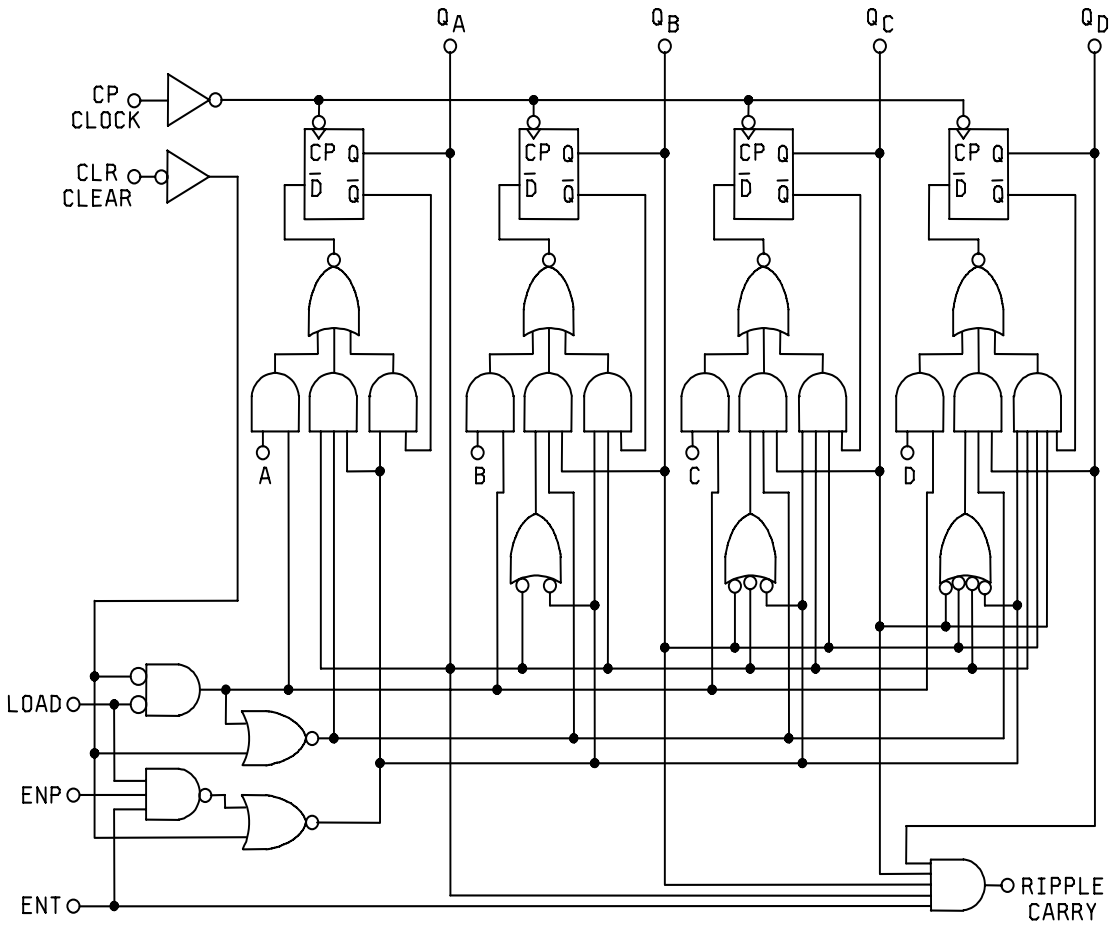


FIGURE 2. Logic diagrams – Continued.



DEVICE TYPE 12
CIRCUITS A,C,D, AND G

FIGURE 2. Logic diagrams – Continued.

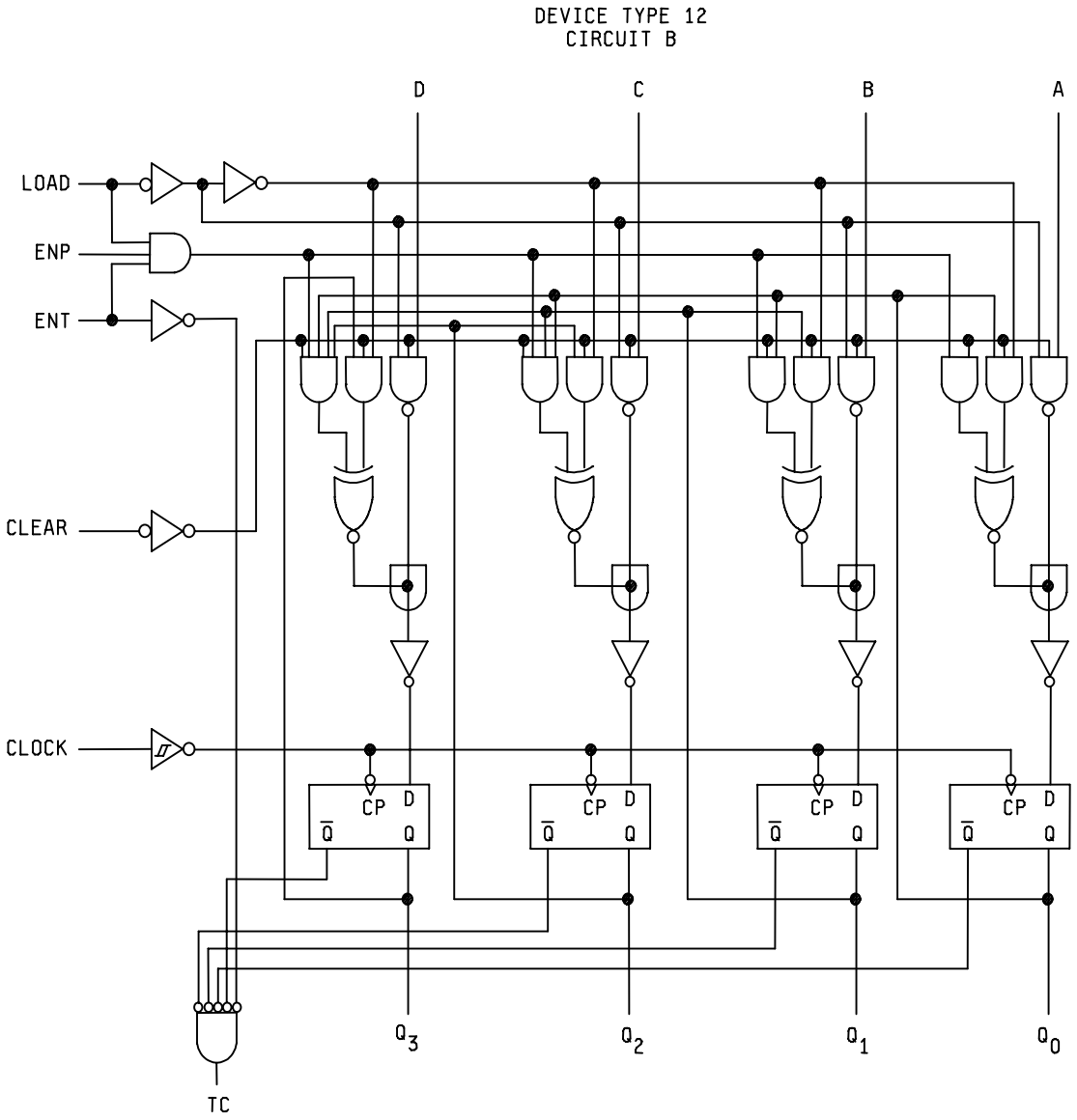


FIGURE 2. Logic diagrams – Continued.

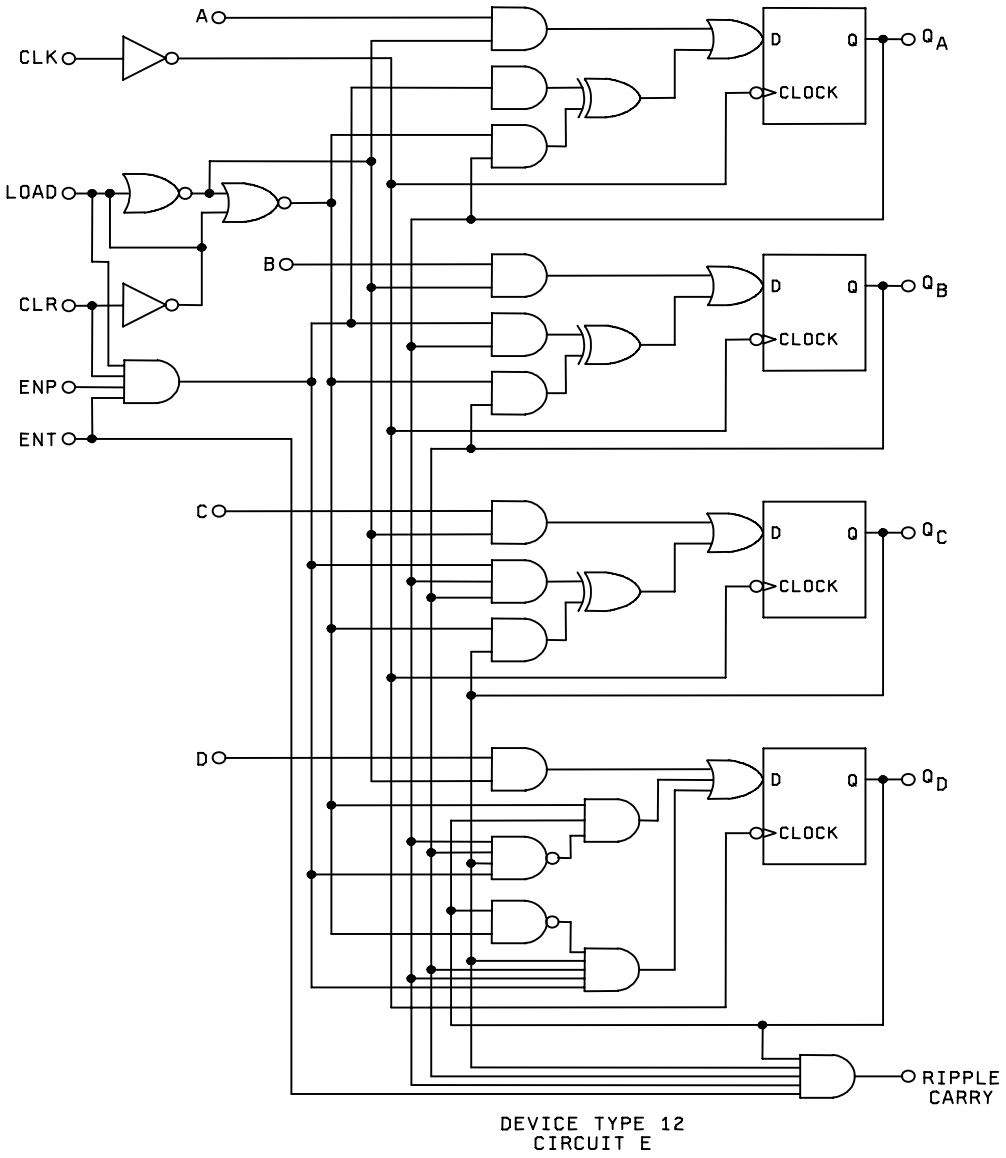


FIGURE 2. Logic diagrams – Continued.

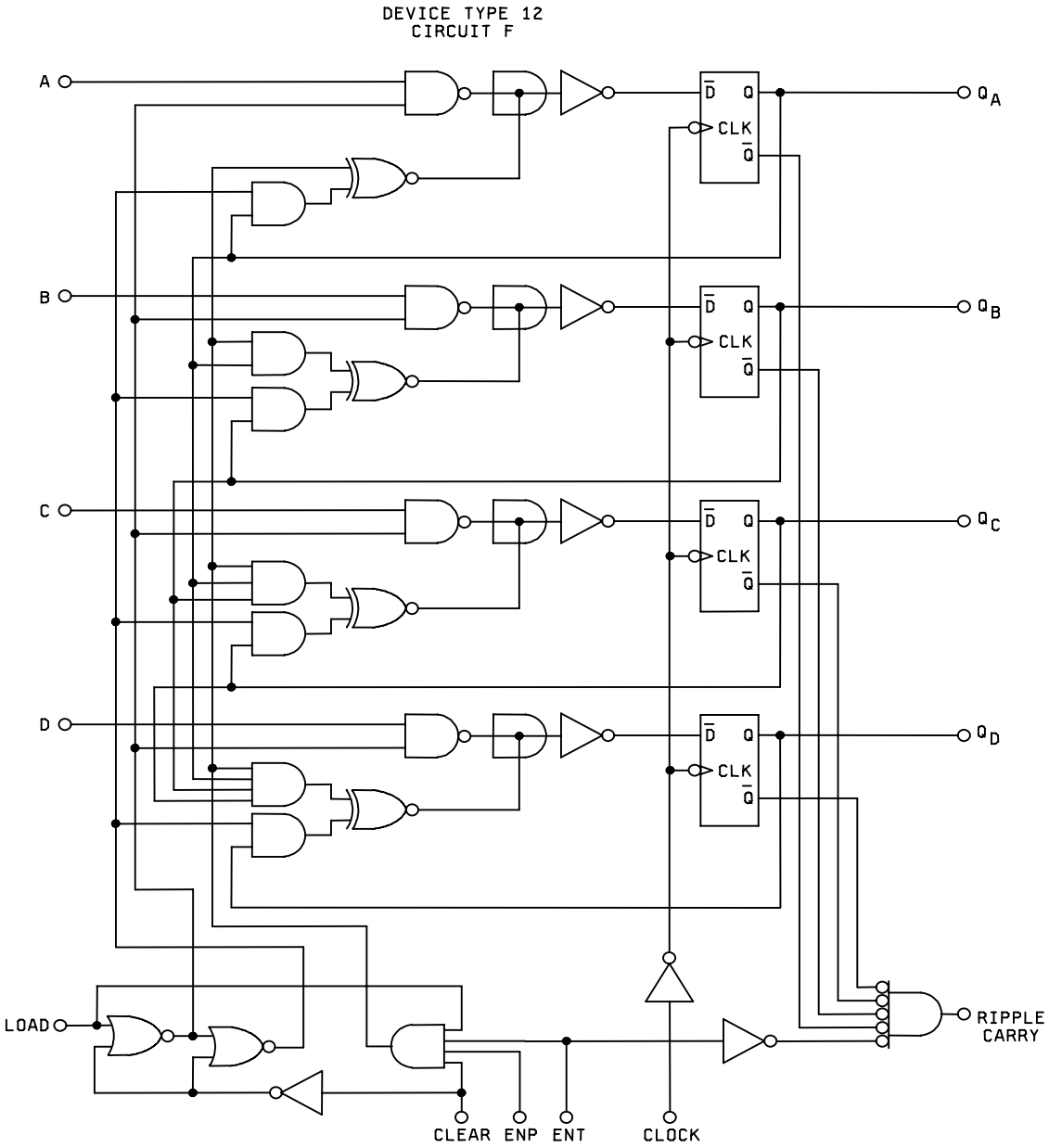


FIGURE 2. Logic diagrams – Continued.

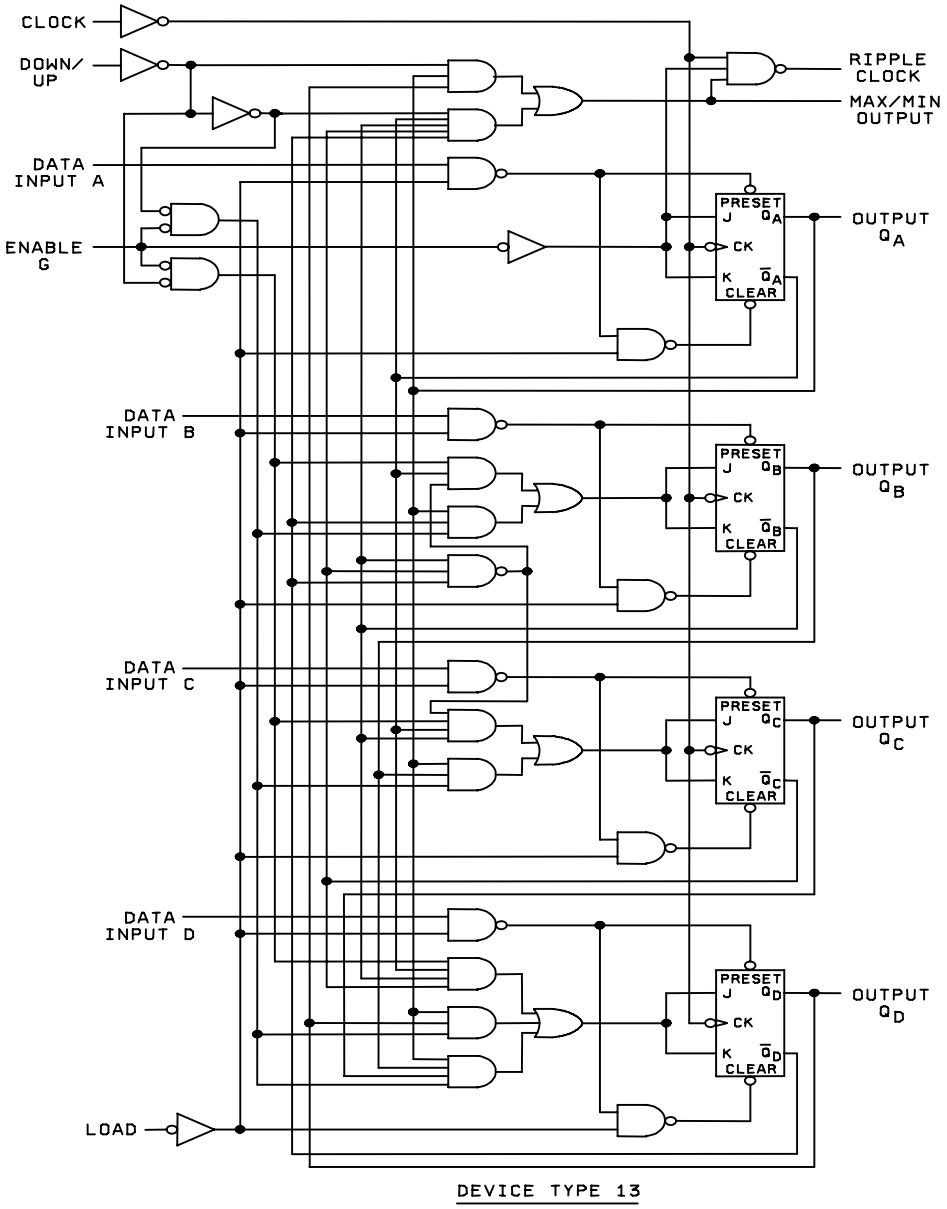


FIGURE 2. Logic diagrams – Continued.

DEVICE TYPE 01

BCD COUNT SEQUENCE
(See Note A)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H

BI-QUINARY (5-2)
(See Note B)

COUNT	OUTPUT			
	Q_A	Q_D	Q_C	Q_B
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	H	L	L	L
6	H	L	L	H
7	H	L	H	L
8	H	L	H	H
9	H	H	L	L

RESET/COUNT FUNCTION TABLE

RESET INPUTS				OUTPUT			
$R_{0(1)}$	$R_{0(2)}$	$R_{9(1)}$	$R_{9(2)}$	Q_D	Q_C	Q_B	Q_A
H	H	L	X	L	L	L	L
H	H	X	L	L	L	L	L
X	X	H	H	H	L	L	H
X	L	X	L	COUNT			
L	X	L	X	COUNT			
L	X	X	L	COUNT			
X	L	L	X	COUNT			

NOTES: A. Output Q_A is connected to input B for BCD count.
B. Output Q_D is connected to input A for bi-quinary count.

FIGURE 3. Truth tables.

DEVICE TYE 02

COUNT SEQUENCE
(See Note)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H
10	H	L	H	L
11	H	L	H	H
12	H	H	L	L
13	H	H	L	H
14	H	H	H	L
15	H	H	H	H

RESET/COUNT FUNCTION TABLE

RESET INPUTS		OUTPUT			
$R_{0(1)}$	$R_{0(2)}$	Q_D	Q_C	Q_B	Q_A
H	H	L	L	L	L
L	X	COUNT			
X	L	COUNT			

NOTE: Output Q_A is connected to input B.

DEVICE TYPE 10

COUNT SEQUENCE
(See Note)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	H	L	L	L
7	H	L	L	H
8	H	L	H	L
9	H	L	H	H
10	H	H	L	L
11	H	H	L	H

RESET/COUNT FUNCTION TABLE

RESET INPUTS		OUTPUT			
$R_{0(1)}$	$R_{0(2)}$	Q_D	Q_C	Q_B	Q_A
H	H	L	L	L	L
L	X	COUNT			
X	L	COUNT			

NOTE: Output Q_A is connected to input B.

FIGURE 3. Truth tables.

SYNCHRONOUS TRUTH TABLE, DEVICE TYPES 3 AND 11

Input at time t_n									Outputs at time t_{n+1}				
Clock	Enable P	Enable T	Load	A	B	C	D	Clear	Q_A	Q_B	Q_C	Q_D	Carry output
CP	L	X	H	X	X	X	X	H	NC	NC	NC	NC	NC
CP	X	L	H	X	X	X	X	H	NC	NC	NC	NC	L
CP	H	H	H	X	X	X	X	H	Previous count plus 1 (note 1)				H if count = 9 L if count < 9
CP	X	H	L	X	X	X	X	H	A	B	C	D	H if count = 9 L if count < 9
CP	X	L	L	X	X	X	X	H	A	B	C	D	L
CP	X	X	X	X	X	X	X	L	L	L	L	L	L

ASYNCHRONOUS TRUTH TABLE, DEVICE TYPE 3

Inputs at time t_n									Outputs at time t_{n+1}				
Clock	Enable P	Enable T	Load	A	B	C	D	Clear	Q_A	Q_B	Q_C	Q_D	Carry output
X	X	X	X	X	X	X	X	L	L	L	L	L	L

NOTES:
1. See up count sequence table.
2. L = V_{IL} for inputs, V_{0L} for outputs.
3. H = V_{IH} for inputs, V_{0H} for outputs.
4. X = V_{IH} or V_{IL}.
5. CP = Clock pulse.
6. NC = No change.

UP COUNT SEQUENCE TABLE

Q_A (LSB)	Q_B	Q_C	Q_D (MSB)
L	L	L	L
H	L	L	L
L	H	L	L
H	H	L	L
L	L	H	L
H	L	H	L
L	H	H	L
H	H	H	L
L	L	L	H
H	L	L	H

FIGURE 3. Truth tables – Continued.

SYNCHRONOUS TRUTH TABLE, DEVICE TYPES 4 AND 12

Input at time t_n									Outputs at time t_{n+1}				
Clock	Enable P	Enable T	Load	A	B	C	D	Clear	Q_A	Q_B	Q_C	Q_D	Carry output
CP	L	X	H	X	X	X	X	H	NC	NC	NC	NC	NC
CP	X	L	H	X	X	X	X	H	NC	NC	NC	NC	L
CP	H	H	H	X	X	X	X	H	Previous count plus 1 (note 1)				H if count = 15 L if count < 15
CP	X	H	L	X	X	X	X	H	A	B	C	D	H if count = 15 L if count < 15
CP	X	L	L	X	X	X	X	H	A	B	C	D	L
CP	X	X	X	X	X	X	X	L	L	L	L	L	L

ASYNCHRONOUS TRUTH TABLE, DEVICE TYPE 4

Inputs at time t_n									Outputs at time t_{n+1}				
Clock	Enable P	Enable T	Load	A	B	C	D	Clear	Q_A	Q_B	Q_C	Q_D	Carry output
X	X	X	X	X	X	X	X	L	L	L	L	L	L

NOTES:
1. See up count sequence table.
2. L = V_{IL} for inputs, V_{0L} for outputs.
3. H = V_{IH} for inputs, V_{0H} for outputs.
4. X = V_{IH} or V_{IL}.
5. CP = Clock pulse.
6. NC = No change.

UP COUNT SEQUENCE TABLE

Q_A (LSB)	Q_B	Q_C	Q_D (MSB)
L	L	L	L
H	L	L	L
L	H	L	L
H	H	L	L
L	L	H	L
H	L	H	L
L	H	H	L
H	H	H	L
L	L	L	H
H	L	L	H
L	H	L	H
H	H	L	H
L	L	H	H
H	L	H	H
L	H	H	H
H	H	H	H

FIGURE 3. Truth tables – Continued.

Device type 05

UP COUNT SEQUENCE TABLE

Q_A (LSB)	Q_B	Q_C	Q_D (MSB)
L	L	L	L
H	L	L	L
L	H	L	L
H	H	L	L
L	L	H	L
H	L	H	L
L	H	H	L
H	H	H	L
L	L	L	H
H	L	L	H

Device type 06

UP COUNT SEQUENCE TABLE

Q_A (LSB)	Q_B	Q_C	Q_D (MSB)
L	L	L	L
H	L	L	L
L	H	L	L
H	H	L	L
L	L	H	L
H	L	H	L
L	H	H	L
H	H	H	L
L	L	L	H
H	L	L	H
L	H	L	H
H	H	L	H
L	L	H	H
H	L	H	H
L	H	H	H
H	H	H	H

Device types 05 and 06

MODE SELECT TABLE

L	EP	ET	$U/\overline{D}$	Action on Rising Clock Edge
L	X	X	X	Load ($D_n \rightarrow Q_n$)
H	L	L	H	Count Up (increment)
H	L	L	L	Count Down (decrement)
H	H	X	X	No Change (Hold)
H	X	H	X	No Change (Hold)

H = High voltage level
L = Low voltage
X = Don't care

FIGURE 3. Truth tables – Continued.

DEVICE TYPE 7 TRUTH TABLE

Inputs at time t_n								Outputs at time $t_{n=1}$					
Count Up	Count Down	Load	A	B	C	D	Clear	Q_A	Q_B	Q_C	Q_D	Carry	Borrow
H	H	H	X	X	X	X	L	NC	NC	NC	NC	H	H
H	H	H	X	X	X	X	H	L	L	L	L	H	H
H	H	L	X	X	X	X	L	A	B	C	D	H	H
P	H	H	X	X	X	X	L	Previous count plus 1 (note 1)				H	H
H	P	H	X	X	X	X	L	Previous count minus 1 (note 2)				H	H
N	H	H	X	X	X	X	L	NC	NC	NC	NC	N if count = 9 H if count $\neq$ 9	H
H	N	H	X	X	X	X	L	NC	NC	NC	NC	H	N if count = 0 H if count $\neq$ 0

NOTES:
1. See up count sequence table.
2. See down count sequence table.
3. L= V_{IL} for inputs, V_{OL} for outputs.
4. H = V_{IH} for inputs, V_{OH} for outputs.
5. X = V_{IH} or V_{IL}.
6. NC = No change.
7. NA = Not applicable.
8. P = Positive going pulse.
9. N= Negative going pulse.

FIGURE 3. Truth tables – Continued.

DEVICE TYPE 07

UP COUNT SEQUENCE TABLE

Q_A (LSB)	Q_B	Q_C	Q_D (MSB)	Carry
L	L	L	L	H
H	L	L	L	H
L	H	L	L	H
H	H	L	L	H
L	L	H	L	H
H	L	H	L	H
L	H	H	L	H
H	H	H	L	H
L	L	L	H	H
H	L	L	H	L

DOWN COUNT SEQUENCE TABLE

Q_A (LSB)	Q_B	Q_C	Q_D (MSB)	Borrow
H	L	L	H	H
L	L	L	H	H
H	H	H	L	H
L	H	H	L	H
H	L	H	L	H
L	L	H	L	H
H	H	L	L	H
L	H	L	L	H
H	L	L	L	H
L	L	L	L	L

DEVICE TYPE 8 TRUTH TABLE

Input at time t_n								Outputs at time $t_{n=1}$					
Count up	Count down	Load	A	B	C	D	Clear	Q_A	Q_B	Q_C	Q_D	Carry	Borrow
H	H	H	X	X	X	X	L	NC	NC	NC	NC	H	H
H	H	H	X	X	X	X	H	L	L	L	L	H	H
H	H	L	X	X	X	X	L	A	B	C	D	H	H
P	H	H	X	X	X	X	L	Previous count plus 1 (note)				H	H
H	P	H	X	X	X	X	L	Previous count minus 1 (note 2)				H	H
N	H	H	X	X	X	X	L	NC	NC	NC	NC	N if count = 15 H if count $\neq$ 15	H
H	N	H	X	X	X	X	L	NC	NC	NC	NC	H	N if count = 0 H if count $\neq$ 0

NOTES:
1. See up count sequence table.
2. See down count sequence table.
3. L = V_{IL} for inputs, V_{OL} for outputs.
4. H = V_{IH} for inputs, V_{OH} for outputs.
5. X = V_{IH} or V_{IL}.
6. NC = No change.
7. NA = Not applicable.
8. P = Positive going pulse.
9. N = Negative going pulse.

FIGURE 3. Truth tables – Continued.

DEVICE TYPE 08

UP COUNT SEQUENCE TABLE

Q_A (LSB)	Q_B	Q_C	Q_D (MSB)	Carry
L	L	L	L	H
H	L	L	L	H
L	H	L	L	H
H	H	L	L	H
L	L	H	L	H
H	L	H	L	H
L	H	H	L	H
H	H	H	L	H
L	L	L	H	H
H	L	L	H	H
L	H	L	H	H
H	H	L	H	H
L	L	H	H	H
H	L	H	H	H
L	H	H	H	H
H	H	H	H	L

DOWN COUNT SEQUENCE TABLE

Q_A (LSB)	Q_B	Q_C	Q_D (MSB)	Borrow
H	H	H	H	H
L	H	H	H	H
H	L	H	H	H
L	L	H	H	H
H	H	L	H	H
L	H	L	H	H
H	L	L	H	H
L	L	L	H	H
H	H	H	L	H
L	H	H	L	H
H	L	H	L	H
L	L	H	L	H
H	H	L	L	H
L	H	L	L	H
H	L	L	L	H
L	L	L	L	L

DEVICE TYPES 09 AND 13

Mode select table

Inputs				Mode
Load	Enable G	U/D	CLK	
H	L	L	⌐¬	Count up
H	L	H	⌐¬	Count down
L	X	X	X	Preset (Asyn)
H	H	X	X	No change (Hold)

Ripple carry truth table

Inputs		Outputs	
Enable G	CLK	Max/Min	RC output
L	¬⌐	H	¬⌐
H	X	X	H
X	X	L	H

L = Low voltage level
H = High voltage level
X = Don't care
⌐¬ = Low-to-high clock transition
¬⌐ = Negative going clock pulse

NOTE: The up count and down count sequence for device type 09 is identical as that for device type 08.

The up count and down count sequence for device type 13 is identical as that for device type 07.

FIGURE 3. Truth tables – Continued.

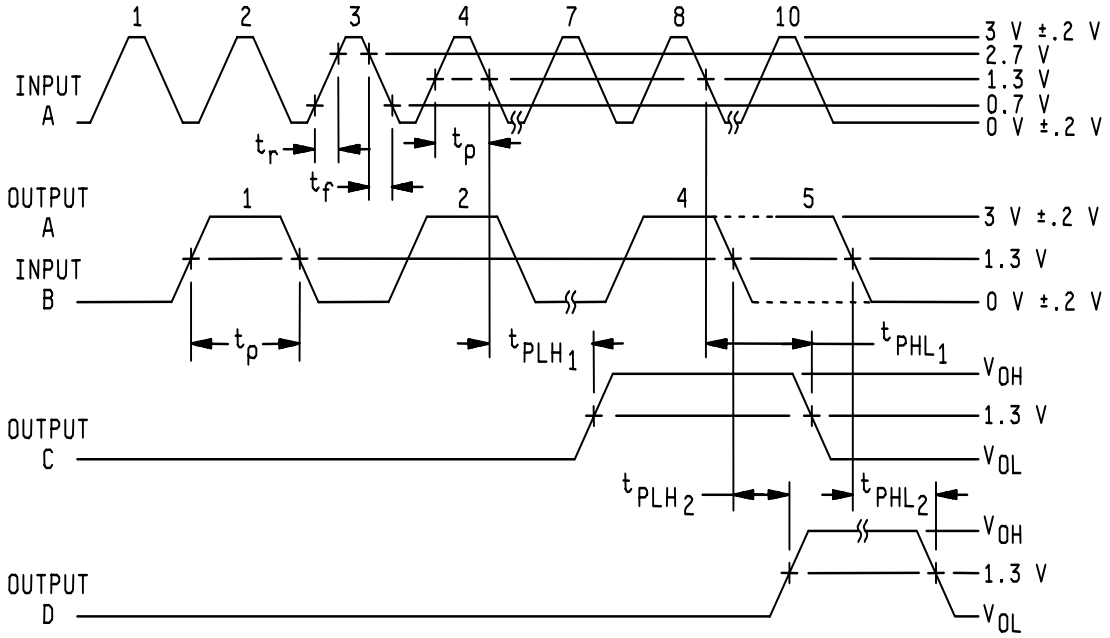
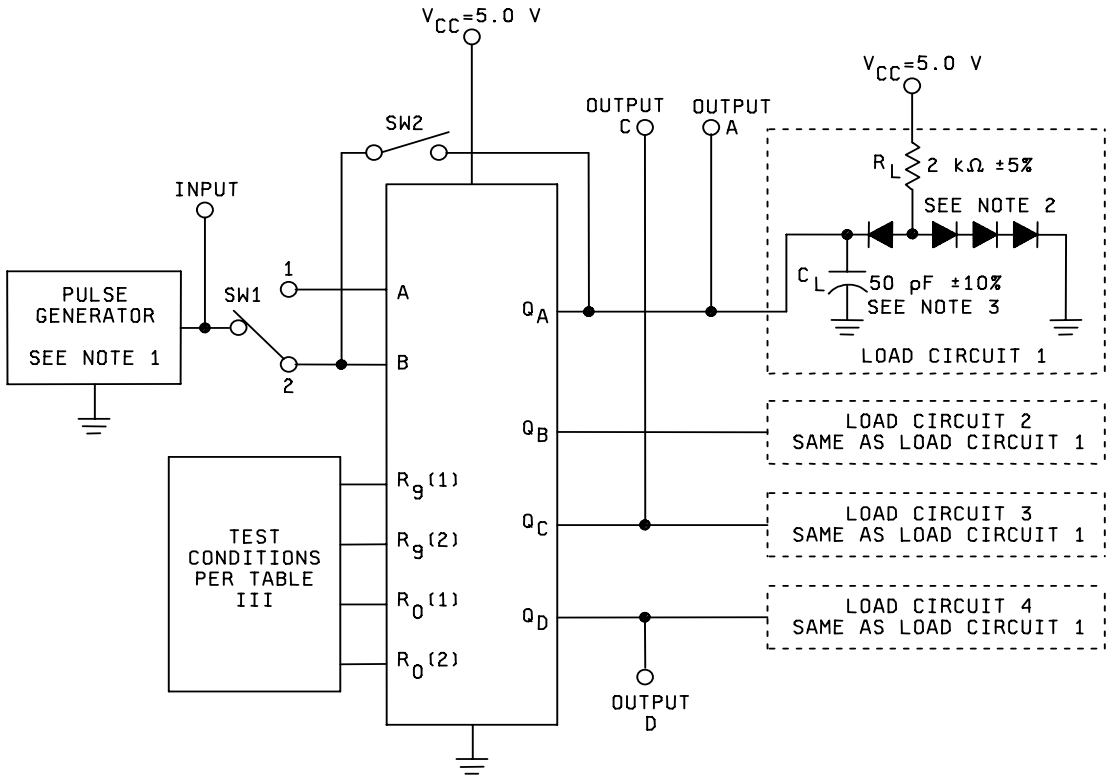


FIGURE 4. Switching time test circuit and waveforms for device type 01.

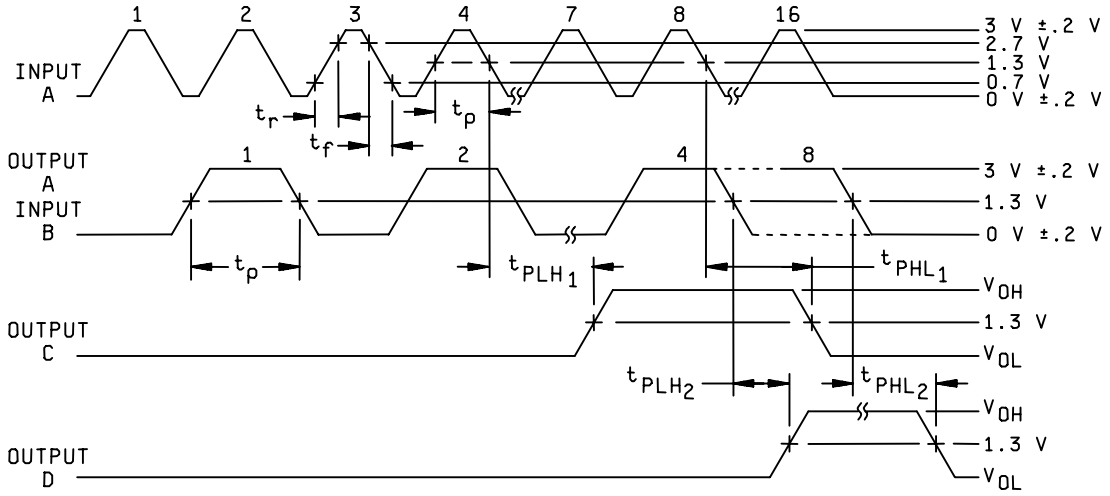


TEST	SWITCH POSITION	
	SW1	SW2
F MAX	1	CLOSED
A TO Q_C	1	CLOSED
B TO Q_D	2	OPEN

TEST CIRCUIT

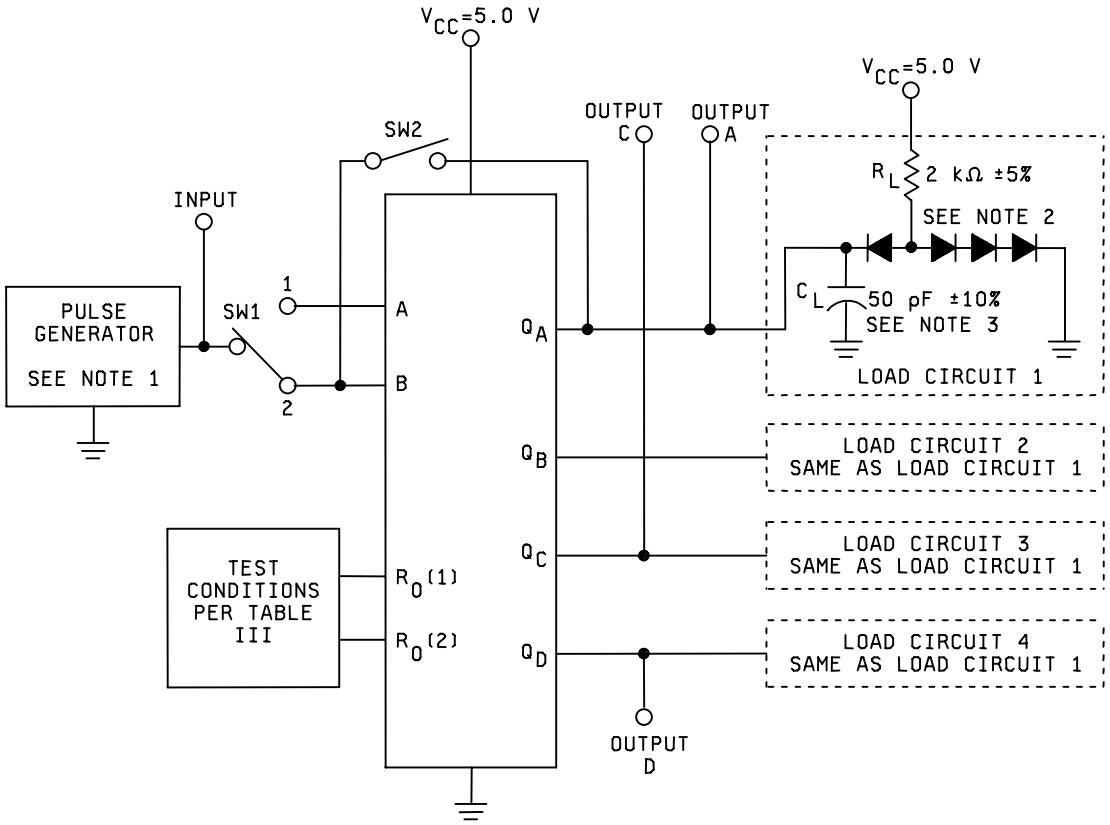
NOTES:
1. The pulse generator has the following characteristics: V_{gen} = 3 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, t_p = .5 µs, PRR ≤ 1 MHz, $Z_{out} \approx 50\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX}: $t_r = t_f \leq 6$ ns.

FIGURE 4. Switching time test circuit and waveforms for device type 01 – Continued.



VOLTAGE WAVEFORMS

FIGURE 5. Switching time test circuit and waveforms for device type 02.

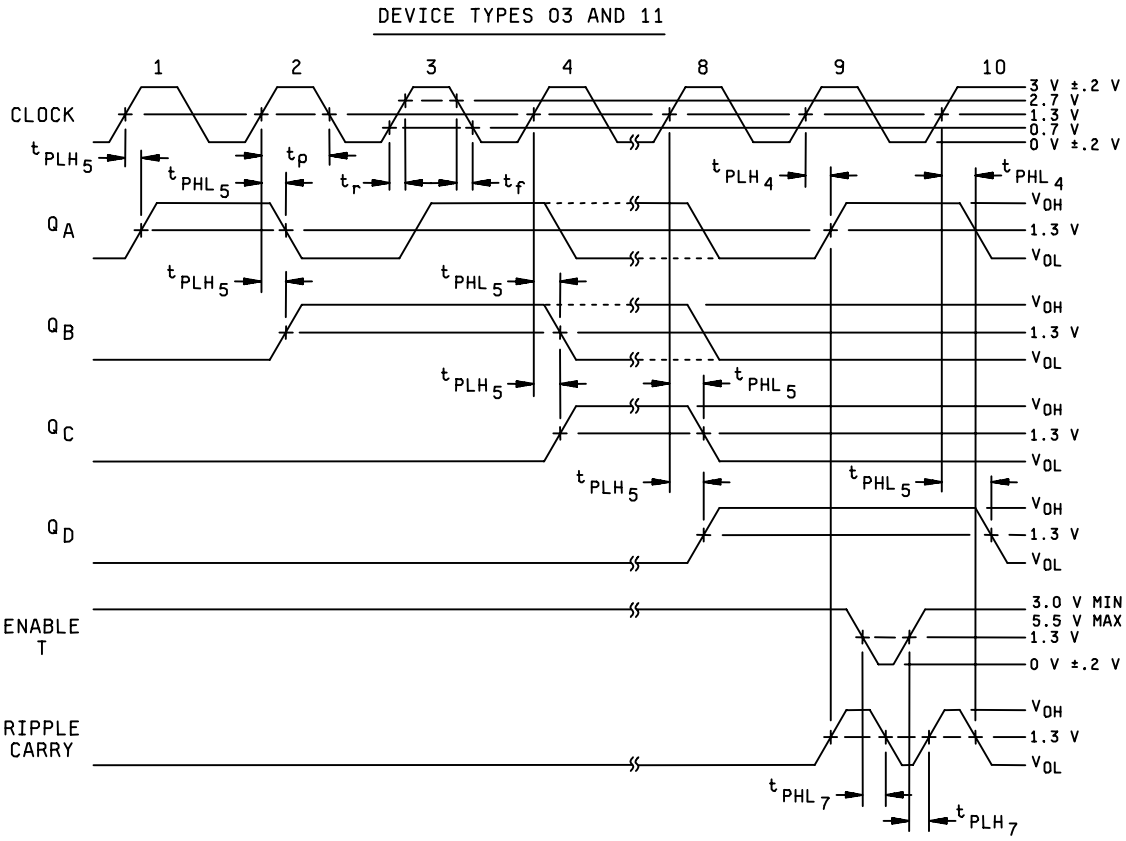


TEST	SWITCH POSITION	
	SW1	SW2
F MAX	1	CLOSED
A TO Q_C	1	CLOSED
B TO Q_D	2	OPEN

TEST CIRCUIT

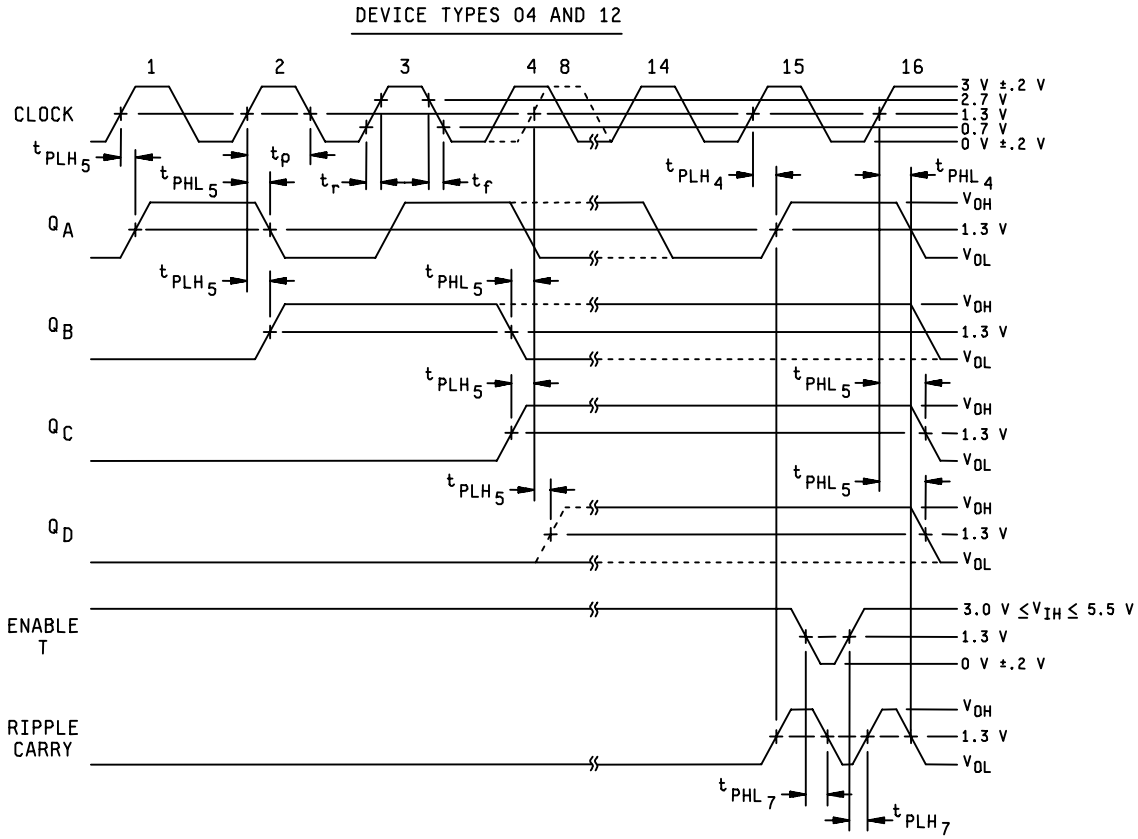
NOTES:
1. The pulse generator has the following characteristics: V_{gen} = 3 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, t_p = .5 µs, PRR ≤ 1 MHz, $Z_{out} \approx 50\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX}: $t_r = t_f \leq 6$ ns.

FIGURE 5. Switching time test circuit and waveforms for device type 02 – Continued.



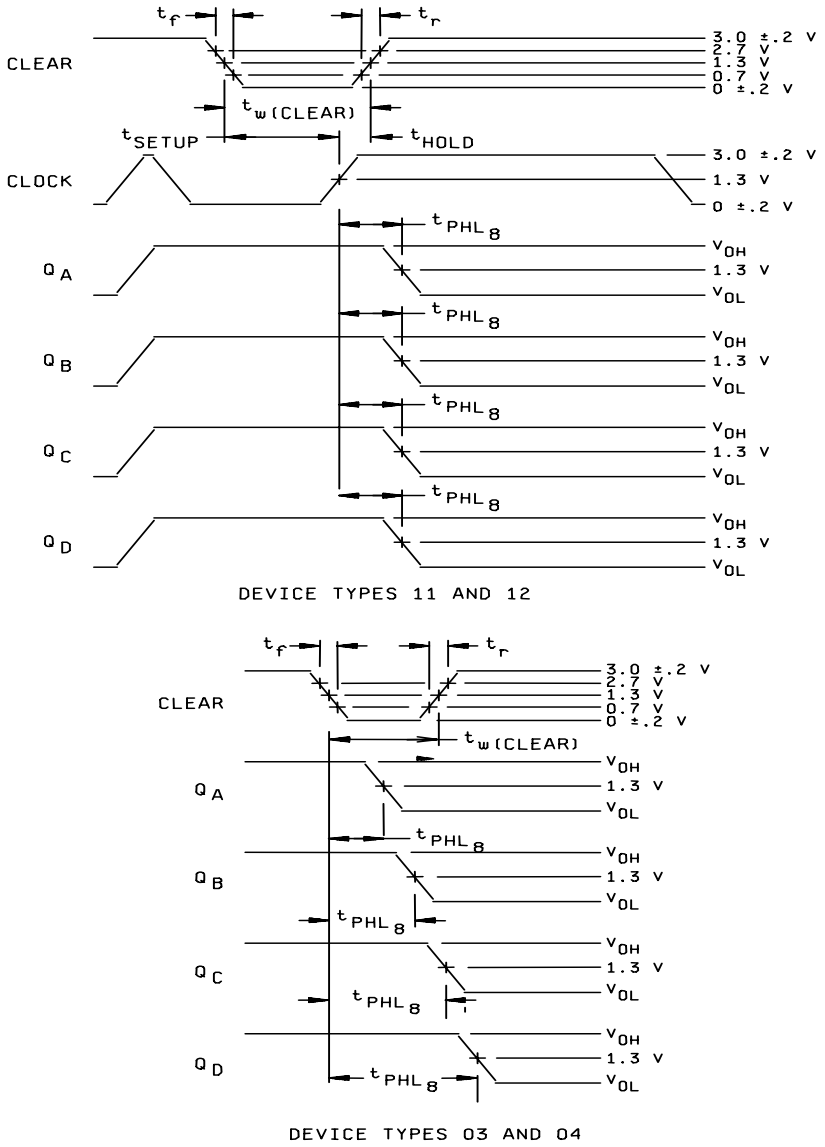
VOLTAGE WAVEFORMS

FIGURE 6. Switching time test circuit and waveforms for device types 03, 04, 11, and 12.



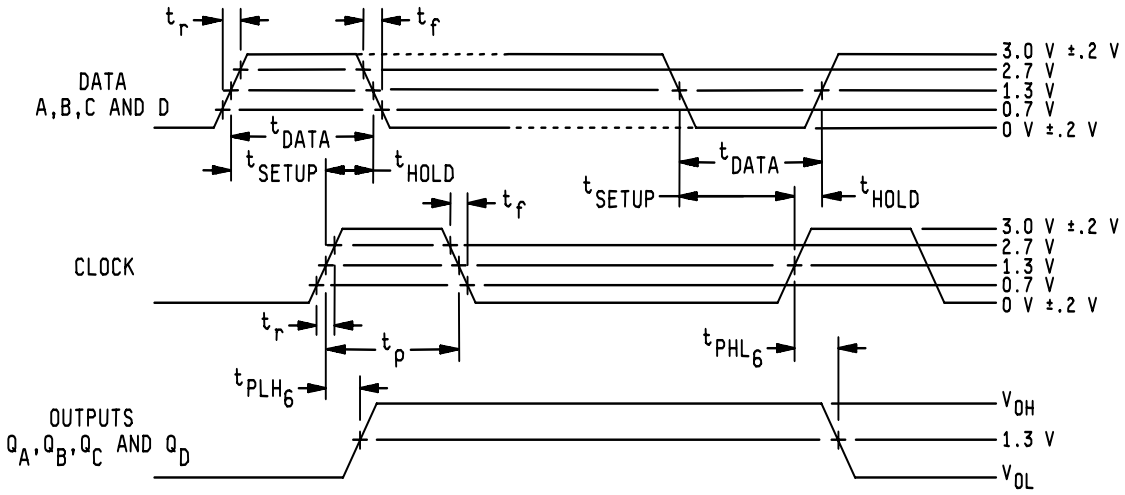
VOLTAGE WAVEFORMS

FIGURE 6. Switching time test circuit and waveforms for device types 03, 04, 11, and 12 – Continued.



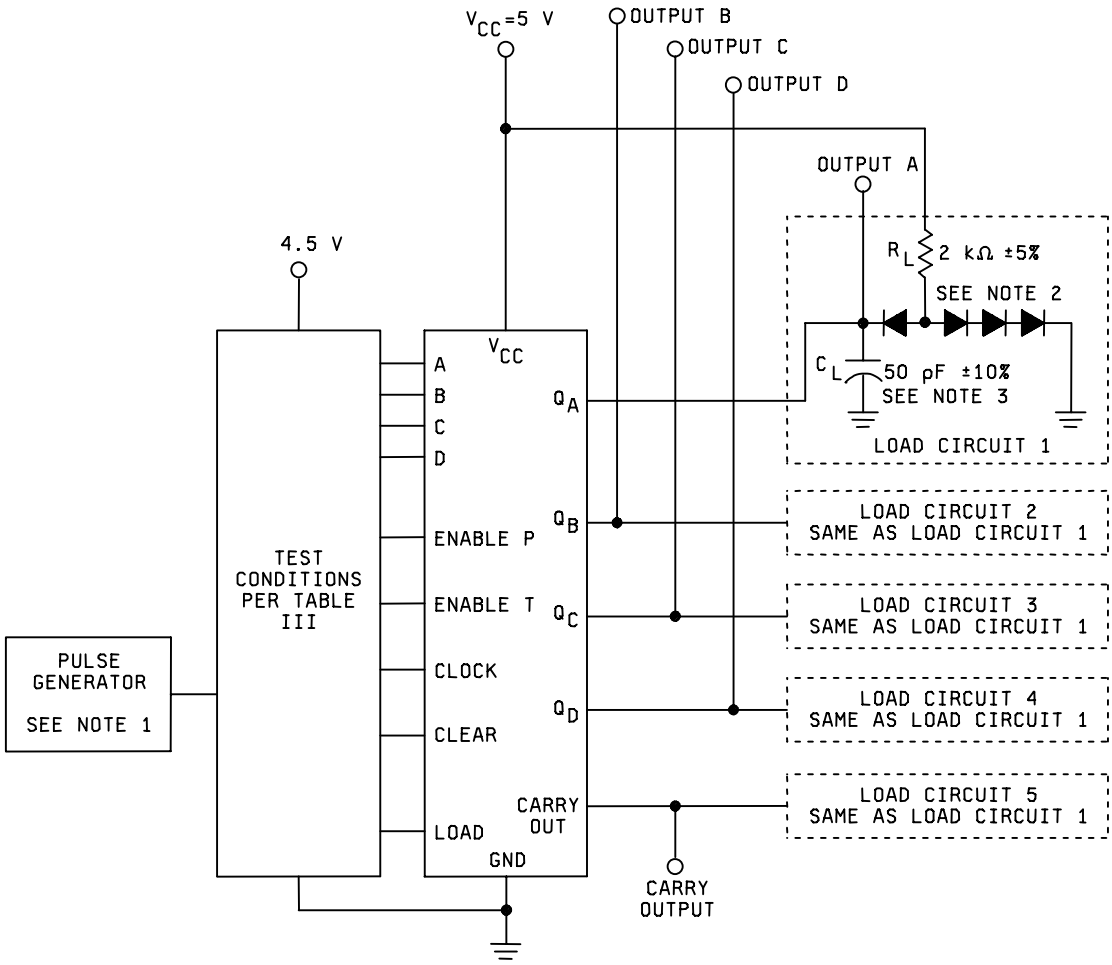
NOTE: The clear pulse generator has the following characteristics:
V_{gen} = 3.0 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, 20 ns $\leq t_{w(clear)} \leq 25$ ns for types 11 and 12, 20 ns $\leq t_{setup} \leq 25$ ns, $t_{hold} = 0$ ns.

FIGURE 6. Switching time test circuit and waveforms for device types 03, 04, 11, and 12 – Continued.



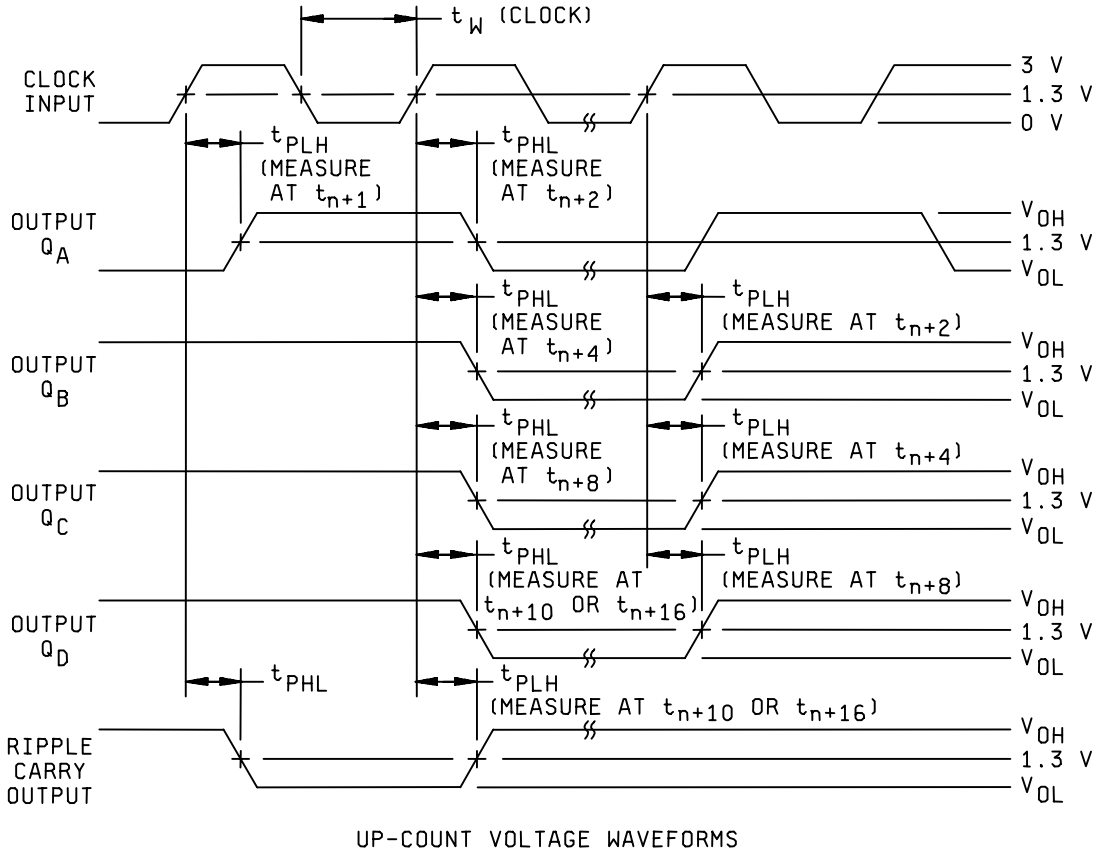
NOTE: The data pulse generator has the following characteristics: V_{gern} = 3.0 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, t_{DATA} = 30 ns, t_{setup} = 20 ns, t_{HOLD} = 10 ns.

FIGURE 6. Switching time test circuit and waveforms for device types 03, 04, 11, and 12 – Continued.



NOTES:
1. The pulse generator has the following characteristics: V_{gen} = 3 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, t_p = .5 µs, PRR ≤ 1 MHz, $Z_{out} \approx 50\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX}: $t_r = t_f \leq 6$ ns.

FIGURE 6. Switching time test circuit and waveforms for device type 03, 04, 11, and 12 – Continued.



UP-COUNT VOLTAGE WAVEFORMS

FIGURE 7. Switching time test circuit and waveforms for device types 05 and 06.

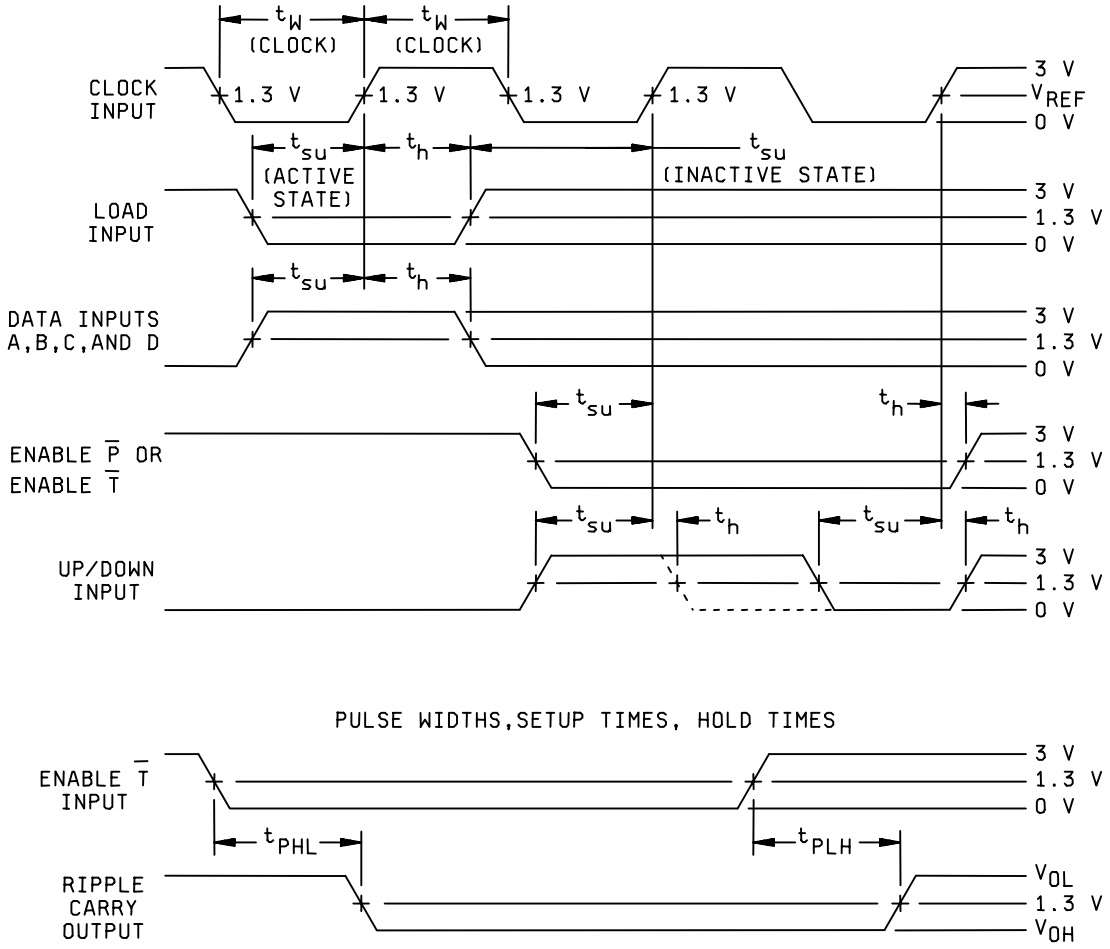
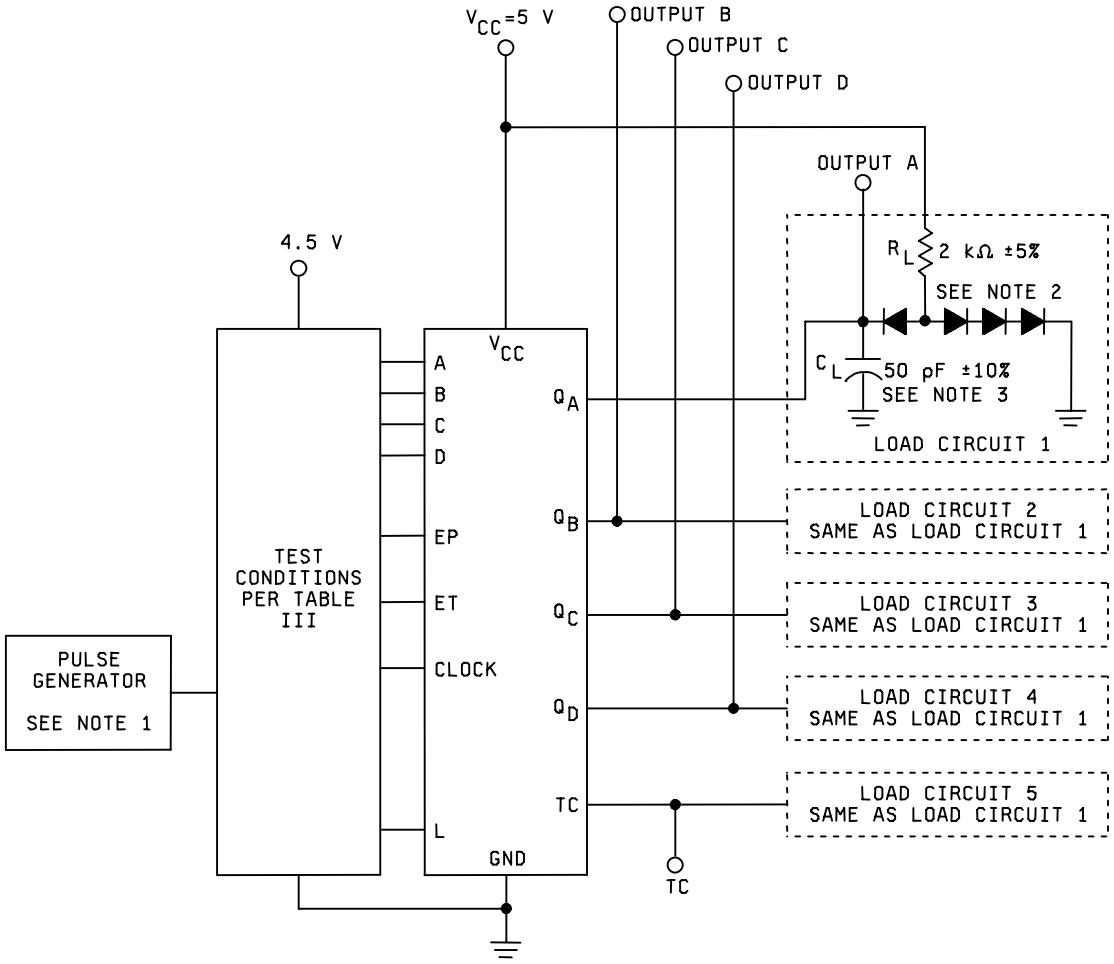
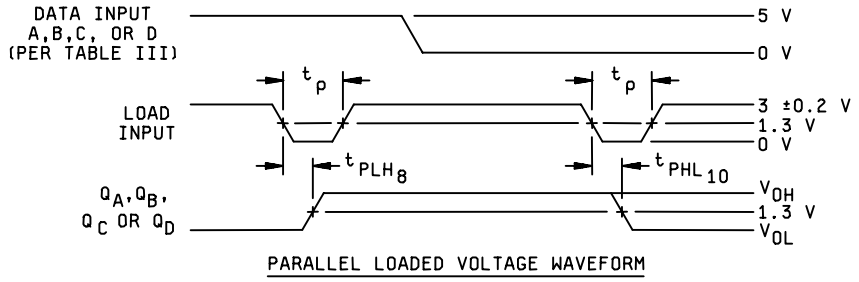


FIGURE 7. Switching time test circuit and waveforms for device types 05 and 06 – Continued.

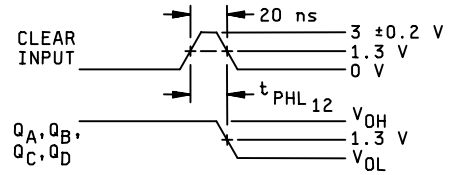


NOTES:
1. The pulse generator has the following characteristics: V_{gen} = 3 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, t_p = .5 µs, PRR ≤ 1 MHz, $Z_{out} \approx 50\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX}: $t_r = t_f \leq 6$ ns.
6. The clear pulse generator has the following characteristics: V_{gen} = 3.0 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, $t_{w(CLEAR)}$ = 20 ns.

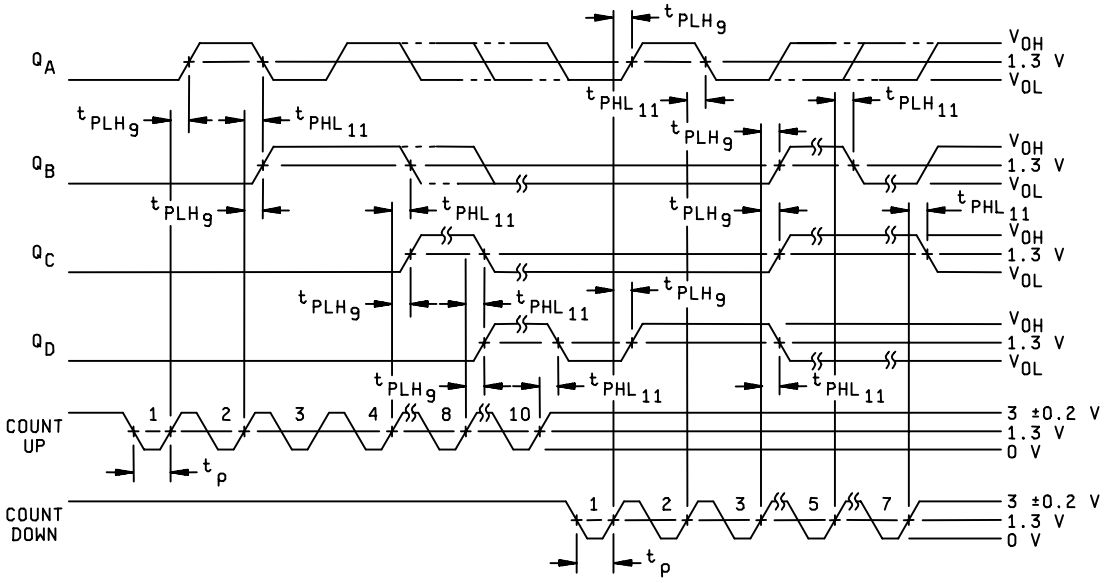
FIGURE 7. Switching time test circuit and waveforms for device types 05 and 06 – Continued.



PARALLEL LOADED VOLTAGE WAVEFORM

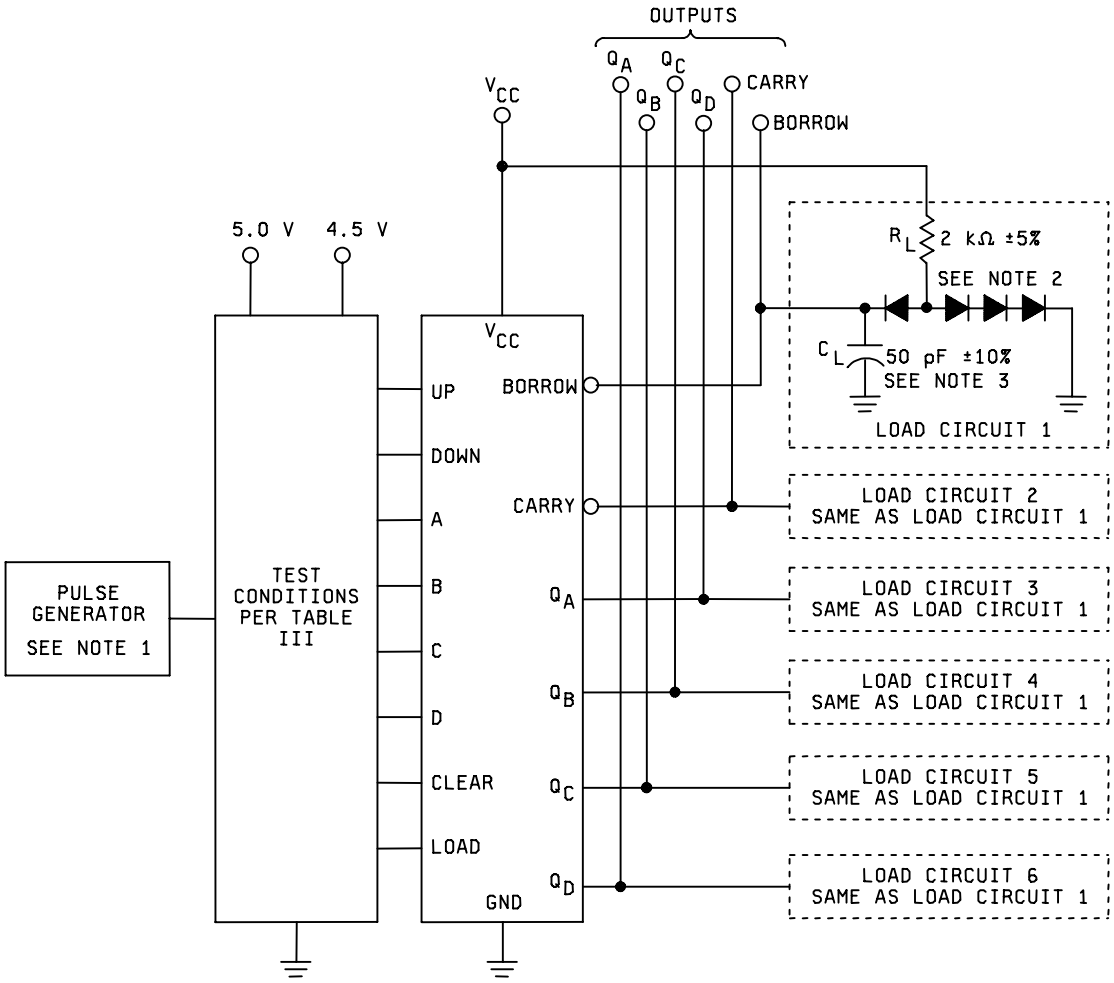


CLEAR SWITCHING VOLTAGE WAVEFORM



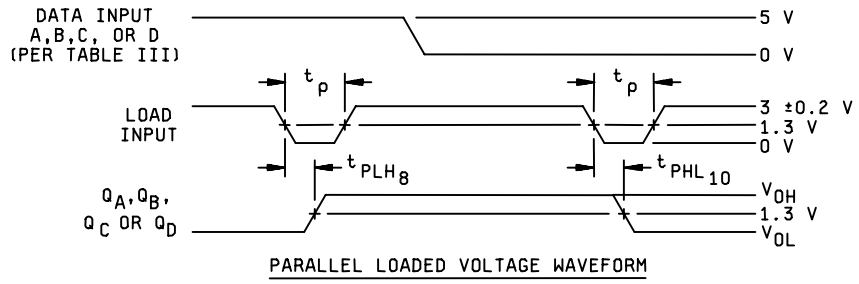
SERIAL LOADED VOLTAGE WAVEFORMS

FIGURE 8. Switching time test circuit and waveforms for device types 07.

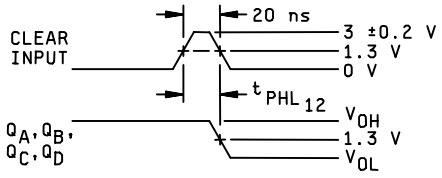


NOTES:
1. The pulse generator has the following characteristics: V_{gen} = 3 V, t_p = .5 µs, PRR ≤ 1 MHz, Z_{out} ≈ 50Ω, t_r ≤ 15 ns, t_f ≤ 6 ns between 0.7 V and 2.7 V.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX}: $t_r = t_f \leq 6$ ns.
6. The clear pulse generator has the following characteristics: V_{gen} = 3.0 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, between 0.7 V and 2.7 V, $t_{w(CLEAR)}$ = 20 ns.

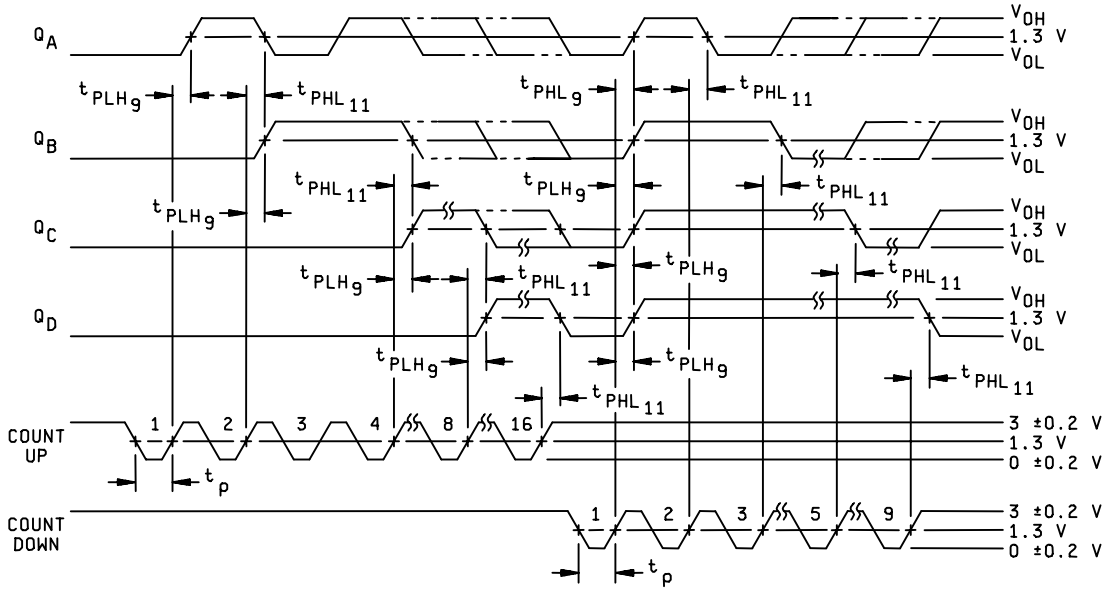
FIGURE 8. Switching time test circuit and waveforms for device types 07 and Continued.



PARALLEL LOADED VOLTAGE WAVEFORM

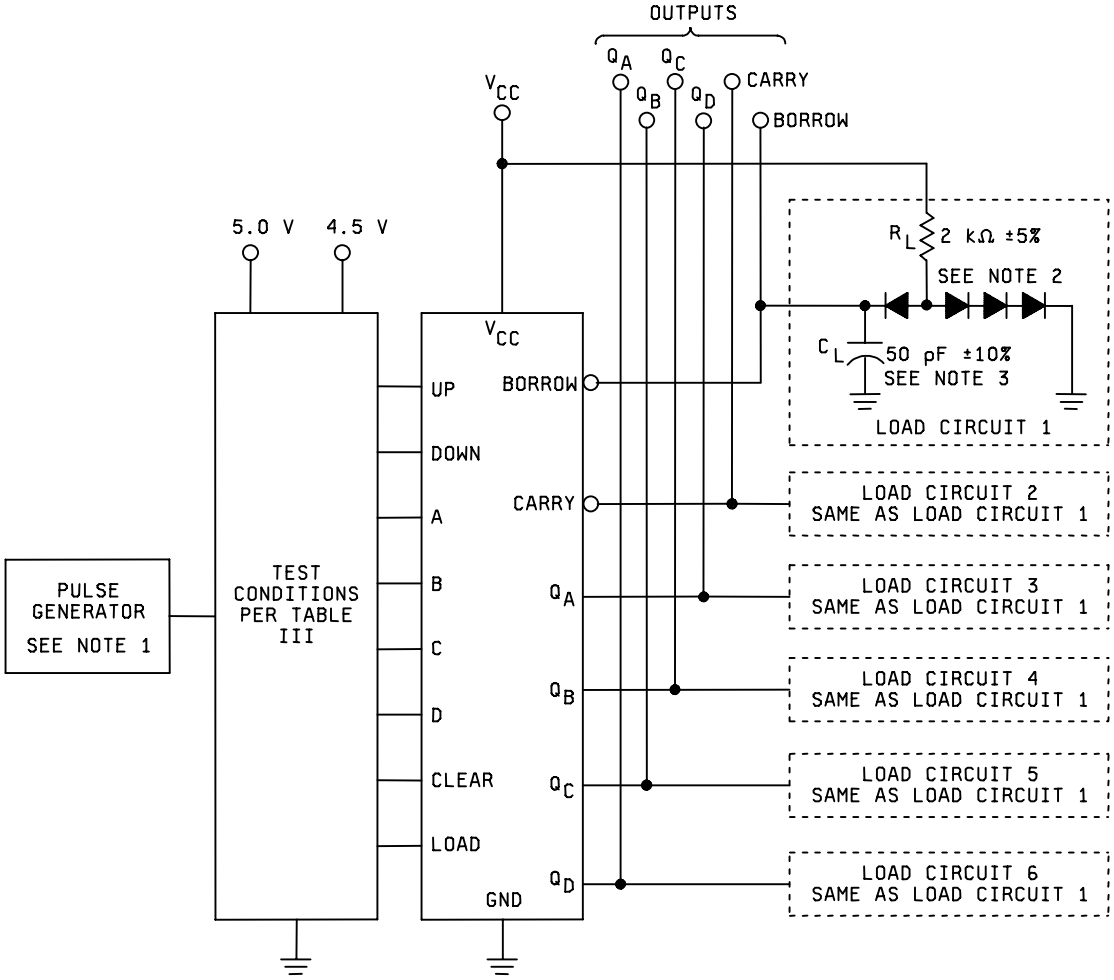


CLEAR SWITCHING VOLTAGE WAVEFORM



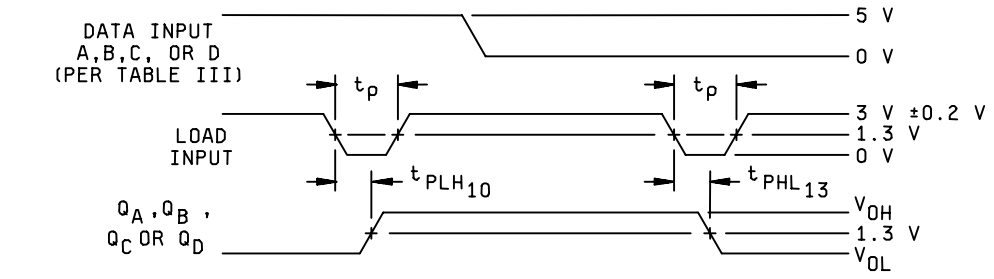
SERIAL LOADED VOLTAGE WAVEFORMS

FIGURE 9. Switching time test circuit and waveforms for device type 08.

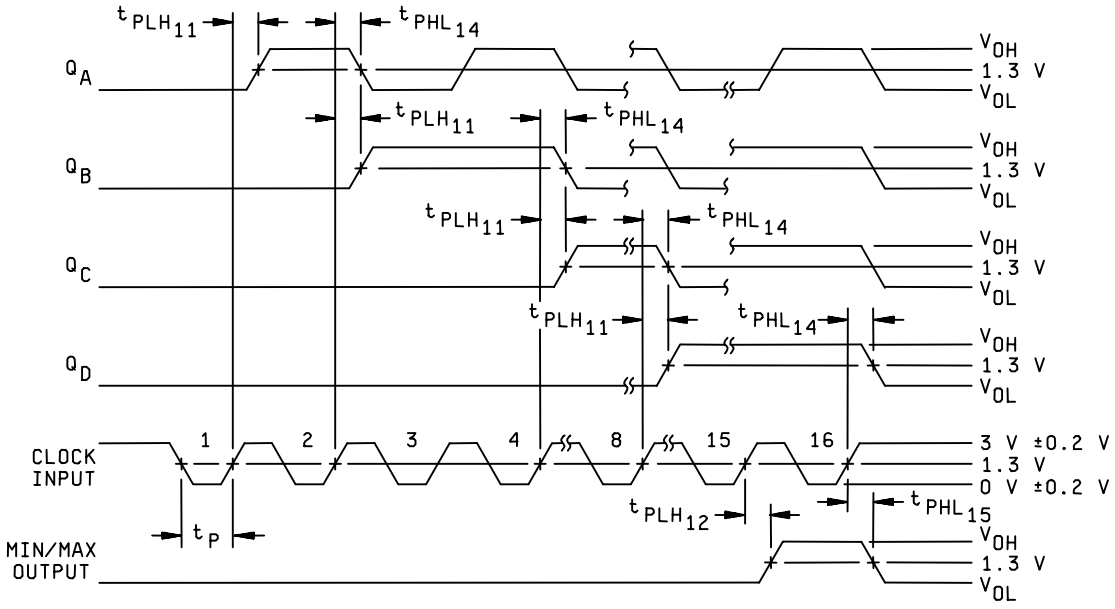


NOTES:
1. The load and count pulse generators have the following characteristics: V_{gen} = 3 V, t_p = .5 µs, PRR ≤ 1 MHz, Z_{out} ≈ 50Ω, t_r ≤ 15 ns, t_f ≤ 6 ns between 0.7 V and 2.7 V.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX}: $t_r = t_f \leq 6$ ns.
6. The clear pulse generator has the following characteristics: V_{gen} = 3.0 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, between 0.7 V and 2.7 V, $t_{w(CLEAR)}$ = 20 ns.

FIGURE 9. Switching time test circuit and waveforms for device type 08 – Continued.

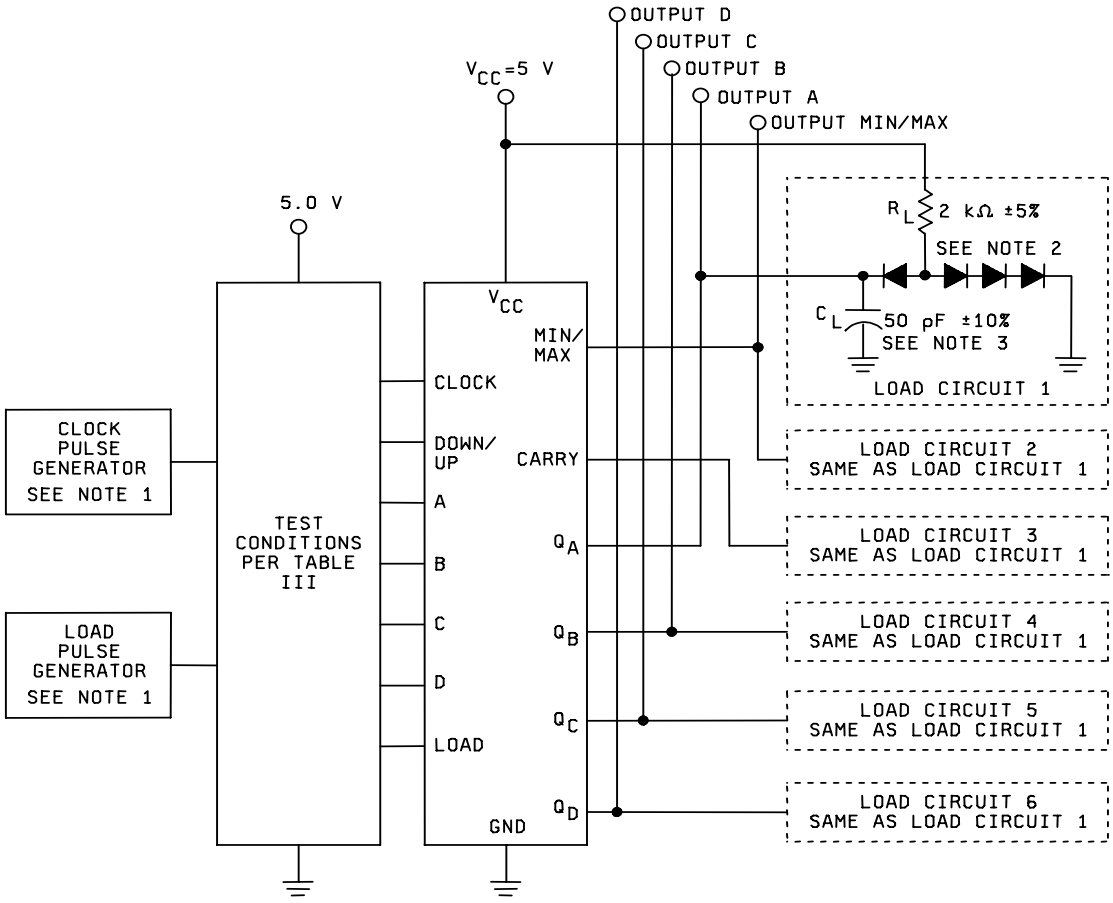


PARALLEL LOADED VOLTAGE WAVEFORMS



SERIAL LOADED VOLTAGE WAVEFORMS
(COUNT UP MODE)

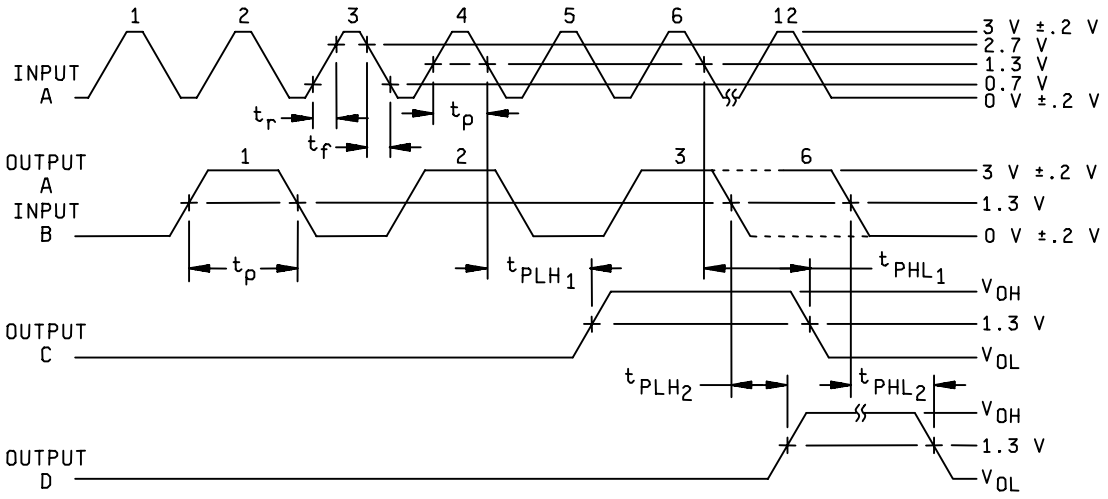
FIGURE 10. Switching time test circuit and waveforms for device type 09.



TEST CIRCUIT

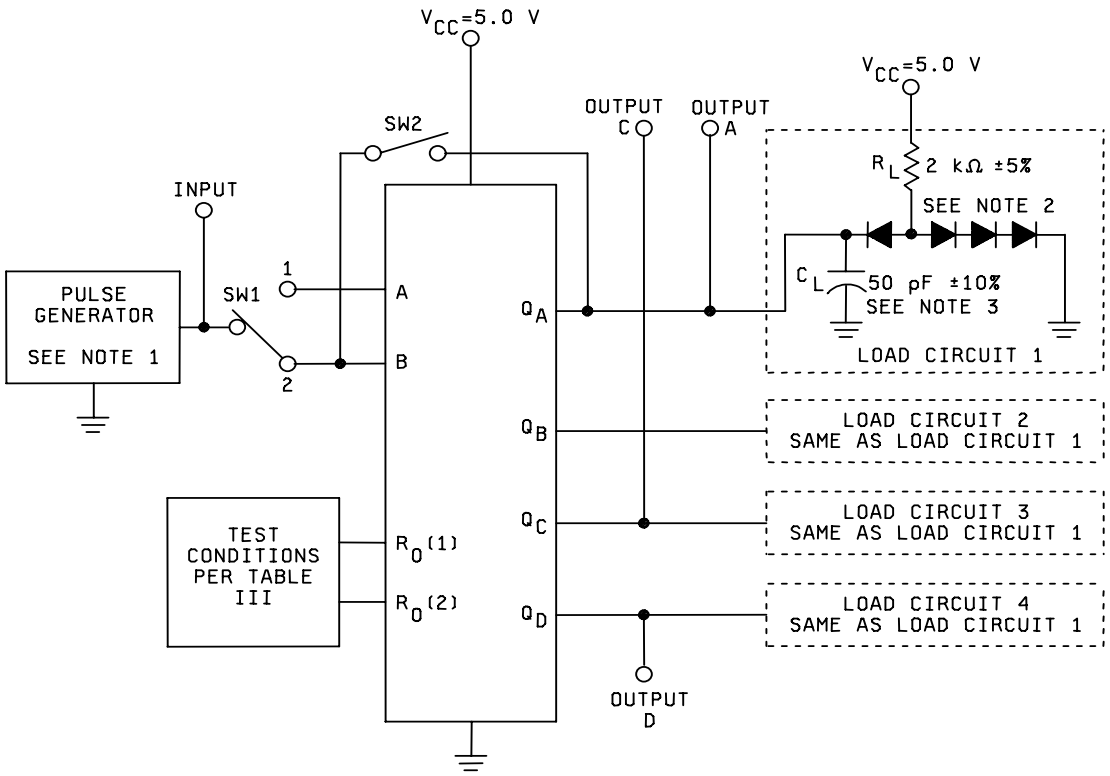
NOTES:
1. The pulse generator has the following characteristics: V_{gen} = 3 V, t_p = .5 µs, PRR ≤ 1 MHz, Z_{out} ≈ 50Ω, t_r ≤ 15 ns, t_f ≤ 6 ns between 0.7 V and 2.7 V.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX}: $t_r = t_f \leq 6$ ns.

FIGURE 10. Switching time test circuit and waveforms for device type 09 – Continued.



VOLTAGE WAVEFORMS

FIGURE 11. Switching time test circuit and waveforms for device type 10.

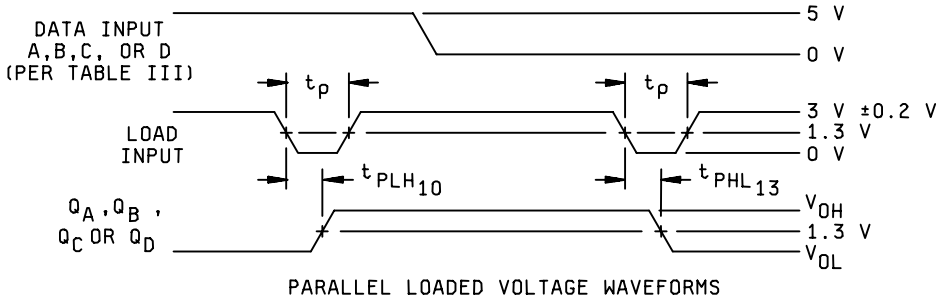


TEST	SWITCH POSITION	
	SW1	SW2
F MAX	1	CLOSED
A TO Q_C	1	CLOSED
B TO Q_D	2	OPEN

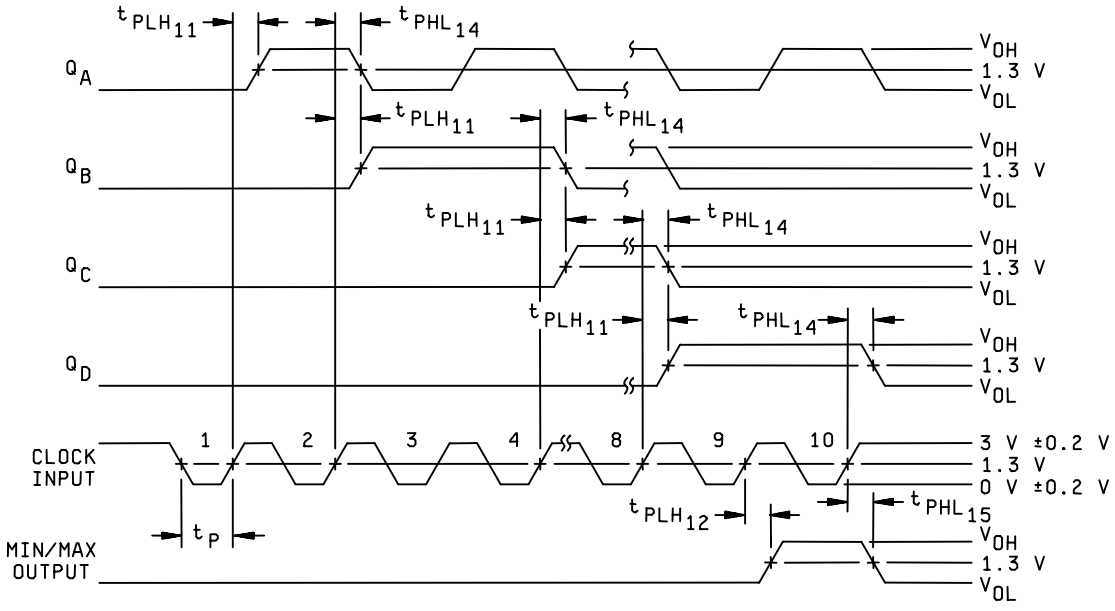
TEST CIRCUIT

NOTES:
1. The pulse generator has the following characteristics: V_{gen} = 3 V, $t_r \leq 15$ ns, $t_f \leq 6$ ns, t_p = .5 µs, PRR ≤ 1 MHz, $Z_{out} \approx 50\Omega$.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX}: $t_r = t_f \leq 6$ ns.

FIGURE 11. Switching time test circuit and waveforms for device type 10 – Continued.

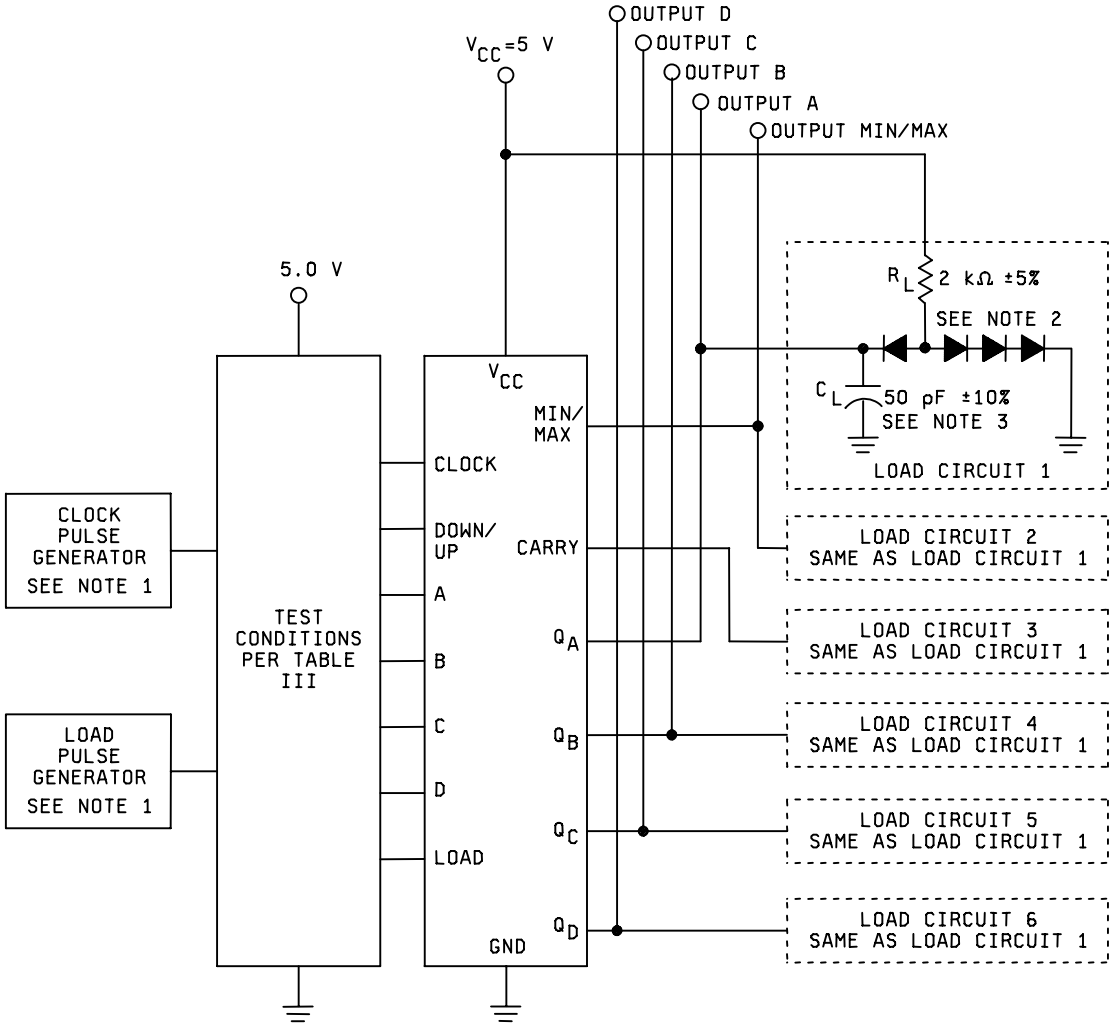


PARALLEL LOADED VOLTAGE WAVEFORMS



SERIAL LOADED VOLTAGE WAVEFORMS
(COUNT UP MODE)

FIGURE 12. Switching time test circuit and waveforms for device type 13.



NOTES:
1. The pulse generator have the following characteristics: V_{gen} = 3 V, t_p = .5 µs, PRR ≤ 1 MHz, Z_{out} ≈ 50Ω, t_r ≤ 15 ns, t_f ≤ 6 ns, between 0.7 V and 2.7 V.
2. All diodes are 1N3064 or equivalent.
3. C_L includes probe and jig capacitance.
4. Voltage values are with respect to ground terminal.
5. F_{MAX}: $t_r = t_f \leq 6$ ns.

Figure 12. Switching time test circuit and waveforms for device type 13 - Continued.

TABLE III. Group A inspection for device type 01.

Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	
			Cases 1/ 2	2	3	4	6	8	9	10	12	13	14	16	18	19	20	Mea
			Test no.	B	$R_O(1)$	$R_O(2)$	NC	V_{CC}	R9(1)	R9(2)	Q_C	Q_B	GND	Q_D	Q_A	NC	A	ter
1 Tc = 25°C	V_{OL}	3007	1	2.0 V	2.0 V	2.0 V		4.5 V	GND	GND	4mA		GND				GND	
		"	2	"	"	"		"	GND	GND		4 mA	"				"	
		"	3	"	"	"		"	2.0 V	0.7 V			"	4 mA			"	
		"	4	GND	"	"		"	0.7 V	2.0 V			"		2/		2.0 V	
		"	5	2.0 V	"	0.7 V		"	2.0 V	"	4 mA		"				GND	
		"	6	2.0 V	0.7 V	2.0 V		"	"	"		4 mA	"				"	
	V_{OH}	3006	7	2.0 V	2.0 V	0.7 V		"	"	"			"	-0.4 mA			"	
		"	8	GND	0.7 V	2.0 V		"	"	"			"		-0.4 mA		2.0 V	
		"	9	2.0 V	"	0.7 V		"	"	"			"	-0.4 mA			GND	
		"	10	GND	"	0.7 V		"	"	"			"		-0.4 mA		2.0 V	
		"	11	3/ 4/	3/	3/		"	0.7 V	0.7 V	-0.4 mA		"				GND	
		"	12	3/ 5/	3/	3/		"	0.7 V	0.7 V		-0.4 mA	"				GND	
	I_{IL1}	3009	13		0.4 V	5.5 V		5.5 V					"					R
		"	14		5.5 V	0.4 V		"					"					R
		"	15					"	0.4 V	5.5 V			"					R
		"	16					"	5.5 V	0.4 V			"					R
	I_{IL2}		17		GND	GND		"	3/	3/			"				0.4 V	
	I_{IL3}		18	0.4 V	GND	GND		"	3/	3/			"					
	V_{IC}		19					4.5 V	-18 mA				"					R
			20					"		-18 mA			"					R
			21					"					"				-18 mA	
			22	-18 mA				"					"					
			23		-18 mA			"					"					R
			24			-18 mA		"					"					R
	I_{IH1}	3010	25					5.5 V	2.7 V				"					R
		"	26					"		2.7 V			"					R
		"	27		2.7 V			"					"					R
		"	28			2.7 V		"					"					R
	I_{IH2}	"	29					"	5.5 V				"					R
		"	30					"		5.5 V			"					R
		"	31		5.5 V			"					"					R
		"	32			5.5 V		"					"					R
	I_{IH3}	"	33					"					"				2.7 V	
	I_{IH4}	"	34					"					"				5.5 V	
	I_{IH5}	"	35	2.7 V				"					"					
	I_{IH6}	"	36	5.5 V				"					"					

See footnotes at end of device types 01.

TABLE III. Group A inspection for device type 01 - Continued

Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D Cases 1/ 2 Test no.	1 2 B	2 3 $R_O(1)$	3 4 $R_O(2)$	4 6 NC	5 8 V_{CC}	6 9 R9(1)	7 10 R9(2)	8 12 Q_C	9 13 Q_B	10 14 GND	11 16 Q_D	12 18 Q_A	13 19 NC	14 20 A
1 Tc = 25°C	I_{OS}	3011	37		GND	GND		5.5 V	5.5 V	5.5 V			GND	GND			
		"	38		GND	GND		"	5.5 V	5.5 V			"		GND		
		"	39	3/ 5/	3/	3/		"	GND	GND		GND	"				GND
		"	40	3/ 4/	"	"		"	"	"	GND		"				"
	I_{CC}		41	GND	"	"		"	"	"			"				"
2	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = 125°C and V_{IC} tests are omitted.																
3	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = -55°C and V_{IC} tests are omitted.																
7 T_C = +25°C	Func- tional tests 7/	3014	42	A 8/	A 8/	A 8/		4.5 V	A	A	L	L	GND	H	H		B 8/
		"	43	B	"	"		"	A	A	"	"	"	H	H		"
		"	44	B	"	"		"	B	B	"	"	"	L	L		"
		"	45	A	B	B		"	A	A	"	"	"	H	H		"
		"	46	B	B	B		"	A	A	"	"	"	H	H		"
		"	47	B	A	A		"	B	B	"	"	"	L	L		"
		"	48	A	A	"		"	"	B	"	"	"	"	"		"
		"	49	B	A	"		"	"	A	"	"	"	"	"		"
		"	50	A	A	"		"	"	"	"	"	"	"	"		"
		"	51	B	A	"		"	"	"	"	"	"	"	"		"
		"	52	A	B	"		"	"	"	"	"	"	"	"		"
		"	53	B	B	"		"	"	"	"	H	"	"	"		"
		"	54	A	"	"		"	"	"	"	H	"	"	"		"
		"	55	B	"	"		"	"	"	H	L	"	"	"		"
		"	56	A	"	"		"	"	"	"	L	"	"	"		"
		"	57	B	"	"		"	"	"	"	H	"	"	"		"
		"	58	A	"	"		"	"	"	"	H	"	"	"		"
		"	59	B	"	"		"	"	"	L	L	"	H	"		"
		"	60	A	"	"		"	"	"	"	"	"	H	"		"
		"	61	B	"	"		"	"	"	"	"	"	L	"		"
		"	62	B	"	B		"	"	B	"	"	"	"	"		"
		"	63	A	"	"		"	A	"	"	"	"	"	"		"
		"	64	B	A	"		"	"	"	"	H	"	"	"		"
		"	65	A	"	"		"	"	"	"	H	"	"	"		"
		"	66	B	"	"		"	"	"	H	L	"	"	"		"
		"	67	A	"	"		"	"	"	"	L	"	"	"		"
		"	68	B	"	"		"	"	"	"	H	"	"	"		"
		"	69	A	"	"		"	"	"	"	H	"	"	"		"
		"	70	B	"	"		"	"	"	L	L	"	H	"		"
		"	71	A	"	"		"	"	"	"	"	"	H	"		"
		"	72	B	"	"		"	"	"	"	"	"	L	"		"
		"	73	B	B	"		"	B	"	"	"	"	"	"		"
		"	74	A	B	"		"	"	"	"	"	"	"	"		"
		"	75	B	A	"		"	"	A	"	H	"	"	"		"
		"	76	A	"	"		"	"	"	"	H	"	"	"		"
		"	77	B	"	"		"	"	"	H	L	"	"	"		"
		"	78	A	"	"		"	"	"	"	L	"	"	"		"
		"	79	B	"	"		"	"	"	"	H	"	"	"		"
		"	80	B	"	A		"	"	B	L	L	"	"	"		"
		"	81	B	B	"		"	A	"	"	"	"	"	"		"
		"	82	A	"	"		"	"	"	"	"	"	"	"		"
		"	83	B	"	"		"	"	"	"	H	"	"	"		"
		"	84	A	"	"		"	"	"	"	H	"	"	"		"
		"	85	B	"	"		"	"	"	H	L	"	"	"		"

See footnotes at end of device type 01.

TABLE III. Group A inspection for device type 01 - Continued

Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D Cases 1/ 2 Test no.	1 2 B	2 3 $R_O(1)$	3 4 $R_O(2)$	4 6 NC	5 8 V_{CC}	6 9 R9(1)	7 10 R9(2)	8 12 Q_C	9 13 Q_B	10 14 GND	11 16 Q_D	12 18 Q_A	13 19 NC	14 20 A
7 T_C = +25°C	Func- tional tests 7/	3014	86	A 8/	B 8/	A		4.5 V	A	B	H	L	GND	L	L		B
		"	87	B	"	A		"	"	B	H	H	"	L	L		"
		"	88	A	"	B		"	"	A	L	L	"	H	H		"
		"	89	"	"	B		"	"	B	"	"	"	H	H		"
		"	90	"	A	A		"	B	"	"	"	"	L	L		"
		"	91	B	A	A		"	"	"	"	"	"	"	"		"
		"	92	A	B	B		"	"	"	"	"	"	"	"		"
		"	93	B	"	"		"	"	"	"	H	"	"	"		"
		"	94	A	"	"		"	"	"	"	H	"	"	"		"
		"	95	B	"	"		"	"	"	H	L	"	"	"		"
		"	96	A	"	"		"	"	"	"	L	"	"	"		"
		"	97	B	"	"		"	"	"	"	H	"	"	"		"
		"	98	A	"	"		"	"	"	"	H	"	"	"		"
		"	99	B	A	A		"	"	"	L	L	"	"	"		"
		"	100	B	B	B		"	"	"	"	"	"	"	"		"
		"	101	A	"	"		"	"	"	"	"	"	"	"		"
		"	102	B	"	"		"	"	"	"	H	"	"	"		"
		"	103	A	"	"		"	"	"	"	H	"	"	"		"
		"	104	B	"	"		"	"	"	H	L	"	"	"		"
		"	105	A	"	"		"	"	"	"	L	"	"	"		"
		"	106	B	"	“		"	"	"	"	H	"	"	"		"
		"	107	A	"	"		"	"	"	"	H	"	"	"		"
		"	108	A	"	"		"	A	A	L	L	"	H	H		"
		"	109	B	"	"		"	A	A	"	"	"	"	"		"
		"	110	B	"	"		"	B	B	"	"	"	"	"		"
		"	111	A	"	"		"	"	"	"	"	"	"	"		"
		"	112	A	A	A		"	"	"	"	"	"	L	L		"
		"	113	B	A	A		"	"	"	"	"	"	"	"		"
		"	114	"	B	B		"	"	"	"	"	"	"	"		A
		"	115	"	"	"		"	"	"	"	"	"	"	H		B
		"	116	"	"	"		"	"	"	"	"	"	"	H		A
		"	117	"	"	"		"	"	"	"	"	"	"	L		B
		"	118	"	"	A		"	"	"	"	"	"	"	"		A
		"	119	"	A	A		"	"	"	"	"	"	"	"		B
		"	120	"	A	B		"	"	"	"	"	"	"	"		A
		"	121	"	B	"		"	"	A	"	"	"	"	H		B
		"	122	"	"	"		"	"	"	"	"	"	"	"		A
		"	123	"	"	"		"	A	"	"	"	"	H	"		B
		"	124	"	A	“		"	"	B	"	"	"	"	"		A
		"	125	"	A	A		"	"	A	"	"	"	"	"		B
8	Same tests, terminal conditions, and limits as for subgroup 7, except T_C = 125°C and -55°C.																
9 T_C = +25°C	F_{MAX}	3003 (Fig. 4)	126		GND			5.0 V	GND				GND		OUT		IN 10/
	t_{PLH1}	"	127		11/	A 8/		"	"		OUT		"				IN
	t_{PHL1}	"	128		GND			"	"		OUT		"				IN
	t_{PLH2}	"	129	IN	11/	A		"	"				"	OUT			
	t_{PHL2}	"	130	IN	GND			"	"				"	OUT			
10 T_C = +125°C	F_{MAX}	"	131		GND			"	"				"		OUT		IN 10/
	t_{PLH1}	"	132		11/	A		"	"		OUT		"				IN
	t_{PHL1}	"	133		GND			"	"		OUT		"				IN
	t_{PLH2}	"	134	IN	11/	A		"	"				"	OUT			
	t_{PHL2}	"	135	IN	GND			"	"				"	OUT			
11	Same tests, terminal conditions, and limits as for subgroup 10, except T_C = -55°C.																

See footnotes at end of device type 01.

1/ Case 2 pins not referenced are N/C.

2/ Test 4, Pin 12; 4 mA + $I_{IL3(MAX).}$

3/ Apply 4.5 V pulse then ground prior to taking measurements to set device in the desired state.

4/ Apply two pulses after R_O (reset) pulse.

5/ Apply one pulse after R_O (reset) pulse.

6/ I_{IL} limits (mA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I_{IL1}	R_O(1)	-12/-.36	-.03/-.40		-.03/-.40	-12/-.36	-12/-.36	
	R_O(2)	"	"		"	"	"	
	R9(1)	"	"		"	"	"	
	R9(2)	"	"		"	"	"	
I_{IL2}	A	-0.5/-2.0	-1.0/-2.4		-1.0/-2.4	-1.0/-2.4	-0.5/-2.0	
I_{IL3}	B	-0.4/-1.6	-1.3/-3.2		-1.3/-3.2	-1.3/-3.2	-1.0/-2.4	

7/ Only a summary of attributes data is required.

8/ A = 3.0 V minimum, B = 0.0 V or GND.

9/ H > 1.5 V; L < 1.5 V.

10/ F_{MAX} minimum limit specified is the frequency of the input pulse. The output pulse shall be one-half of the input frequency.

11/ Momentary 3.0 V (min), then ground. Maintain ground for measurement.

TABLE III. Group A inspection for device type 02.

Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Mea ter
			Cases 1/ 2	2	3	4	6	8	9	10	12	13	14	16	18	19	20	
			Test no.	B	R_O(1)	R_O(2)	NC	V_{CC}	NC	NC	Q_C	Q_B	GND	Q_D	Q_A	NC	A	
1 Tc = 25°C	V_{OL}	3007	1	GND	2.0 V	2.0 V		4.5 V					GND		2/		2.0 V	
		"	2	2.0 V	"	"		"				4 mA	"				GND	
		"	3	"	"	"		"			4mA		"				"	
		"	4	"	"	"		"					"	4 mA			"	
	V_{OH}	3006	5	GND	3/	3/		"					"		-0.4 mA		3/ 4/	
		"	6	3/ 4/	3/	"		"				-0.4 mA	"				GND	
		"	7	3/ 5/	"	"		"			-0.4 mA		"				"	
		"	8	3/ 6/	"	"		"					"	-0.4 mA			"	
	V_{IC}		9					"					"				-18 mA	
			10	-18 mA				"					"					
			11		-18 mA			"					"					R_L
			12			-18 mA		"					"					R_L
	I_{IL1}	3009	13		0.4 V	5.5 V		5.5 V					"					R_L
		"	14		5.5 V	0.4 V		"					"					R_L
	I_{IL2}	"	15		3/	3/		"					"				0.4 V	
	I_{IL3}	"	16	0.4 V	3/	3/		"					"					
	I_{IH1}	3010	17		2.7 V	GND		"					"					R_L
	I_{IH1}	"	18		GND	2.7 V		"					"					R_L
	I_{IH2}	"	19		5.5 V	GND		"					"					R
	I_{IH2}	"	20		GND	5.5 V		"					"					R
	I_{IH3}	"	21		5.5 V	"		"					"				2.7 V	
	I_{IH4}	"	22		"	"		"					"				5.5 V	
	I_{IH5}	"	23	2.7 V	"	"		"					"					
	I_{IH6}	"	24	5.5 V	"	"		"					"					
	I_{OS}	3011	25	GND	3/	3/		"					"		GND		3/ 4/	
		"	26	3/ 4/	"	"		"				GND	"				GND	
		"	27	3/ 5/	"	"		"			GND		"				"	
		"	28	3/ 6/	"	"		"					"	GND			"	
	I_{CC}	3005	29	GND				"					"					V
2	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = 125°C and V_{IC} tests are omitted.																	
3	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = -55°C and V_{IC} tests are omitted.																	

See footnotes at end of device types 02.

TABLE III. Group A inspection for device type 02 - Continued

Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D Cases 1/ 2 Test no.	1 2 B	2 3 $R_O(1)$	3 4 $R_O(2)$	4 6 NC	5 8 V_{CC}	6 9 NC	7 10 NC	8 12 Q_C	9 13 Q_B	10 14 GND	11 16 Q_D	12 18 Q_A	13 19 NC	14 20 A
7 Tc = 25°C	Func- tional tests 9/	3014	30	B 9/	A 9/	A		4.5 V			L	L	GND	L	L		B 9/
		"	31	A	"	"		"			"	"	"	"	"		"
		"	32	B	"	"		"			"	"	"	"	"		"
		"	33	B	"	B		"			"	"	"	"	"		"
		"	34	A	"	"		"			"	"	"	"	"		"
		"	35	B	"	"		"			"	H	"	"	"		"
		"	36	"	"	A		"			"	L	"	"	"		"
		"	37	"	B	"		"			"	"	"	"	"		"
		"	38	A	"	"		"			"	"	"	"	"		"
		"	39	A	"	B		"			"	"	"	"	"		"
		"	40	B	"	"		"			"	H	"	"	"		"
		"	41	A	"	"		"			"	H	"	"	"		"
		"	42	B	"	"		"			H	L	"	"	"		"
		"	43	A	"	"		"			"	L	"	"	"		"
		"	44	B	"	"		"			"	H	"	"	"		"
		"	45	A	"	"		"			"	H	"	"	"		"
		"	46	B	"	"		"			L	L	"	H	"		"
		"	47	A	"	"		"			"	L	"	"	"		"
		"	48	B	"	"		"			"	H	"	"	"		"
		"	49	A	"	"		"			"	H	"	"	"		"
		"	50	B	"	"		"			H	L	"	"	"		"
		"	51	A	"	"		"			"	L	"	"	"		"
		"	52	B	"	"		"			"	H	"	"	"		"
		"	53	A	"	"		"			"	H	"	"	"		"
		"	54	B	"	"		"			L	L	"	L	"		"
		"	55	A	"	"		"			"	L	"	"	"		"
		"	56	B	"	"		"			"	H	"	"	"		"
		"	57	A	"	"		"			"	H	"	"	"		"
		"	58	B	"	"		"			H	L	"	"	"		"
		"	59	A	"	"		"			"	L	"	"	"		"
		"	60	B	"	"		"			"	H	"	"	"		"
		"	61	A	"	"		"			"	H	"	"	"		"
		"	62	B	"	"		"			L	L	"	H	"		"
		"	63	A	"	"		"			"	L	"	"	"		"
		"	64	B	"	"		"			"	H	"	"	"		"
		"	65	B	A	"		"			"	"	"	"	"		"
		"	66	A	"	"		"			"	"	"	"	"		"
		"	67	B	"	"		"			H	L	"	"	"		"
		"	68	A	"	"		"			"	L	"	"	"		"
		"	69	B	"	"		"			"	H	"	"	"		"
		"	70	A	"	"		"			"	H	"	"	"		"
		"	71	A	"	A		"			L	L	"	L	"		"
		"	72	B	"	A		"			"	"	"	"	"		"
		"	73	"	B	B		"			"	"	"	"	"		A
		"	74	"	"	"		"			"	"	"	"	H		B
		"	75	"	"	"		"			"	"	"	"	H		A
		"	76	"	"	"		"			"	"	"	"	L		B
8	Same tests, terminal conditions, and limits as for subgroup 7, except T_C = +125°C and -55°C.																
9 T_C = +25°C	F_{MAX}	3003 (Fig. 5)	77		GND			5.0 V					GND		OUT		IN 11/
	t_{PLH1}	"	78		12/	A 9/		"			OUT		"				IN
	t_{PHL1}	"	79		GND			"			OUT		"				IN
	t_{PLH2}	"	80	IN	12/	A		"					"	OUT			
	t_{PHL1}	"	81	IN	GND			"					"	OUT			

See footnotes at end of device type 02.

TABLE III. Group A inspection for device type 02 - Continued

Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,C,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14
			Cases 1/ 2	2	3	4	6	8	9	10	12	13	14	16	18	19	20
			Test no.	B	$R_O(1)$	$R_O(2)$	NC	V_{CC}	NC	NC	Q_C	Q_B	GND	Q_D	Q_A	NC	A
10 T_C = +125°C	F_{MAX}	3003 (Fig. 5)	82		GND			5.0 V					GND		OUT		IN 11/
	t_{PLH1}	"	83		12/	A		"			OUT		"				IN
	t_{PHL1}	"	84		GND			"			OUT		"				IN
	t_{PLH2}	"	85	IN	12/	A		"					"	OUT			
	t_{PHL2}	"	86	IN	GND			"					"	OUT			
11	Same tests, terminal conditions, and limits as for subgroup 10 except, T_C = 55°C																

1/ Case 2 pins not referenced are N/C.

2/ For test 1, 4 mA $+I_{IL3}$ (max).

3/ Apply 4.5 V pulse, then ground prior to taking measurements to set device in the desired state. Maintain ground for measurement.

4/ Input pulse must be applied one time after R_O pulse.

5/ Input pulse must be applied twice after R_O pulse.

6/ Input pulse must be applied four times after R_O pulse.

7/ I_{IL} limits (mA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I_{IL1}	$R_O(1)$	-12/-.36	-.03/-.40	-12/-.36	-.03/-.40	-12/-.36	-12/-.36	
	$R_O(2)$	"	"	"	"	"	"	
I_{IL2}	A	-0.5/-2.0	-1.0/-2.4	-0.5/-2.0	-1.0/-2.4	-1.0/-2.4	-0.5/-2.0	
I_{IL3}	B	-0.4/-1.6	-0.4/-1.6	-0.4/-1.6	-0.4/-1.6	-.65/-1.6	-0.4/-1.6	

8/ Only a summary of attributes data is required.

9/ A = 3.0 V minimum; B = 0.0 V or GND.

10/ H > 1.5 V; L < 1.5 V.

11/ F_{MAX} min limit specified is the frequency of the input pulse. The output frequency shall be one-half the input frequency.

12/ Momentary 3.0 V (min), then ground. Maintain ground for measurement.

TABLE III. Group A inspection for device types 03, 04, 11, and 12.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V_{CC}
1 Tc = +25°C	V_{OL}	3007	1	4.5 V	2/				0.7 V		GND	GND		4 mA					4.5 V
		"	2	"	"			0.7 V			"	"			4 mA				"
		"	3	"	"		0.7 V				"	"				4 mA			"
		"	4	"	"	0.7 V					"	"					4 mA		"
		"	5	"							"	"	0.7 V					4 mA	"
	V_{OH}	3006	6	"	2/				2.0 V		"	GND		-.4 mA					"
		"	7	"	"			2.0 V			"	"			-.4 mA				"
		"	8	"	"		2.0 V				"	"				-.4 mA			"
		"	9	"	"	2.0 V					"	"					-.4 mA		"
		"	10	"	"	2.0 V	3/	3/	2.0 V		"	"	2.0 V					-.4 mA	"
	V_{IC}		11	-18 mA							"								"
			12		-18 mA						"								"
			13			-18 mA					"								"
			14				-18 mA				"								"
			15					-18 mA			"								"
			16						-18 mA		"								"
			17							-18 mA	"								"
			18								"	-18 mA							"
			19								"		-18 mA						"
	I_{IL4}	3009	20	0.4 V							"								5.5 V
	I_{IL6}	"	21		0.4 V						"								"
	I_{IL4}	"	22			0.4 V					"	GND							"
		"	23				0.4 V				"	"							"
		"	24					0.4 V			"	"							"
		"	25						0.4 V		"	"							"
		"	26							0.4 V	"	4.5 V	4.5 V						"
	I_{IL5}	"	27							4.5 V	"	0.4 V	4.5 V						"
	I_{IL5}	"	28 5/							4.5 V	"	4.5 V	0.4 V						"
	I_{IH13}	3010	29 13/	2.7 V							"								"
	I_{IH9}	"	30		2.7 V						"								"
	I_{IH11}	"	31			2.7 V					"								"
		"	32				2.7 V				"								"
		"	33					2.7 V			"								"
		"	34						2.7 V		"								"
		"	35							2.7 V	"	GND	GND						"
	I_{IH9}	"	36							GND	"	2.7 V	GND						"
	I_{IH9}	"	37							GND	"	GND	2.7 V						"

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device types 03, 04, 11, and 12 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V_{CC}
1	I_{IH14}	3010	38 13/	5.5 V							GND								5.5 V
Tc = +25°C	I_{IH10}	"	39		5.5 V						"								"
	I_{IH12}	"	40			5.5 V					"								"
		"	41				5.5 V				"								"
		"	42					5.5 V			"								"
		"	43						5.5 V		"								"
		"	44							5.5 V	"	GND	GND						"
	I_{IH10}	"	45							GND	"	5.5 V	GND						"
	I_{IH10}	"	46							GND	"	GND	5.5 V						"
	I_{OS}	3011	47	4.5 V	2/				4.5 V		"	GND		GND					"
		"	48	"	"			4.5 V			"	"			GND				"
		"	49	"	"		4.5 V				"	"				GND			"
		"	50	"	"	4.5 V					"	"					GND		"
		"	51	"	"	4.5 V	6/	6/	4.5 V		"	"	4.5 V					GND	"
	I_{CCH}	3005	52	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	"	5.5 V	5.5 V						"
	I_{CCH}	"	53	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	"	GND	5.5 V						"
	I_{CCL}	"	54	GND	GND	GND	GND	GND	GND	GND	"	GND	GND						"
	I_{CCL}	"	55	GND	GND	GND	GND	GND	GND	GND	"	GND	GND						"
2	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = 125°C and V_{IC} tests are omitted.																		
3	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = -55°C and V_{IC} tests are omitted.																		

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 03 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
7	Func-	3014	56	B 8/	A 8/	A 8/	A 8/	A	A	A	GND	A	A	L	L	L	L	L	4
Tc = +25°C	tional	"	57	A	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
	tests	"	58	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
	7/	"	59	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	60	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	61	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	62	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	63	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	64	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	65	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	66	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	67	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	68	"	A	A	A	A	A	"	"	"	A	"	H	L	L	"	
		"	69	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	70	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	71	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	72	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	73	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	74	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	75	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	76	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	77	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	78	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	79	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	80	"	A	A	A	A	A	"	"	"	A	H	L	L	L	"	
		"	81	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	82	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	83	"	A	A	A	A	A	"	"	"	A	"	"	"	H	H	
		"	84	"	A	B	B	B	B	"	"	"	B	"	"	"	"	L	
		"	85	"	B	A	A	A	A	"	"	"	A	"	"	"	"	H	
		"	86	"	A	"	"	"	"	"	"	"	"	L	"	"	L	L	
		"	87	B	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	88	A	A	"	"	"	"	B	"	"	"	"	"	"	"	"	
		"	89	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	90	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	91	"	A	B	B	B	B	A	"	"	B	"	"	"	"	"	
		"	92	"	A	A	A	A	A	"	"	"	"	"	"	"	"	"	
		"	93	"	B	"	A	A	A	"	"	"	"	"	"	"	"	"	
		"	94	"	A	"	A	A	A	"	"	"	"	"	"	"	"	"	
		"	95	"	A	"	B	B	B	"	"	B	"	"	"	"	"	"	
		"	96	"	B	"	B	B	"	"	"	"	"	"	"	"	"	"	
		"	97	"	A	"	B	B	"	"	"	"	"	"	"	"	H	"	
		"	98	"	A	"	A	A	"	"	"	"	"	"	"	"	"	"	
		"	99	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	100	"	A	"	"	"	"	"	"	"	"	"	"	H	H	"	
		"	101	"	A	"	"	"	"	"	"	A	"	"	"	"	"	"	
		"	102	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	103	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	104	"	A	"	B	B	A	"	"	B	"	"	"	"	"	"	
		"	105	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	106	"	A	"	"	"	"	"	"	"	"	H	L	L	"	"	
		"	107	"	A	"	"	"	"	"	"	A	"	"	"	"	"	"	
		"	108	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	109	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	110	B	A	"	A	A	"	"	"	B	A	L	"	"	L	"	
		"	111	A	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	112	A	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	113	A	A	"	"	"	"	"	"	"	"	H	H	H	H	X	
		"	114	B	A	"	"	"	"	"	"	A	"	L	L	L	L	L	

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 03 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
7	Func-	3014	115	A 8/	A 8/	A 8/	B 8/	B	B	B	GND	B	B	L	L	L	L	L	4
Tc = +25°C	tional	"	116	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
	tests	"	117	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
	7/	"	118	"	A	B	"	"	A	A	"	"	A	"	"	"	"	"	
		"	119	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	120	"	A	"	"	"	"	"	"	"	"	H	"	"	L	"	
		"	121	"	A	"	A	"	B	B	"	"	"	"	"	"	"	"	
		"	122	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	123	"	A	"	"	"	"	"	"	"	"	L	"	H	"	"	
		"	124	"	A	"	B	A	A	"	"	"	"	"	"	"	"	"	
		"	125	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	126	"	A	"	"	"	"	"	"	"	"	H	H	L	"	"	
		"	127	"	A	"	A	"	"	"	"	"	B	"	"	"	"	"	
		"	128	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	129	"	A	"	"	"	"	"	"	"	"	"	"	H	"	"	
		"	130	"	A	A	B	B	"	A	"	"	A	"	"	"	"	"	
		"	131	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	132	"	A	"	"	"	"	"	"	"	"	"	L	L	H	H	
		"	133	"	A	"	A	A	B	B	"	"	B	"	"	"	"	L	
		"	134	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	135	"	A	"	"	"	"	"	"	"	"	L	H	H	"	"	
		"	136	"	A	B	"	B	A	A	"	"	"	"	"	"	"	"	
		"	137	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	138	"	A	"	"	"	"	"	"	"	"	H	L	"	L	"	
		"	139	"	A	A	"	"	B	"	"	"	A	"	"	"	"	"	
		"	140	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	141	"	A	"	"	"	"	"	"	"	"	L	"	"	H	"	
		"	142	"	A	B	B	A	"	"	"	"	"	"	"	"	"	"	
		"	143	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	144	"	A	"	"	"	"	"	"	"	"	"	H	L	L	"	
		"	145	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	146	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	147	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	148	"	A	B	A	"	"	"	"	"	"	"	"	"	"	"	
		"	149	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	150	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
8	Repeat subgroup 7 at T_C = +125°C and T_C = -55°C.																		

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 04 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
7	Func-	3014	56	B 8/	A 8/	A 8/	A	A	A	A 8/	GND	A	A	L	L	L	L	L	4
Tc = +25°C	tional	"	57	A	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
	tests	"	58	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
	7/	"	59	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	60	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	61	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	62	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	63	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	64	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	65	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	66	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	67	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	68	"	A	A	A	A	A	"	"	"	A	"	H	L	L	"	
		"	69	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	70	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	71	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	72	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	73	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	74	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	75	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	76	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	77	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	78	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	79	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	80	"	A	A	A	A	A	"	"	"	A	H	L	L	L	"	
		"	81	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	82	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	83	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	84	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	85	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	86	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	87	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	88	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	89	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	90	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	91	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	92	"	A	A	A	A	A	"	"	"	A	"	H	L	L	"	
		"	93	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	94	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	95	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	96	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	97	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	98	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	99	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	100	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	101	"	A	A	A	A	A	"	"	"	A	"	"	"	H	H	
		"	102	"	A	B	B	B	B	"	"	"	B	"	"	"	"	L	
		"	103	"	B	A	A	A	A	"	"	"	A	"	"	"	"	H	
		"	104	"	A	A	A	A	A	"	"	"	A	L	L	L	L	L	
		"	105	B	A	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	106	A	A	A	A	A	A	B	"	"	A	"	"	"	"	"	
		"	107	"	B	"	"	"	"	B	"	"	B	"	"	"	"	"	
		"	108	"	A	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	109	"	B	"	B	B	B	"	"	"	"	"	"	"	"	"	
		"	110	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	111	"	B	"	"	"	"	"	"	B	"	"	"	"	"	"	
		"	112	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	113	"	A	"	A	A	"	"	"	"	"	"	"	"	"	"	
		"	114	"	B	"	A	A	"	"	"	"	"	"	"	"	"	"	

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 04 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
7	Func-	3014	115	A 8/	A 8/	A	A	A	B	A	GND	B	B	L	H	H	H	L	4
T_C = +25°C	tional	"	116	"	A	"	"	"	"	"	"	A	"	"	"	"	"	"	
	tests	"	117	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
	7/	"	118	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	119	"	B	"	B	B	A	"	"	B	"	"	"	"	"	"	
		"	120	"	A	"	B	B	"	"	"	"	"	H	L	L	"	"	
		"	121	B	A	"	A	A	"	"	"	"	A	L	"	"	L	"	
		"	122	A	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	123	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	124	"	A	"	"	"	"	"	"	"	"	H	H	H	H	H	
		"	125	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	126	B	A	"	"	"	"	"	"	A	"	L	L	L	L	L	
		"	127	A	A	B	"	"	"	"	"	B	"	"	"	"	"	"	
		"	128	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	129	"	A	"	"	"	"	"	"	"	"	H	H	H	"	"	
		"	130	"	A	"	"	B	B	"	"	"	"	"	"	"	"	"	
		"	131	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	132	"	A	"	"	"	"	"	"	"	"	L	L	"	"	"	
		"	133	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	134	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	135	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	136	"	A	B	B	A	"	"	"	"	"	"	"	"	"	"	
		"	137	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	138	"	A	"	"	"	"	"	"	"	"	"	H	L	L	"	
		"	139	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	140	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	141	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	142	"	A	B	A	"	"	"	"	"	"	"	"	"	"	"	
		"	143	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	144	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	145	"	A	"	B	B	A	"	"	"	"	"	"	"	"	"	
		"	146	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	147	"	A	"	"	"	"	"	"	"	"	H	L	L	"	"	
		"	148	"	A	A	A	"	"	"	"	"	"	"	"	"	"	"	
		"	149	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	150	"	A	"	"	"	"	"	"	"	"	"	"	H	H	"	
		"	151	"	A	B	B	A	"	"	"	"	"	"	"	"	"	"	
		"	152	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	153	"	A	"	"	"	"	"	"	"	"	"	H	L	L	"	
		"	154	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	155	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	156	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
8	Repeat subgroup 7 at T_C = +125 and T_C = -55°C.																		

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 11 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F Cases 1/ 2 Test no.	1 2 Clear	2 3 Clock	3 4 A	4 5 B	5 7 C	6 8 D	7 9 EnP	8 10 GND	9 12 Load	10 13 EnT	11 14 Q_D	12 15 Q_C	13 17 Q_B	14 18 Q_A	15 19 Ripple carry	V
7	Func-	3014	56	B 8/	B 8/	B 8/	B	B	B 8/	A 8/	GND	B	A	X	X	X	X	X	4
Tc = +25°C	tional	"	57	B	A	"	"	"	"	"	"	"	"	L	L	L	L	L	
	tests	"	58	A	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
	7/	"	59	A	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	60	B	A	A	A	A	A	"	"	A	"	"	"	"	"	"	
		"	61	B	B	A	A	A	A	"	"	"	"	"	"	"	"	"	
		"	62	B	A	A	A	A	A	"	"	"	"	"	"	"	"	"	
		"	63	A	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	64	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	65	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	66	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	67	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	68	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	69	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	70	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	71	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	72	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	73	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	74	"	A	A	A	A	A	"	"	"	A	"	H	L	L	"	
		"	75	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	76	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	77	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	78	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	79	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	80	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	81	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	82	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	83	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	84	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	85	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	86	"	A	A	A	A	A	"	"	"	A	H	L	L	L	"	
		"	87	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	88	"	B	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	89	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	90	"	A	A	A	A	A	"	"	"	A	"	"	"	H	H	
		"	91	"	A	B	B	B	B	"	"	"	B	"	"	"	"	L	
		"	92	"	B	A	A	A	A	"	"	"	A	"	"	"	"	H	
		"	93	"	A	"	"	"	"	"	"	"	A	L	"	"	L	L	
		"	94	"	A	"	"	"	"	B	"	"	"	"	"	"	"	"	
		"	95	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	96	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	97	"	B	"	"	"	"	A	"	"	B	"	"	"	"	"	
		"	98	"	A	"	B	B	B	"	"	"	"	"	"	"	"	"	
		"	99	"	B	"	"	"	"	"	"	"	B	"	"	"	"	"	
		"	100	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	101	"	A	"	A	A	"	"	"	"	"	"	"	"	"	"	
		"	102	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	103	"	A	"	"	"	"	"	"	"	"	"	H	H	"	"	
		"	104	"	A	"	"	"	"	"	"	A	"	"	"	"	"	"	
		"	105	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	106	A	A	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	107	"	B	"	B	B	A	"	"	B	"	"	"	"	"	"	
		"	108	"	A	"	"	"	"	"	"	B	"	H	L	L	"	"	
		"	109	"	A	"	"	"	"	"	"	A	"	"	"	"	"	"	
		"	110	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	111	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	112	B	B	"	A	A	"	"	"	"	A	"	"	"	"	H	
		"	113	B	A	"	"	"	"	"	"	"	"	L	"	"	L	L	
		"	114	A	A	"	"	"	"	"	"	B	"	L	"	"	L	L	

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 11 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
7 Tc = +25°C	Func-tional tests 7/	3014	115	A 8/	B 8/	A	B	B	A	A	GND	B	A	L	L	L	L	L	4
		"	116	"	A	"	"	"	"	"	"	"	"	H	"	"	H	H	
		"	117	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	118	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	119	B	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	120	B	A	"	"	"	"	"	"	"	"	L	"	"	L	L	
		"	121	A	A	B	"	"	B	"	"	"	B	"	"	"	"	"	
		"	122	"	B	"	A	"	"	"	"	"	"	"	"	"	"	"	
		"	123	"	A	"	A	"	"	"	"	"	"	"	"	H	"	"	
		"	124	"	A	"	B	"	A	"	"	"	"	"	"	"	"	"	
		"	125	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	126	"	A	"	"	"	"	"	"	"	"	H	"	L	"	"	
		"	127	"	A	"	"	"	B	"	"	"	A	"	"	"	"	"	
		"	128	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	129	"	A	"	"	"	"	"	"	"	"	L	"	"	"	"	
		"	130	"	A	"	A	A	A	"	"	"	"	"	"	"	"	"	
		"	131	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	132	"	A	"	"	"	"	"	"	"	"	H	H	H	"	"	
		"	133	"	A	A	"	B	B	"	"	"	"	"	"	"	"	"	
		"	134	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	135	"	A	"	"	"	"	"	"	"	"	L	L	"	H	"	
		"	136	"	A	B	B	A	"	"	"	"	"	"	"	"	"	"	
		"	137	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	138	"	A	"	"	"	"	"	"	"	"	"	H	L	L	"	
		"	139	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	140	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	141	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	142	"	A	B	A	"	"	"	"	"	"	"	"	"	"	"	
		"	143	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	144	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	145	"	A	"	B	B	A	"	"	"	"	"	"	"	"	"	
		"	146	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	147	"	A	"	"	"	"	"	"	"	"	H	L	L	"	"	
		"	148	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	149	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	150	"	A	"	"	"	"	"	"	"	"	"	"	"	H	H	
		"	151	"	A	"	A	A	"	"	"	A	"	"	"	"	"	"	
		"	152	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	153	"	A	"	"	"	"	"	"	"	"	L	"	"	L	L	
8	Repeat subgroup 7 at T_C = +125 and T_C = -55°C.																		

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 12 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
7	Func-	3014	56	B 8/	B 8/	B 8/	B	B	B	A 8/	GND	B	A	X	X	X	X	X	4
Tc = +25°C	tional	"	57	B	A	"	"	"	"	"	"	"	"	L	L	L	L	L	
	tests	"	58	A	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
	7/	"	59	A	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	60	B	A	A	A	A	A	"	"	A	"	"	"	"	"	"	
		"	61	B	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	62	B	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	63	A	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	64	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	65	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	66	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	67	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	68	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	69	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	70	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	71	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	72	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	73	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	74	"	A	A	A	A	A	"	"	"	A	"	H	L	L	"	
		"	75	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	76	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	77	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	78	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	79	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	80	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	81	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	82	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	83	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	84	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	85	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	86	"	A	A	A	A	A	"	"	"	A	H	L	L	L	"	
		"	87	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	88	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	89	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	90	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	91	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	92	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	93	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	94	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	95	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	96	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	97	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	98	"	A	A	A	A	A	"	"	"	A	"	H	L	L	"	
		"	99	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	100	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	101	"	A	A	A	A	A	"	"	"	A	"	"	"	H	"	
		"	102	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	103	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	104	"	A	A	A	A	A	"	"	"	A	"	"	H	L	"	
		"	105	"	A	B	B	B	B	"	"	"	B	"	"	"	"	"	
		"	106	"	B	A	A	A	A	"	"	"	A	"	"	"	"	"	
		"	107	"	A	A	A	A	A	"	"	"	A	"	"	"	H	H	
		"	108	"	A	B	B	B	B	"	"	"	B	"	"	"	"	L	
		"	109	"	B	A	A	A	A	"	"	"	A	"	"	"	"	H	
		"	110	"	A	"	"	"	"	"	"	"	A	L	L	L	L	L	
		"	111	"	B	"	"	"	"	B	"	"	B	"	"	"	"	"	
		"	112	"	A	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	113	"	B	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	114	"	A	"	B	B	B	A	"	"	"	"	"	"	"	"	

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device type 12 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	
7	Func-	3014	115	A 8/	B	A	B 8/	B 8/	B	A	GND	B	B	L	L	L	L	L	4
Tc = +25°C	tional	"	116	"	A	"	B	B	"	"	"	"	"	"	"	"	H	"	
	tests	"	117	"	A	"	A	A	"	"	"	"	"	"	"	"	"	"	
	7/	"	118	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	119	"	A	"	"	"	"	"	"	"	"	"	H	H	"	"	
		"	120	"	A	"	"	"	"	"	"	A	"	"	"	"	"	"	
		"	121	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	122	"	A	"	B	B	A	"	"	"	"	"	"	"	"	"	
		"	123	"	B	"	"	"	"	"	"	B	"	"	"	"	"	"	
		"	124	"	A	"	"	"	"	"	"	"	"	H	L	L	"	"	
		"	125	"	A	"	A	A	"	"	"	"	A	"	"	"	"	"	
		"	126	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	127	"	A	"	"	"	"	"	"	"	"	"	H	H	"	H	
		"	128	"	A	B	"	"	"	"	"	"	"	"	"	"	"	"	
		"	129	"	B	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	130	"	B	A	B	B	B	"	"	"	"	"	"	"	"	"	
		"	131	"	A	A	"	"	"	"	"	"	"	L	L	L	"	L	
		"	132	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	
		"	133	"	"	A	"	A	A	"	"	"	"	"	"	"	"	"	
		"	134	"	"	B	"	"	A	"	"	"	"	"	"	"	"	"	
		"	135	"	"	A	"	"	B	"	"	"	"	"	"	"	"	"	
		"	136	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"	
		"	137	"	"	B	A	B	"	"	"	"	"	"	"	"	"	"	
		"	138	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	139	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	140	"	A	"	"	"	"	"	"	"	"	"	"	H	"	"	
		"	141	"	A	B	B	A	"	"	"	"	"	"	"	"	"	"	
		"	142	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	143	"	A	"	"	"	"	"	"	"	"	"	H	L	L	"	
		"	144	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	145	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	146	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	147	"	A	B	A	"	"	"	"	"	"	"	"	"	"	"	
		"	148	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	149	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	150	"	A	"	B	B	A	"	"	"	"	"	"	"	"	"	
		"	151	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	152	"	A	"	"	"	"	"	"	"	"	H	L	L	"	"	
		"	153	"	A	"	A	"	"	"	"	"	"	"	"	"	"	"	
		"	154	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	155	"	A	"	"	"	"	"	"	"	"	"	"	H	"	"	
		"	156	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	157	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	158	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	159	"	A	B	B	A	"	"	"	"	"	"	"	"	"	"	
		"	160	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	161	"	A	"	"	"	"	"	"	"	"	"	H	L	L	"	
		"	162	"	A	A	"	"	"	"	"	"	"	"	"	"	"	"	
		"	163	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	164	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	165	"	A	"	"	"	"	"	"	A	"	"	"	"	"	"	
		"	166	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	167	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
8	Repeat subgroup 7 at T_C = +125 and T_C = -55°C.																		

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device types 03, 04, 11, and 12.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F				1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Case 1/				2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no. (Device types)				Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V_{CC}
9 Tc = +125°C	F_{MAX} 10/	3003 (Fig 6)	151	157	154	168	4.5 V	IN					4.5 V	GND	4.5 V	4.5 V				OUT		5.0 V
	t_{PLH4}	"	152	158	155	169	"	"					"	"	"	"					OUT	"
	t_{PHL4}	"	153	159	156	170	"	"					"	"	"	"					OUT	"
	t_{PLH5}	"	154	160	157	171	"	"					"	"	"	"				OUT		"
		"	155	161	158	172	"	"					"	"	"	"			OUT			"
		"	156	162	159	173	"	"					"	"	"	"		OUT				"
		"	157	163	160	174	"	"					"	"	"	"	OUT					"
	t_{PHL5}	"	158	164	161	175	"	"					"	"	"	"				OUT		"
		"	159	165	162	176	"	"					"	"	"	"			OUT			"
		"	160	166	163	177	"	"					"	"	"	"		OUT				"
		"	161	167	164	178	"	"					"	"	"	"	OUT					"
	t_{PLH6}	"	162	168	165	179	"	"	IN					"	GND					OUT		"
	t_{PHL6}	"	163	169	166	180	"	"	IN					"	"					OUT		"
	t_{PLH6}	"	164	170	167	181	"	"		IN				"	"				OUT			"
	t_{PHL6}	"	165	171	168	182	"	"		IN				"	"				OUT			"
	t_{PLH6}	"	166	172	169	183	"	"			IN			"	"			OUT				"
	t_{PHL6}	"	167	173	170	184	"	"			IN			"	"			OUT				"
	t_{PLH6}	"	168	174	171	185	"	"				IN		"	"		OUT					"
	t_{PHL6}	"	169	175	172	186	"	"				IN		"	"		OUT					"
	t_{PLH7}	"	170	176	173	187	"	"					4.5 V	"	4.5 V	IN					OUT	"
	t_{PHL7}	"	171	177	174	188	"	"					4.5 V	"	4.5 V	IN					OUT	
	t_{PHL8}	"	172	178	175	189	IN	12/	4.5 V					"	GND					OUT		
	t_{PHL8}	"	173	179	176	190	"	"		4.5 V				"	"				OUT			
	t_{PHL8}	"	174	180	177	191	"	"			4.5 V			"	"			OUT				
	t_{PHL8}	"	175	181	178	192	"	"				4.5 V		"	"		OUT					

See footnotes at end of device types 03, 04, 11, and 12.

TABLE III. Group A inspection for device types 03, 04, 11, and 12.

Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F				1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Case 1/				2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no. (Device types)				Clear	Clock	A	B	C	D	EnP	GND	Load	EnT	Q_D	Q_C	Q_B	Q_A	Ripple carry	V_{CC}
			03	04	11	12																
10 Tc = +125°C	F_{MAX} 10/	3003 (Fig 6)	176	182	179	193	Same terminal conditions as for subgroup 9.															
	t_{PLH4}	"	177	183	180	194																
	t_{PHL4}	"	178	184	181	195																
	t_{PLH5}	"	179	185	182	196																
		"	180	186	183	197																
		"	181	187	184	198																
		"	182	188	185	199																
	t_{PHL5}	"	183	189	186	200																
		"	184	190	187	201																
		"	185	191	188	202																
		"	186	192	189	203																
	t_{PLH6}	"	187	193	190	204																
	t_{PHL6}	"	188	194	191	205																
	t_{PLH6}	"	189	195	192	206																
	t_{PLH6}	"	190	196	193	207																
	t_{PLH6}	"	191	197	194	208																
	t_{PHL6}	"	192	198	195	209																
	t_{PLH6}	"	193	199	196	210																
	t_{PHL6}	"	194	200	197	211																
	t_{PLH7}	"	195	201	198	212																
	t_{PHL7}	"	196	202	199	213																
	t_{PHL8}	"	197	203	200	214																
	t_{PHL8}	"	198	204	201	215																
	t_{PHL8}	"	199	205	202	216																
	t_{PHL8}	"	200	206	203	217																
11	Same tests, terminal conditions, and limits as for subgroup 10, except T_C = -55°C.																					

See footnotes at end of device types 03, 04, 11, and 12.

1/ For case 2, pins not referenced are NC.

2/ Apply one pulse prior to measurement as follows:

3/ Apply 0.7 V for types 03 and 11; apply 2.0 V for types 04 and 12.

4/ I_{IL} limits (µA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
	Clear 03	-160/-400	-30/-300	-120/-360	-160/-400	-120/-360	-0/-100	-16/-400
	Clear 04	"	"	"	"	"	"	"
	Clear 11	"	"		"	"	-150/-450	"
	Clear 12	"	"	-290/-630	"			"
	EnP	"	"	-120/-360	"	-120/-360	-150/-380	"
	A, B, C, D	"	"	-160/-400	"	-150/-380	-0/-100	"
I_{IL5}	Load	-320/-800	-30/-300	-290/-630	-320/-800	-120/-360	-160/-400	-320/-800
	EnT			-340/-860		-240/-720	-300/-760	
I_{IL6}	Clock	-160/-400	-0/-100	-290/-630	-160/-400	-180/-420	-0/-100	-160/-400

5/ For types 03 and 11, set outputs to 9th count (Q_A = 1, Q_D = 1, Q_B and Q_C = 0) prior to measurement.

For types 04 and 12, set outputs to 15th count (Q_A, Q_B, Q_C and Q_D = 1) prior to measurement.

6/ Apply GND for types 03 and 11; apply 4.5 V for types 04 and 12.

7/ Only a summary of attributes data is required.

8/ A = 3.0 V minimum; B = 0.0 V or GND.

9/ H > 1.5 V; L < 1.5 V; X = don't care.

10/ The F_{MAX} minimum limit specified is the frequency of the input pulse. The output frequency shall be one-half of the input frequency. For type 04, circuit C, 20 MHz minimum.

11/ The limit for circuit B shall be 23 ns.

12/ For types 03 and 04, apply one clock pulse prior to test. For types 11 and 12 apply one clock pulse prior to test and another pulse during test.

13/ I_{IH13} limit for types 11 and 12; 40 µA maximum.

I_{IH14} limit for types 11 and 12; 200 µA maximum.

TABLE III. Group A inspection for device types 05 and 06.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Case 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	$\overline{U/D}$	CK	A	B	C	D	EP	GND	L	ET	$Q_{D'}$	$Q_{C'}$	$Q_{B'}$	$Q_{A'}$	Ripple carry	V_{CC}
1 Tc = +25°C	V_{OL}	3007	1	4.5 V	2/	0.7 V	0.7 V	0.7 V	0.7 V	4.5 V	GND	0.7 V	4.5 V	4 mA					4.5 V
	"		2		"	"	"	"	"	"	"	"	"		4 mA				"
	"		3		"	"	"	"	"	"	"	"	"			4 mA			"
	"		4		"	"	"	"	"	"	"	"	"				4 mA		"
	"		5	0.7 V	"	"	"	"	"	0.7 V	"	"	0.7 V					4 mA	"
	V_{OH}	3006	6	4.05 V	"	2.0 V	2.0 V	2.0 V	2.0 V	"	"	"	"	-.4 mA					"
	"		7		"	"	"	"	"	"	"	"	"		-.4 mA				"
	"		8		"	"	"	"	"	"	"	"	"			-.4 mA			"
	"		9		"	"	"	"	"	"	"	"	"				-.4 mA		"
	"		10	0.7 V	"	"	"	"	"	"	"	"	"					-.4 mA	"
	V_{IC}		11	-18 mA							"								"
			12		-18 mA						"								"
			13			-18 mA					"								"
			14				-18 mA				"								"
			15					-18 mA			"								"
			16						-18 mA		"								"
			17							-18 mA	"								"
			18								"	-18 mA							"
			19								"		-18 mA						"
	I_{IL12}	3009	20			0.4 V					"	GND							5.5 V
	"		21				0.4 V				"	"							"
	"		22					0.4 V			"	"							"
	"		23						0.4 V		"	"							"
	I_{IL13}	"	24	0.4 V							"								"
	"		25		0.4 V						"								"
	"		26								"	0.4 V							"
	I_{IL14}	"	27							0.4 V	"								"
	I_{IL15}	"	28								"		0.4 V						"
	I_{IL17}	3010	29	2.7 V							"								"
	"		30		2.7 V						"								"
	"		31			2.7 V					"								"
	"		32				2.7 V				"								"
	"		33					2.7 V			"								"
	"		34						2.7 V		"								"
	"		35							2.7 V	"								"
	"		36								"	2.7 V							"
	I_{IH19}	"	37								"		2.7 V						"

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device types 05 and 06.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	$\overline{U/D}$	CK	A	B	C	D	EP	GND	L	ET	Q_D	Q_C	Q_B	Q_A	Ripple carry	V_{CC}
1	I_{IH18}	3010	38	5.5 V							GND								5.5 V
Tc = +25°C		"	39		5.5 V						"								"
		"	40			5.5 V					"								"
		"	41				5.5 V				"								"
		"	42					5.5 V			"								"
		"	43						5.5 V		"								"
		"	44							5.5 V	"								"
		"	45								"	5.5 V							"
	I_{IL20}	"	46								"		5.5 V						"
	I_{0S}	3011	47	5.5 V	2/	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	"	GND	5.5 V	GND					"
		"	48	"	"	"	"	"	"	"	"	"	"		GND					"
		"	49	"	"	"	"	"	"	"	"	"	"			GND				"
		"	50	"	"	"	"	"	"	"	"	"	"				GND			"
		"	51	"	"	"	"	"	"	"	"	"	"					GND		"
	I_{CC}	3005	52	GND	"	GND	GND	GND	GND	GND	"	5.5 V	GND							"
2	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = +125°C and V_{IC} tests are omitted.																			
3	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = -55°C and V_{IC} tests are omitted.																			

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 05 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	U/ $\overline{D}$	CK	A	B	C	D	EP	GND	L	ET	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
7	Func-	3014	53	A 5/	B 5/	B	B	B	B	B	GND	B	B	X	X	X	X	X	4
T_C = +25°C	tional	"	54	"	A	"	"	"	"	"	"	B	"	L 5/	L	L	L	H 5/	
	tests	"	55	"	B	"	"	"	"	"	"	A	"	"	"	"	L	"	
	4/	"	56	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	57	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	58	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	59	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	60	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	61	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	62	"	A	"	"	"	"	"	"	"	"	"	H	L	L	"	
		"	63	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	64	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	65	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	66	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	67	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	68	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	69	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	70	"	A	"	"	"	"	"	"	"	"	H	L	L	L	"	
		"	71	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	72	"	A	"	"	"	"	"	"	"	"	"	"	"	H	L	
		"	73	"	B	"	"	"	"	A	"	"	"	"	"	"	"	L	
		"	74	"	A	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	75	"	B	"	"	"	"	B	"	"	"	"	"	"	"	"	
		"	76	"	A	"	"	"	"	"	"	"	A	"	"	"	"	H	
		"	77	"	A	"	"	"	"	"	"	"	A	"	"	"	"	H	
		"	78	"	B	"	"	"	"	"	"	"	B	"	"	"	"	L	
		"	79	"	A	"	"	"	"	"	"	"	"	L	"	"	L	H	
		"	80	"	B	A	"	"	A	"	"	B	"	L	"	"	L	"	
		"	81	"	A	"	"	"	"	"	"	B	"	H	"	"	H	L	
		"	82	B	B	"	"	"	"	"	"	A	"	"	"	"	H	H	
		"	83	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	84	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	85	"	A	"	"	"	"	"	"	"	"	L	H	H	H	"	
		"	86	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	87	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	88	"	B	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	89	"	A	"	"	"	"	"	"	"	"	"	"	L	H	"	
		"	90	"	B	"	"	"	"	"	"	"	"	"	"	"	"	"	
		"	91	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	92	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	93	"	A	"	"	"	"	"	"	"	"	"	L	H	H	"	
		"	94	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	95	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	96	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	97	"	A	"	"	"	"	"	"	"	"	"	"	L	H	"	
		"	98	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	99	"	A	"	"	"	"	"	"	"	"	"	"	"	L	L	
		"	100	"	B	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	101	"	A	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	102	"	B	"	"	"	"	B	"	"	"	"	"	"	"	"	
		"	103	"	B	"	"	"	"	"	"	"	A	"	"	"	"	H	
		"	104	"	A	"	"	"	"	"	"	"	A	"	"	"	"	H	
		"	105	"	B	"	"	"	"	"	"	"	B	"	"	"	"	L	
		"	106	"	B	B	A	A	"	"	"	B	"	"	"	"	"	L	
		"	107	"	A	B	A	A	"	"	"	B	"	"	"	H	H	H	
8	Repeat subgroup 7 at T_C = +125 and T_C = -55°C.																		

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 06 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	U/ $\overline{D}$	CK	A	B	C	D	EP	GND	L	ET	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
7	Func-	3014	53	A 5/	B 5/	B	B	B	B	B	GND	B	B	X	X	X	X	X	4
Tc = +25°C	tional	"	54	"	A	"	"	"	"	"	"	B	"	L 5/	L	L	L	H 5/	
	tests	"	55	"	B	"	"	"	"	"	"	A	"	"	"	"	L	"	
	4/	"	56	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	57	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	58	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	59	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	60	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	61	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	62	"	A	"	"	"	"	"	"	"	"	"	H	L	L	"	
		"	63	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	64	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	65	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	66	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	67	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	68	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	69	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	70	"	A	"	"	"	"	"	"	"	"	H	L	L	L	"	
		"	71	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	72	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	73	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	74	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	75	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	76	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	77	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	78	"	A	"	"	"	"	"	"	"	"	"	H	L	L	"	
		"	79	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	80	"	A	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	81	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	82	"	A	"	"	"	"	"	"	"	"	"	"	H	L	"	
		"	83	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	84	"	A	"	"	"	"	"	"	"	"	"	"	"	H	L	
		"	85	"	B	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	86	"	A	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	87	"	B	"	"	"	"	B	"	"	"	"	"	"	"	"	
		"	88	"	B	"	"	"	"	"	"	"	A	"	"	"	"	H	
		"	89	"	A	"	"	"	"	"	"	"	A	"	"	"	"	H	
		"	90	"	B	"	"	"	"	"	"	"	B	"	"	"	"	L	
		"	91	"	A	"	"	"	"	"	"	"	"	L	L	L	L	H	
		"	92	"	B	A	A	A	A	"	"	B	"	L	L	L	L	H	
		"	93	"	A	"	"	"	"	"	"	B	"	H	H	H	H	L	
		"	94	B	B	"	"	"	"	"	"	A	"	"	"	"	H	H	
		"	95	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	96	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	97	"	A	"	"	"	"	"	"	"	"	"	"	L	H	"	
		"	98	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	99	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	100	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	101	"	A	"	"	"	"	"	"	"	"	"	L	H	H	"	
		"	102	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	103	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	104	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	105	"	A	"	"	"	"	"	"	"	"	"	"	L	H	"	
		"	106	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	107	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	108	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 06 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	$\overline{U}$/ D	CK	A	B	C	D	EP	GND	L	ET	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
7 Tc = +25°C	Func-tional tests 4/	3014	109	B 5/	A 5/	A	A	A	A	B	GND	A	B	L	H	H	H	H	4.
		"	110	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	111	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	112	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	113	"	A	"	"	"	"	"	"	"	"	"	"	L	H	"	
		"	114	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	115	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	116	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	117	"	A	"	"	"	"	"	"	"	"	"	L	H	H	"	
		"	118	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	119	"	A	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	120	"	B	"	"	"	"	"	"	"	"	"	"	"	L	"	
		"	121	"	A	"	"	"	"	"	"	"	"	"	"	L	H	"	
		"	122	"	B	"	"	"	"	"	"	"	"	"	"	"	H	"	
		"	123	"	A	"	"	"	"	"	"	"	"	"	"	"	L	L	
		"	124	"	B	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	125	"	A	"	"	"	"	A	"	"	"	"	"	"	"	"	
		"	126	"	B	"	"	"	"	B	"	"	A	"	"	"	"	H	
		"	127	"	A	"	"	"	"	"	"	"	A	"	"	"	"	H	
		"	128	"	B	"	"	"	"	"	"	"	B	"	"	"	"	L	
8	Repeat subgroup 7 at T_C = +125 and T_C = -55°C.																		

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 05– Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	$\overline{U}$/ D	CK	A	B	C	D	EP	GND	L	ET	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
9	t_{PLH5}	See	108	5.0 V	IN 7/	GND	GND	GND	GND	GND	GND	IN 7/	GND				OUT		5
Tc = +25°C		fig. 7	109	"	IN	"	"	"	"	"	"	5.0 V				OUT			
		"	110	"	IN 2/	"	"	"	"	"	"	"			OUT				
		"	111	"	IN 8/	"	"	"	"	"	"	"		OUT					
	t_{PHL5}	"	112	"	IN 7/	5.0 V	"	"	"	"	"	IN					OUT		
		"	113	"	"	"	5.0 V	"	"	"	"	"				OUT			
		"	114	"	"	"	"	5.0 V	"	"	"	"			OUT				
		"	115	"	"	"	"	"	5.0 V	"	"	"		OUT					
	t_{PHL15}	"	116	"	"	"	"	"	"	"	"	"						OUT	
	t_{PLH12}	"	117	"	IN	"	"	"	"	"	"	5.0 V						OUT	
	t_{PLH5}	"	118	GND	IN 9/	IN	GND	GND	GND	"	"	GND					OUT		
	t_{PHL5}	"	119	"	IN	GND	GND	"	"	"	"						OUT		
	t_{PLH5}	"	120	"	"	"	5.0 V	"	"	"	"					OUT			
	t_{PHL5}	"	121	"	"	"	GND	"	"	"	"					OUT			
	t_{PLH5}	"	122	"	"	"	"	5.0 V	"	"	"				OUT				
	t_{PHL5}	"	123	"	"	"	"	GND	"	"	"				OUT				
	t_{PLH5}	"	124	"	"	"	"	"	5.0 V	"	"			OUT					
	t_{PHL5}	"	125	"	"	"	"	"	GND	"	"			OUT					
	t_{PHL7}	"	126	5.0 V	IN 7/	5.0 V	"	"	5.0 V	"	"	IN	IN					OUT	
	t_{PLH7}	"	127	5.0 V	GND	"	"	"	"	"	"	5.0 V	IN					OUT	
	t_{PHL11}	"	128	IN	IN 7/	"	"	"	"	"	"	IN	GND					OUT	
	t_{PLH9}	"	129	IN	GND	"	"	"	"	"	"	5.0 V	GND						
	t_{PHL7}	"	130	GND	IN 7/	GND	"	"	GND	"	"	IN	IN						
	t_{PLH7}	"	131	GND	GND	"	"	"	"	"	"	5.0 V	IN						
	t_{PHL11}	"	132	IN	IN 7/	"	"	"	"	"	"	IN	GND						
	t_{PLH9}	"	133	IN	GND	"	"	"	"	"	"	5.0 V							
	F_{MAX} 10/	"	134	5.0 V	IN					"	"	5.0 V		OUT	OUT	OUT	OUT		
	F_{MAX} 10/	"	135	GND	IN					"	"	5.0 V		OUT	OUT	OUT	OUT		

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 05– Continued.

Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	$\overline{U}/D$	CK	A	B	C	D	EP	GND	L	ET	Q_D	Q_C	Q_B	Q_A	Ripple carry	V
10 Tc = +125°C	t_{PLH5}	See	136																
		fig. 7	137																
		"	138																
		"	139																
	t_{PHL5}	"	140																
		"	141																
		"	142																
		"	143																
	t_{PHL15}	"	144																
	t_{PLH12}	"	145																
	t_{PLH5}	"	146																
	t_{PHL5}	"	147																
	t_{PLH5}	"	148																
	t_{PHL5}	"	149																
	t_{PLH5}	"	150																
	t_{PHL5}	"	151																
	t_{PLH5}	"	152																
	t_{PHL5}	"	153																
	t_{PHL7}	"	154																
	t_{PLH7}	"	155																
	t_{PHL11}	"	156																
	t_{PLH9}	"	157																
	t_{PHL7}	"	158																
	t_{PLH7}	"	159																
	t_{PHL11}	"	160																
	t_{PLH9}	"	161																
	F_{MAX}	"	162																
	F_{MAX}	"	163																
11	Same tests, conditions and limits as for subgroup 10 except T_C = -55°C and V_{CC} = 4.5 for F_{MAX}.																		

Same conditions as for subgroup 9.

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 06.

Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F Cases 1/ 2 Test no.	1 2 $\overline{U}$/ D	2 3 CK	3 4 A	4 5 B	5 7 C	6 8 D	7 9 EP	8 10 GND	9 12 L	10 13 ET	11 14 Q_D	12 15 Q_C	13 17 Q_B	14 18 Q_A	15 19 Ripple carry	
9	t_{PLH5}	See	129	5.0 V	IN 7/	GND	GND	GND	GND	GND	GND	IN	GND				OUT		5
Tc = +25°C		fig. 7	130	"	"	5.0 V	"	"	"	"	"	"	"			OUT			
		"	131	"	"	"	5.0 V	"	"	"	"	"	"		OUT				
		"	132	"	"	"	"	5.0 V	"	"	"	"	"	OUT					
	t_{PHL5}	"	133	"	" 7/	5.0 V	GND	GND	GND	"	GND	IN	GND				OUT		
		"	134	"	"	"	5.0 V	"	"	"	"	"	"			OUT			
		"	135	"	"	"	"	5.0 V	"	"	"	"	"		OUT				
		"	136	"	"	"	"	"	5.0 V	"	"	"	"	OUT					
	t_{PHL15}	"	137	"	"	GND	"	"	"	"	"	"	"					OUT	
	t_{PLH12}	"	138	"	"	GND	"	"	"	"	"	5.0 V	"					OUT	
	t_{PLH5}	"	139	GND	"	5.0 V	GND	GND	GND	"	"	5.0 V	"				OUT		
	t_{PHL5}	"	140	"	"	GND	GND	"	"	"	"	"	"				OUT		
	t_{PLH5}	"	141	"	"	"	5.0 V	"	"	"	"	"	"			OUT			
	t_{PHL5}	"	142	"	"	"	GND	"	"	"	"	"	"			OUT			
	t_{PLH5}	"	143	"	"	"	"	5.0 V	"	"	"	"	"		OUT				
	t_{PHL5}	"	144	"	"	"	"	GND	"	"	"	"	"		OUT				
	t_{PLH5}	"	145	"	"	"	"	"	5.0 V	"	"	"	"	OUT					
	t_{PHL5}	"	146	"	"	"	"	"	GND	"	"	"	"	OUT					
	t_{PHL7}	"	147	5.0 V	" 7/	5.0 V	5.0 V	5.0 V	5.0 V	"	"	5.0 V	IN					OUT	
	t_{PLH7}	"	148	5.0 V	"	"	"	"	"	"	"	5.0 V	IN					OUT	
	t_{PHL11}	"	149	IN	IN 7/	"	"	"	"	"	"	5.0 V	GND					OUT	
	t_{PLH9}	"	150	IN	IN	"	"	"	"	"	"	5.0 V	GND					"	
	t_{PHL7}	"	151	GND	IN 7/	GND	GND	GND	GND	"	"	5.0 V	IN					"	
	t_{PLH7}	"	152	GND	IN	"	"	"	"	"	"	5.0 V	IN					"	
	t_{PHL11}	"	153	IN	IN 7/	"	"	"	"	"	"	5.0 V	GND					"	
	t_{PLH9}	"	154	IN	IN	"	"	"	"	"	"	5.0 V	"					"	
	F_{MAX}	"	155	5.0 V	IN	"	"	"	"	"	"	5.0 V	"	OUT	OUT	OUT	OUT		
	F_{MAX}	"	156	GND	IN	5.0 V	5.0 V	5.0 V	5.0 V	"	"	5.0 V	"	OUT	OUT	OUT	OUT		

See footnotes at end of device types 05 and 06.

TABLE III. Group A inspection for device type 06.

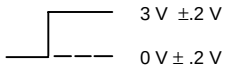
Terminal conditions (pins not designated may be H ≥ 2.0 V or L ≤ 0.7 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	
			Test no.	$\overline{U}$/ D	CK	A	B	C	D	EP	GND	L	ET	Q_D	Q_C	Q_B	Q_A	Ripple carry	
10 Tc = +125°C	t_{PLH5}	See	157	Same conditions as for subgroup 9.															
		fig. 7	158																
		"	159																
		"	160																
	t_{PHL5}	"	161																
		"	162																
		"	163																
		"	164																
	t_{PHL15}	"	165																
	t_{PLH12}	"	166																
	t_{PLH5}	"	167																
	t_{PHL5}	"	168																
	t_{PLH5}	"	169																
	t_{PHL5}	"	170																
	t_{PLH5}	"	171																
	t_{PHL5}	"	172																
	t_{PLH5}	"	173																
	t_{PHL5}	"	174																
	t_{PHL7}	"	175																
	t_{PLH7}	"	176																
	t_{PHL11}	"	177																
	t_{PLH9}	"	178																
	t_{PHL7}	"	179																
	t_{PLH7}	"	180																
	t_{PHL11}	"	181																
	t_{PLH9}	"	182																
	F_{MAX}	"	183																
	F_{MAX}	"	184																
11	Same tests, conditions and limits as for subgroup 10 except T_C = -55°C and V_{CC} = 4.5 for F_{MAX}.																		

See footnotes at end of device types 05 and 06.

1/ Case 2, pins not referenced are N/C.

2/ Apply one clock pulse prior to test as follows:



3/ I_{IL} limits (µA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I_{IL12}	A, B, C, D			-160/-400		-0.5/-400		
I_{IL13}	U/$\overline{D}$, CK, L			-160/-400		-135/-370		
I_{IL14}	EP			160/-400		-150/-385		
I_{IL15}	ET			-140/-720		-280/-760		

4/ Only a summary of attributes data is required.

5/ A = 3.0 V minimum; B = 0.0 V or GND.

6/ H > 1.5 V; L < 1.5 V; X = don't care.

7/ Apply one clock pulse with "L" low prior to test.

8/ Apply three clock pulses prior to test.

9/ Apply one clock pulse with "A" low prior to test.

10/ On (Q_A, Q_B, Q_C, and Q_D) shall respond as specified in the truth table with the minimum F_{MAX} frequency input to "CK".

TABLE III. Group A inspection for device types 07 and 08.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Count down	Count Up	Q_C	Q_D	GND	D	C	Load	Ripple Carry	Borrow	Clear	A	V_{CC}
1 Tc = +25°C	V_{OL}	3007	1			4 mA					GND			0.7 V			0.7 V	0.7 V	4.5 V
		"	2	0.7 V	4 mA						"			"			"		"
		"	3						4 mA		"		0.7 V	"			"		"
		"	4							4 mA	"	0.7 V	"	"			"		"
		"	5	2/				0.7 V			"	2.0 V	2/	"	4 mA		"	2.0 V	4.5 V
		"	6				0.7 V				"					4 mA	2.0 V		4.5 V
	V_{OH}	3006	7			-0.4 mA					"			0.7 V			0.7 V	2.0 V	"
		"	8	2.0 V	-0.4 mA						"			"			"		"
		"	9						-0.4 mA		"		2.0 V	"			"		"
		"	10							-0.4 mA	"	2.0 V		"			"		"
		"	11					2.0 V			"				-0.4 mA		"		"
		"	12				2.0 V				"					-0.4 mA			"
	V_{IC}		13								"							-18 mA	"
			14	-18 mA							"								"
			15								"		-18 mA						"
			16								"	-18 mA							"
			17								"			-18 mA					"
			18								"						-18 mA		"
			19					-18 mA			"								"
			20				-18 mA				"								"
	I_{IL9}	3009	21								"			GND			GND	0.4 V	5.5 V
		"	22	0.4 V							"			"			"		"
		"	23								"		0.4 V	"			"		"
		"	24								"	0.4 V		"			"		"
	I_{IL10}	"	25								"			0.4 V					"
	I_{IL11}	"	26								"						0.4 V		"
		"	27					0.4 V			"								"
		"	28				0.4 V				"								"
	I_{IH17}	3010	29								"			5.5 V			5.5 V	2.7 V	"
		"	30	2.7 V							"			"			"		"
		"	31								"		2.7 V	"			"		"
		"	32								"	2.7 V		"			"		"
		"	33								"			2.7 V					"
		"	34								"						2.7 V		"
		"	35					2.7 V			"								"
		"	36				2.7 V				"								"
	I_{IH18}	"	37								"			5.5 V			5.5 V	5.5 V	"
		"	38	5.5 V							"			"			"		"
		"	39								"		5.5 V	"			"		"
		"	40								"	5.5 V		"			"		"
		"	41								"			"					"
		"	42								"						5.5 V		"
		"	43					5.5 V			"								"
		"	44				5.5 V				"								"

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 07 and 08 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Count down	Count Up	Q_C	Q_D	GND	D	C	Load	Ripple Carry	Borrow	Clear	A	V_{CC}
1 Tc = +25°C	I_{OS}	3011	45			GND					GND			GND			GND	5.5 V	5.5 V
		"	46	5.5 V	GND						"			"			"		"
		"	47						GND		"		5.5 V	"			"		"
		"	48							GND	"	5.5 V		"			"		"
		"	49					5.5 V			"				GND		"		"
		"	50				5.5 V				"					GND			"
	I_{CC}	3005	51								"			GND			GND		"
2	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = +125°C and V_{IC} tests are omitted.																		
3	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = -55°C and V_{IC} tests are omitted.																		

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 07 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Count down	Count Up	Q_C	Q_D	GND	D	C	Load	Ripple Carry	Borrow	Clear	A	V_{CC}
7	Func-	3014	52	A 6/	L	L	A	A	L	L	GND	A	A	A	H	H	A	A	4.5 V
Tc = +25°C	tional	"	53	"	"	L	"	A	"	"	"	"	"	"	"	"	B 6/	"	"
	tests	"	54	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
	5/	"	55	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	56	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	57	"	H	L	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	58	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	59	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	60	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	61	"	L	L	"	A	H	"	"	"	"	"	"	"	"	"	"
		"	62	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	63	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	64	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	65	"	H	L	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	66	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	67	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	68	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	69	"	L	L	"	A	L	H	"	"	"	"	"	"	"	"	"
		"	70	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	71	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	72	"	"	H	"	B	"	"	"	"	"	"	L	"	"	"	"
		"	73	"	"	L	"	A	"	L	"	"	"	"	H	"	"	"	"
		"	74	"	"	L	B	"	"	L	"	"	"	"	"	L	"	"	"
		"	75	"	"	H	A	"	"	H	"	"	"	"	"	H	"	"	"
		"	76	"	"	H	B	"	"	"	"	"	"	"	"	H	"	"	"
		"	77	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	78	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	79	"	H	H	A	"	H	L	"	"	"	"	"	"	"	"	"
		"	80	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	81	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	82	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	83	"	L	H	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	84	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	85	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	86	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	87	"	H	H	A	"	L	"	"	"	"	"	"	"	"	"	"
		"	88	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	89	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	90	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	91	"	L	H	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	92	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	93	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	94	"	"	L	B	"	"	"	"	"	"	"	"	L	"	"	"
		"	95	"	"	H	A	"	"	H	"	"	"	"	"	H	"	"	"
		"	96	"	H	H	"	"	H	H	"	"	"	B	"	"	"	"	"
		"	97	"	L	L	"	"	L	L	"	"	"	"	"	"	A	"	"
		"	98	"	H	H	"	"	H	H	"	"	"	"	"	"	B	"	"
		"	99	"	H	H	"	"	H	H	"	"	"	A	"	"	B	"	"
		"	100	"	L	L	"	"	L	L	"	"	"	"	"	"	A	"	"
		"	101	"	L	L	"	"	L	L	"	"	"	"	"	"	B	"	"

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 07 – Continued.
Terminal conditions (pins not designated may be high ≥ 2.0 V; or low ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Count down	Count Up	Q_C	Q_D	GND	D	C	Load	Ripple Carry	Borrow	Clear	A	V_{CC}
7	Func-	3014	102	A 6/	H	H	A	A	H	H	GND	A	A	B 6/	H	H	B	A	4.5 V
T_c = +25°C	tional	"	103	A	"	"	"	"	"	"	"	A	A	A	"	"	"	A	"
	tests	"	104	B	"	"	"	"	"	"	"	B	B	A	"	"	"	B	"
	5/	"	105	"	L	L	"	"	L	L	"	"	"	B	"	"	"	"	"
		"	106	"	"	"	B	"	"	"	"	"	"	"	"	L	"	"	"
		"	107	"	"	"	A	"	"	"	"	"	"	"	"	H	"	"	"
		"	108	"	"	"	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	109	"	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	110	"	"	"	"	"	"	"	"	"	"	A	"	"	"	"	"
		"	111	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"	"
		"	112	"	"	"	B	"	"	"	"	"	"	"	"	L	"	"	"
		"	113	"	"	"	A	"	"	"	"	"	"	"	"	H	"	"	"
		"	114	"	"	"	A	B	"	"	"	"	"	"	"	"	"	"	"
		"	115	"	"	"	A	A	"	"	"	"	"	"	"	"	"	"	"
8	Repeat subgroup 7 at T_C = +125 and T_C = -55°C.																		

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 08 – Continued.
Terminal conditions (pins not designated may be high ≥ 2.0 V; or low ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Count down	Count Up	Q_C	Q_D	GND	D	C	Load	Ripple Carry	Borrow	Clear	A	V_{CC}
7	Func-	3014	52	B 6/	L	L	A 6/	A	L	L	GND	B	B	B	H	H	B	B	4.5 V
T_C = +25°C	tional	"	53	"	"	L	"	"	"	"	"	"	"	A	"	"	"	B	"
	tests	"	54	"	"	H	"	"	"	"	"	"	"	B	"	"	"	A	"
	5/	"	55	"	"	H	"	"	"	"	"	"	"	A	"	"	"	A	"
		"	56	A	H	L	"	"	"	"	"	"	"	B	"	"	"	B	"
		"	57	"	"	L	"	"	"	"	"	"	"	A	"	"	"	B	"
		"	58	"	"	H	"	"	"	"	"	"	"	B	"	"	"	A	"
		"	59	"	"	H	"	"	"	"	"	"	"	A	"	"	"	A	"
		"	60	B	L	L	"	"	H	"	"	"	A	B	"	"	"	B	"
		"	61	"	"	L	"	"	"	"	"	"	"	A	"	"	"	B	"
		"	62	"	"	H	"	"	"	"	"	"	"	B	"	"	"	A	"
		"	63	"	"	H	"	"	"	"	"	"	"	A	"	"	"	A	"
		"	64	A	H	L	"	"	"	"	"	"	"	B	"	"	"	B	"
		"	65	"	"	L	"	"	"	"	"	"	"	A	"	"	"	B	"
		"	66	"	"	H	"	"	"	"	"	"	"	B	"	"	"	A	"
		"	67	"	"	H	"	"	"	"	"	"	"	A	"	"	"	A	"
		"	68	B	L	L	"	"	L	H	"	A	B	B	"	"	"	B	"
		"	69	"	"	L	"	"	"	"	"	"	"	A	"	"	"	B	"
		"	70	"	"	H	"	"	"	"	"	"	"	B	"	"	"	A	"
		"	71	"	"	H	"	"	"	"	"	"	"	A	"	"	"	A	"
		"	72	A	H	L	"	"	"	"	"	"	"	B	"	"	"	B	"
		"	73	"	"	L	"	"	"	"	"	"	"	A	"	"	"	B	"
		"	74	"	"	H	"	"	"	"	"	"	"	B	"	"	"	A	"
		"	75	"	"	H	"	"	"	"	"	"	"	A	"	"	"	A	"
		"	76	B	L	L	"	"	H	"	"	"	A	B	"	"	"	B	"
		"	77	"	"	L	"	"	"	"	"	"	"	A	"	"	"	B	"
		"	78	"	"	H	"	"	"	"	"	"	"	B	"	"	"	A	"
		"	79	"	"	H	"	"	"	"	"	"	"	A	"	"	"	A	"
		"	80	A	H	L	"	"	"	"	"	"	"	B	"	"	"	B	"
		"	81	"	"	L	"	"	"	"	"	"	"	A	"	"	"	B	"
		"	82	"	"	H	"	"	"	"	"	"	"	B	"	"	"	A	"
		"	83	"	L	L	"	"	L	L	"	"	"	B	"	"	A	"	"
		"	84	"	"	"	"	"	"	"	"	"	"	A	"	"	A	"	"
		"	85	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	"
		"	86	"	"	"	B	"	"	"	"	"	"	"	"	L	"	"	"
		"	87	"	H	H	A	"	H	H	"	"	"	"	"	H	"	"	"
		"	88	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	89	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	90	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	91	"	L	H	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	92	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	93	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	94	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	95	"	H	H	A	"	L	"	"	"	"	"	"	"	"	"	"
		"	96	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	97	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	98	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	99	"	L	H	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	100	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	101	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	102	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	103	"	H	H	A	"	H	L	"	"	"	"	"	"	"	"	"
		"	104	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	105	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	106	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	107	"	L	H	A	"	"	"	"	"	"	"	"	"	"	"	"

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 08 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Count down	Count Up	Q_C	Q_D	GND	D	C	Load	Ripple Carry	Borrow	Clear	A	V_{CC}
7	Func-	3014	108	A 6/	L	H	B 6/	A	H	L	GND	A	A	A	H	H	B 8/	A	4.5 V
T_C = +25°C	tional	"	109	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
	tests	"	110	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
	5/	"	111	"	H	H	A	"	L	"	"	"	"	"	"	"	"	"	"
		"	112	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	113	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	114	"	"	L	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	115	"	L	H	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	116	"	"	H	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	117	"	"	L	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	118	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	119	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	120	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	121	"	H	L	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	122	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	123	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	124	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	125	"	L	L	"	A	H	"	"	"	"	"	"	"	"	"	"
		"	126	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	127	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	128	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	129	"	H	L	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	130	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	131	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	132	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	133	"	L	L	"	A	L	H	"	"	"	"	"	"	"	"	"
		"	134	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	135	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	136	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	137	"	H	L	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	138	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	139	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	140	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	141	"	L	L	"	A	H	"	"	"	"	"	"	"	"	"	"
		"	142	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	143	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	144	"	"	H	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	145	"	H	L	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	146	"	"	L	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	147	"	"	H	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	148	"	"	H	"	B	"	"	"	"	"	"	L	"	"	"	"
		"	149	"	L	L	"	A	L	L	"	"	"	"	H	"	"	"	"
		"	150	"	"	"	"	A	"	"	"	"	"	"	"	"	A	"	"
		"	151	"	"	"	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	152	"	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	153	"	"	"	B	"	"	"	"	"	"	"	"	L	"	"	"
		"	154	"	"	"	A	"	"	"	"	"	"	"	"	H	"	"	"
		"	155	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	"
		"	156	"	H	H	"	"	H	H	"	"	"	B	"	"	"	"	"
		"	157	"	"	"	"	B	"	"	"	"	"	"	L	"	"	"	"
		"	158	"	"	"	"	A	"	"	"	"	"	"	H	"	"	"	"
		"	159	"	"	"	B	A	"	"	"	"	"	"	"	"	"	"	"
		"	160	"	"	"	A	A	"	"	"	"	"	"	"	"	"	"	"
8	Repeat subgroup 7 at T_C = +125 and T_C = -55°C.																		

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 07 and 08 – Continued.
Terminal conditions (pins not designated may be high ≥ 2.0 V; or low ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Me
			Case 1/ 2		2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20	
			(Device type)		B	Q_B	Q_A	Count down	Count up	Q_C	Q_D	GND	D	C	Load	Ripple carry	Borrow	Clear	A	V_{CC}	te
			07	08																	
9 Tc = +25°C	F_{MAX} 8/	3003 9/	116	161			OUT	5.0 V	IN			GND			5.0 V			GND		5.0 V	Coun
	F_{MAX} 8/	"	117	162			OUT	IN	5.0 V			"			5.0 V			GND		"	Count
	t_{PLH8}	"	118	163			OUT					"			IN			GND	5.0 V	"	Loa
		"	119	164	5.0 V	OUT						"			"			"		"	Loa
		"	120	165						OUT		"		5.0 V	"			"		"	Loa
		"	121	166							OUT	"	5.0 V	"	"			"		"	Loa
	t_{PHL10}	"	122	167			OUT					"			"			GND	GND	"	Loa
		"	123	168	GND	OUT						"			"			"		"	Loa
		"	124	169						OUT		"		GND	"			"		"	Loa
		"	125	170							OUT	"	GND		"			"		"	Loa
	t_{PLH9}	"	126	171			OUT	5.0 V	IN			"			5.0 V			"		"	Coun
		"	127	172		OUT		"	"			"			"			"		"	Coun
		"	128	173				"	"	OUT		"			"			"		"	Coun
		"	129	174				"	"		OUT	"			"			"		"	Coun
		"	130	175				IN	5.0 V		OUT	"			"			"		"	Count
		"	131	176				"	"	OUT		"			"			"		"	Count
		"	132	177		OUT		"	"			"			"			"		"	Count
		"	133	178			OUT	"	"			"			"			"		"	Count
	t_{PHL11}	"	134	179			OUT	5.0 V	IN			"			"			"		"	Coun
		"	135	180		OUT		"	"			"			"			"		"	Coun
		"	136	181				"	"	OUT		"			"			"		"	Coun
		"	137	182				"	"		OUT	"			"			"		"	Coun
		"	138	183				IN	5.0 V		OUT	"			"			"		"	Count
		"	139	184				"	"	OUT		"			"			"		"	Count
		"	140	185		OUT		"	"			"			"			"		"	Count
		"	141	186			OUT	"	"			"			"			"		"	Count
	t_{PHL12}	"	142	187			OUT					"			10/			IN	5.0 V	"	Cle
		"	143	188	5.0 V	OUT						"			"			"		"	Cle
		"	144	189						OUT		"		5.0 V	"			"		"	Cle
		"	145	190							OUT	"	5.0 V		"			"		"	Cle

See footnotes at end of device types 07 and 08.

TABLE III. Group A inspection for device types 07 and 08 – Continued.
Terminal conditions (pins not designated may be high ≥ 2.0 V; or low ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	Me
			Case 1/ 2		2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20	
			(Device type)		B	Q_B	Q_A	Count down	Count up	Q_C	Q_D	GND	D	C	Load	Ripple carry	Borrow	Clear	A	V_{CC}	te
			07	08																	
9 Tc = +25°C	F_{MAX} 8/	3003 9/	146	191	Same terminal conditions as for subgroup 9.																Coun
	F_{MAX} 8/	"	147	192																	Count
	t_{PLH8}	"	148	193																	Loa
		"	149	194																	Loa
		"	150	195																	Loa
		"	151	196																	Loa
	t_{PHL10}	"	152	197																	Loa
		"	153	198																	Loa
		"	154	199																	Loa
		"	155	200																	Loa
	t_{PLH9}	"	156	201																	Coun
		"	157	202																	Coun
		"	158	203																	Coun
		"	159	204																	Coun
		"	160	205																	Count
		"	161	206																	Count
		"	162	207																	Count
		"	163	208																	Count
	t_{PHL11}	"	164	209																	Coun
		"	165	210																	Coun
		"	166	211																	Coun
		"	167	212																	Coun
		"	168	213																	Count
		"	169	214																	Count
		"	170	215																	Count
		"	171	216																	Count
	t_{PHL12}	"	172	217																	Cle
		"	173	218																	Cle
		"	174	219																	Cle
		"	175	220																	Cle
11	Same tests, terminal conditions, and limits as for subgroup 10, except T_C = -55°C.																				

See footnotes at end of device types 07 and 08.

1/ Case 2, pins not referenced are N/C.

2/ Apply 0.7 V for device type 07; apply 2.0 V for device type 08.

3/ I_{IL} limits (μA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
		-160/-400	-160/-400	-160/-400	-100/-340	-100/-340	-120/-360	-135/-370
I_{IL9}	A	"	"	"	"	"	"	"
	B	"	"	"	"	"	"	"
	C	"	"	"	"	"	"	"
	D	"	"	"	"	"	"	"
I_{IL10}	Load	-100/-340	"	-150/-380	-120/-360	-120/-360	"	-100/-340
I_{IL11}	Clear	-160/-400	"	-150/-380	"	"	"	-135/-370
	Count up	"	"	"	"	"	"	"
	Count down	"	"	"	"	"	"	"

4/ I_{OS} limits (mA) min/max values for circuits shown: -15/-100 for circuits A, C, D, E, F, and G and –15/-110 for circuit B.

5/ Only a summary of attributes data is required.

6/ A = 3.0 V minimum; B = 0.0 V or GND.

7/ H > 1.5 V; L < 1.5 V; X = don't care.

8/ F_{MAX} minimum limit specified is the frequency of the input pulse. The output frequency shall be one-half of the input frequency.

9/ See figure 8 for device type 07 and figure 9 for device type 08.

10/ Apply momentary GND, then 4.5 V minimum prior to input pulses. Maintain 4.5 V minimum for measurement.

TABLE III. Group A inspection for device types 09 and 13 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Enable G	Down/ up	Q_C	Q_D	GND	D	C	Load	Max/ Min	Ripple carry	Clock	A	V_{CC}
1	V_{OL}	3007	1	0.7 V	4 mA						GND			0.7 V					4.5 V
Tc = +25°C		"	2			4 mA					"			"				0.7 V	"
		"	3						4 mA		"		0.7 V	"					"
		"	4							4 mA	"	0.7 V		"					"
		"	5	2.0 V				2.0 V			"			"	4 mA				"
		"	6	2/			0.7 V	0.7 V			"	2.0 V	2/	"		4 mA	0.7 V	2.0 V	"
	V_{OH}	3006	7	2.0 V	-0.4 mA						"			"					"
		"	8			-0.4 mA					"			"				2.0 V	"
		"	9						-0.4 mA		"		2.0 V	"					"
		"	10							-0.4 mA	"	2.0 V		"					"
		"	11	0.7 V				2.0 V			"	0.7 V	0.7 V	"	-0.4 mA			0.7 V	"
		"	12				2.0 V				"			"		-0.4 mA			"
	V_{IC}		13	-18 mA							"								"
			14				-18 mA				"								"
			15					-18 mA			"								"
			16								"	-18 mA							"
			17								"		-18 mA						"
			18								"			-18 mA					"
			19								"						-18 mA		"
			20								"							-18 mA	"
	I_{IL7}	3009	21				0.4 V	5.5 V			"								5.5 V
	I_{IL8}	"	22	0.4 V							"			GND					"
		"	23					0.4 V			"								"
		"	24								"	0.4 V		"					"
		"	25								"		0.4 V	"					"
		"	26								"			0.4 V					"
		"	27								"						0.4 V		"
		"	28								"			GND				0.4 V	"
	I_{IH15}	3010	29				2.7 V				"								"
	I_{IH16}	"	30				5.5 V				"								"
	I_{IH17}	"	31	2.7 V							"			5.5 V					"
		"	32					2.7 V			"								"
		"	33								"	2.7 V		5.5 V					"
		"	34								"		2.7 V	5.5 V					"
		"	35								"			2.7 V					"
		"	36								"						2.7 V		"
		"	37								"			5.5 V				2.7 V	"

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 09 and 13 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Enable G	Down/ Up	Q_C	Q_D	GND	D	C	Load	Max/ Min	Ripple Carry	Clock	A	V_{CC}
1 T_C = +25°C	I_{IH18}	3010	38	5.5 V							GND			5.5 V					5.5 V
		"	39					5.5 V			"								"
		"	40								"	5.5 V		5.5 V					"
		"	41								"		5.5 V	"					"
		"	42								"			"					"
		"	43								"						5.5 V		"
		"	44								"			5.5 V				5.5 V	"
	I_{OS}	3011	45	5.5 V	GND						"			GND					"
		"	46			GND					"			"				5.5 V	"
		"	47						GND		"		5.5 V	"					"
		"	48							GND	"	5.5 V		"					"
		"	49	GND				5.5 V			"	GND	GND	"	GND			GND	"
		"	50				5.5 V				"					GND			"
	I_{CC}	3005	51	GND			GND	GND			"	GND	GND	GND			GND	GND	"
2	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = +125°C and V_{IC} tests are omitted.																		
3	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = -55°C and V_{IC} tests are omitted.																		

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 09 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Enable G	Down/ up	Q_C	Q_D	GND	D	C	Load	Max/Min	Ripple Carry	Clock	A	V_{CC}
7	Func-	3014	52	A 6/	H	H	B 6/	B	H	H	GND	A	A	B	H	H	A	A	4.5 V
Tc = +25°C	tional		53	"	"	"	A	"	"	"	"	"	"	B	"	"	"	"	"
	tests		54	"	"	"	"	"	"	"	"	"	"	A	"	"	"	"	"
	5/		55	B	"	"	"	"	"	"	"	B	B	"	"	"	B	B	"
			56	B	"	"	"	"	"	"	"	"	"	"	"	"	A	"	"
			57	B	"	"	B	"	"	"	"	"	"	"	"	"	A	"	"
			58	A	"	"	"	"	"	"	"	A	A	"	"	L	B	A	"
			59	"	L	L	"	"	L	L	"	"	"	"	L	H	A	"	"
			60	"	"	L	"	"	"	"	"	"	"	"	"	"	B	"	"
			61	"	"	H	"	"	"	"	"	"	"	"	"	"	A	B	"
			62	"	"	H	"	"	"	"	"	"	"	"	"	"	B	"	"
			63	B	H	L	"	"	"	"	"	B	B	"	"	"	A	"	"
			64	A	"	L	"	"	"	"	"	A	A	"	"	"	B	A	"
			65	"	"	H	"	"	"	"	"	"	A	"	"	"	A	A	"
			66	"	"	H	"	"	"	"	"	"	B	"	"	"	B	B	"
			67	"	L	L	"	"	H	"	"	"	"	"	"	"	A	B	"
			68	"	"	L	"	"	"	"	"	B	"	"	"	"	B	A	"
			69	"	"	H	"	"	"	"	"	A	A	"	"	"	A	B	"
			70	"	"	H	"	"	"	"	"	"	B	"	"	"	B	B	"
			71	"	H	L	"	"	"	"	"	"	A	"	"	"	A	A	"
			72	"	"	L	"	"	"	"	"	B	"	"	"	"	B	B	"
			73	"	"	H	"	"	"	"	"	B	"	"	"	"	A	A	"
			74	B	"	H	"	"	"	"	"	A	B	"	"	"	B	B	"
			75	B	L	L	"	"	L	H	"	A	B	"	"	"	A	B	"
			76	A	"	L	"	"	"	"	"	B	A	"	"	"	B	A	"
			77	"	"	H	"	"	"	"	"	"	"	"	"	"	A	A	"
			78	"	"	H	"	"	"	"	"	"	"	"	"	"	B	B	"
			79	B	H	L	"	"	"	"	"	A	B	"	"	"	A	A	"
			80	"	"	L	"	"	"	"	"	"	B	"	"	"	B	"	"
			81	"	"	H	"	"	"	"	"	"	A	"	"	"	A	"	"
			82	"	"	H	"	"	"	"	"	"	A	"	"	"	B	B	"
			83	"	L	L	"	"	H	"	"	"	B	"	"	"	A	"	"
			84	"	"	L	"	"	"	"	"	B	B	"	"	"	B	"	"
			85	A	"	H	"	"	"	"	"	A	A	"	"	"	A	A	"
			86	B	"	H	"	"	"	"	"	B	B	"	"	"	B	B	"
			87	A	H	L	"	"	"	"	"	A	A	"	"	"	A	A	"
			88	B	"	L	"	"	"	"	"	B	B	"	"	"	B	"	"
			89	A	"	H	"	"	"	"	"	A	A	"	H	"	A	"	"
			90	B	"	H	"	"	"	"	"	B	B	"	H	L	B	B	"
			91	A	L	L	"	"	L	L	"	A	A	"	L	H	A	A	"
			92	B	"	"	"	A	"	"	"	B	B	"	H	"	"	B	"
			93	A	"	"	A	"	"	"	"	A	A	"	"	"	"	A	"
			94	B	"	"	"	"	"	"	"	B	B	"	"	"	B	B	"
			95	A	"	"	"	"	"	"	"	B	A	"	"	"	A	"	"
			96	B	"	"	B	"	"	"	"	A	B	"	"	"	A	"	"
			97	A	"	"	"	"	"	"	"	"	B	"	"	L	B	"	"
			98	A	H	H	"	"	H	H	"	"	A	"	L	H	A	A	"
			99	B	"	H	"	"	"	"	"	B	B	"	"	"	B	B	"
			100	B	"	L	"	"	"	"	"	B	B	"	"	"	A	B	"
			101	A	"	L	"	"	"	"	"	A	A	"	"	"	B	A	"

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 09 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Enable G	Down/ up	Q_C	Q_D	GND	D	C	Load	Max/Min	Ripple Carry	Clock	A	V_{CC}
7 Tc = +25°C	Func-tional tests 5/	3014	102	A 6/	L	H	B 6/	A	H	H	GND	B	A	A	L	H	A	B	4.5 V
		"	103	B	"	H	"	"	"	"	"	A	A	"	"	"	B	B	"
		"	104	A	"	L	"	"	"	"	"	B	B	"	"	"	A	A	"
		"	105	A	"	L	"	"	"	"	"	B	B	"	"	"	B	A	"
		"	106	A	H	H	"	"	L	"	"	A	A	"	"	"	A	B	"
		"	107	B	"	H	"	"	"	"	"	A	B	"	"	"	B	A	"
		"	108	B	"	L	"	"	"	"	"	B	A	"	"	"	A	A	"
		"	109	A	"	L	"	"	"	"	"	A	B	"	"	"	B	A	"
		"	110	A	L	H	"	"	"	"	"	B	A	"	"	"	A	B	"
		"	111	A	"	H	"	"	"	"	"	B	A	"	"	"	B	B	"
		"	112	B	"	L	"	"	"	"	"	A	B	"	"	"	A	A	"
		"	113	B	"	L	"	"	"	"	"	B	B	"	"	"	B	A	"
		"	114	B	H	H	"	"	H	L	"	B	B	"	"	"	A	B	"
		"	115	A	"	H	"	"	"	"	"	A	A	"	"	"	B	A	"
		"	116	B	"	L	"	"	"	"	"	B	B	"	"	"	A	B	"
		"	117	A	"	L	"	"	"	"	"	A	A	"	"	"	B	B	"
		"	118	B	L	H	"	"	"	"	"	B	B	"	"	"	A	A	"
		"	119	A	"	H	"	"	"	"	"	A	A	"	"	"	B	B	"
		"	120	A	"	L	"	"	"	"	"	B	B	"	"	"	A	A	"
		"	121	A	"	L	"	"	"	"	"	B	B	"	"	"	B	"	"
		"	122	B	H	H	"	"	L	"	"	B	A	"	"	"	A	"	"
		"	123	B	"	H	"	"	"	"	"	A	A	"	"	"	B	"	"
		"	124	B	"	L	"	"	"	"	"	B	B	"	"	"	A	"	"
		"	125	A	"	L	"	"	"	"	"	B	B	"	"	"	B	B	"
		"	126	A	L	H	"	"	"	"	"	A	B	"	"	"	A	A	"
		"	127	A	"	H	"	"	"	"	"	A	A	"	"	"	B	A	"
		"	128	B	"	L	"	"	"	"	"	B	B	"	H	"	A	B	"
		"	129	A	"	L	"	"	"	"	"	A	A	"	H	L	B	A	"
		"	130	B	H	H	"	"	H	H	"	B	B	"	L	H	A	B	"
		"	131	A	"	"	"	"	"	"	"	A	A	B	L	H	A	A	"
		"	132	"	"	"	"	B	"	"	"	"	"	"	H	L	B	"	"
		"	133	"	"	"	"	"	"	"	"	"	"	"	"	H	A	"	"
		"	134	"	"	"	A	"	"	"	"	"	"	"	"	"	B	"	"
		"	135	B	L	L	"	"	L	L	"	B	B	"	L	"	"	B	"
		"	136	B	L	H	"	"	H	L	"	B	A	"	"	"	"	A	"
		"	137	A	H	L	"	"	L	H	"	A	B	"	"	"	"	B	"
		"	138	B	L	H	"	A	H	L	"	B	A	"	"	"	"	A	"
		"	139	A	H	L	B	"	L	H	"	A	B	"	"	"	"	B	"
		"	140	B	L	H	"	"	H	L	"	B	A	"	"	"	"	A	"
		"	141	A	H	L	"	"	L	H	"	A	B	"	"	"	A	B	"
		"	142	A	"	"	"	"	"	"	"	A	B	A	"	"	"	B	"
		"	143	B	"	"	"	"	"	"	"	B	A	"	"	"	"	A	"
		"	144	"	"	"	"	B	"	"	"	"	"	"	"	"	"	"	"
		"	145	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	146	"	"	"	B	"	"	"	"	"	"	"	"	"	"	"	"
		"	147	"	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"
		"	148	"	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"
		"	149	A	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"
		"	150	"	"	"	"	"	H	L	"	"	"	B	"	"	B	B	"
		"	151	"	"	"	"	"	H	L	"	"	"	A	"	"	B	B	"
8	Repeat subgroup 7 at T_C = +125 and T_C = -55°C.																		

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 13 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases 1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Enable G	Down/ up	Q_C	Q_D	GND	D	C	Load	Max/Min	Ripple carry	Clock	A	V_{CC}
7	Func-	3014	52	B 6/	L	H	A 6/	B	L	H	GND	A	B	B 6/	H	H	B	A	4.5 V
Tc = +25°C	tional		53	"	"	"	"	"	"	"	"	"	"	A	"	"	B	"	"
	tests		54	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"	"
	5/		55	"	"	"	B	"	"	"	"	"	"	"	"	"	A	"	"
			56	"	"	"	"	"	"	"	"	"	"	"	"	L	B	"	"
			57	"	"	L	"	"	"	L	"	"	"	"	L	H	A	"	"
			58	A	"	L	"	"	"	"	"	"	A	"	"	"	B	"	"
			59	A	"	H	"	"	"	"	"	"	"	"	"	"	A	"	"
			60	B	"	H	"	"	"	"	"	"	"	"	"	"	B	B	"
			61	B	H	L	"	"	"	"	"	B	B	"	"	"	A	B	"
			62	A	"	L	"	"	"	"	"	A	A	"	"	"	B	A	"
			63	B	"	H	"	"	"	"	"	"	B	"	"	"	A	"	"
			64	"	"	H	"	"	"	"	"	"	B	"	"	"	B	"	"
			65	"	L	L	"	"	H	"	"	"	A	"	"	"	A	B	"
			66	A	"	L	"	"	"	"	"	"	A	"	"	"	B	"	"
			67	B	"	H	"	"	"	"	"	B	B	"	"	"	A	"	"
			68	A	"	H	"	"	"	"	"	"	A	"	"	"	B	"	"
			69	"	H	L	"	"	"	"	"	"	B	"	"	"	A	"	"
			70	"	"	L	"	"	"	"	"	"	B	"	"	"	B	"	"
			71	"	"	H	"	"	"	"	"	A	A	"	"	"	A	A	"
			72	B	"	H	"	"	"	"	"	B	B	"	"	"	B	B	"
			73	A	L	L	"	"	L	H	"	A	A	"	"	"	A	A	"
			74	A	"	L	"	"	"	"	"	A	A	"	"	"	B	A	"
			75	B	"	H	"	"	"	"	"	B	B	"	H	"	A	B	"
			76	B	"	H	"	"	"	"	"	"	"	"	H	L	B	"	"
			77	B	"	L	"	"	"	L	"	"	"	"	L	H	A	"	"
			78	A	"	L	"	"	"	"	"	A	A	"	"	"	B	A	"
			79	B	"	H	"	"	"	"	"	A	B	"	"	"	A	A	"
			80	A	"	"	A	A	"	"	"	B	A	"	"	"	B	B	"
			81	A	"	"	"	"	"	"	"	B	A	"	"	"	A	B	"
			82	B	"	"	"	"	"	"	"	A	B	"	"	"	B	A	"
			83	"	"	"	"	"	"	"	"	"	B	"	"	"	A	A	"
			84	"	"	"	B	"	"	"	"	"	A	"	"	"	B	B	"
			85	"	"	L	"	"	"	"	"	"	A	"	H	"	A	"	"
			86	"	"	L	"	"	"	"	"	B	B	"	H	L	B	"	"
			87	A	"	H	"	"	"	H	"	"	"	"	L	H	A	A	"
			88	"	"	H	"	"	"	"	"	"	"	"	L	H	B	"	"
			89	"	"	L	"	"	"	"	"	"	"	"	"	"	A	"	"
			90	"	"	L	"	"	"	"	"	A	A	"	"	"	B	"	"
			91	"	H	H	"	"	H	L	"	"	"	"	"	"	A	"	"
			92	"	"	H	"	"	"	"	"	"	"	"	"	"	B	B	"
			93	"	"	L	"	"	"	"	"	"	"	"	"	"	A	"	"
			94	"	"	L	"	"	"	"	"	B	B	"	"	"	B	"	"
			95	"	L	H	"	"	"	"	"	"	B	"	"	"	A	"	"
			96	B	"	H	"	"	"	"	"	"	A	"	"	"	B	A	"
			97	B	"	L	"	"	"	"	"	"	"	"	"	"	A	B	"
			98	A	"	L	"	"	"	"	"	A	"	"	"	"	B	B	"
			99	"	H	H	"	"	L	"	"	"	"	"	"	"	A	A	"
			100	"	"	H	"	"	"	"	"	"	"	"	"	"	B	"	"
			101	"	"	L	"	"	"	"	"	"	"	"	"	"	A	"	"

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 13 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
			Cases1/ 2	2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20
			Test no.	B	Q_B	Q_A	Enable G	Down/ up	Q_C	Q_D	GND	D	C	Load	Max/Min	Ripple Carry	Clock	A	V_{CC}
7	Func-	3014	102	B 6/	H	L	B 6/	A 6/	L	L	GND	B	B 6/	A	L	H	B	B	4.5 V
Tc = +25°C	tional	"	103	"	L	H	"	"	"	"	"	"	"	"	"	"	A	B	"
	tests	"	104	"	"	H	"	"	"	"	"	"	"	"	"	"	B	A	"
	5/	"	105	"	"	L	"	"	"	"	"	"	"	"	H	"	A	A	"
		"	106	A	"	L	A	"	"	"	"	A	A	"	"	"	A	B	"
		"	107	A	"	"	"	"	"	"	"	A	A	"	"	"	B	"	"
		"	108	B	"	"	"	"	"	"	"	B	B	"	"	"	A	"	"
		"	109	"	"	"	B	"	"	"	"	"	"	"	"	"	A	"	"
		"	110	"	"	"	"	"	"	"	"	"	"	"	"	L	B	"	"
		"	111	A	"	H	"	"	"	H	"	A	A	"	L	H	A	A	"
		"	112	"	"	H	"	"	"	"	"	"	"	"	"	"	B	B	"
		"	113	"	"	L	"	"	"	"	"	"	"	"	"	"	A	A	"
		"	114	B	"	H	"	"	"	"	"	"	B	B	"	"	"	"	"
		"	115	"	"	"	"	"	"	"	"	"	"	A	"	"	"	"	"
		"	116	"	"	"	"	"	"	"	"	B	"	"	"	"	"	B	"
		"	117	"	"	"	A	"	"	"	"	"	"	"	"	"	"	"	"
		"	118	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	"
		"	119	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"	"
		"	120	"	"	"	"	B	"	"	"	"	"	"	H	"	A	"	"
		"	121	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	"
		"	122	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"	"
		"	123	A	"	"	B	"	"	"	"	A	A	"	"	"	A	A	"
		"	124	"	"	"	"	"	"	"	"	"	"	"	"	L	B	"	"
		"	125	"	"	L	"	"	L	L	"	"	"	"	L	H	A	"	"
		"	126	B	"	H	"	"	H	"	"	B	"	B	"	"	A	"	"
		"	127	"	"	"	"	"	"	"	"	"	"	"	"	"	B	"	"
		"	128	"	"	"	"	"	"	"	"	"	"	"	"	"	A	"	"
		"	129	"	"	"	"	"	"	"	"	"	"	A	"	"	"	"	"
		"	130	A	"	"	"	"	"	"	"	A	B	"	"	"	"	B	"
		"	131	A	"	"	"	"	"	"	"	"	"	"	"	"	B	"	"
		"	132	B	"	L	"	"	L	H	"	"	"	B	"	"	B	"	"
		"	133	"	"	"	"	"	"	"	"	"	"	B	"	"	A	"	"
		"	134	"	"	"	A	A	"	"	"	"	"	A	"	"	A	"	"
		"	135	"	"	"	"	"	"	"	"	B	A	"	"	"	B	A	"
		"	136	"	"	"	"	"	"	"	"	B	A	"	"	"	A	"	"
		"	137	"	"	H	"	"	"	"	"	A	B	B	"	"	"	"	"
		"	138	A	H	L	"	"	H	L	"	B	A	"	"	"	"	B	"
		"	139	A	H	H	"	"	H	"	"	"	A	"	"	"	"	A	"
		"	140	B	L	L	"	B	L	"	"	"	B	"	"	"	"	B	"
		"	141	B	"	"	B	"	"	"	"	"	B	A	"	"	"	B	"
		"	142	A	"	"	"	"	"	"	"	A	A	"	"	"	"	A	"
		"	143	"	"	"	"	A	"	"	"	"	"	"	H	"	"	"	"
		"	144	"	"	"	"	"	"	"	"	"	"	"	H	L	B	"	"
		"	145	"	"	H	"	"	"	H	"	B	"	"	L	H	A	B	"
		"	146	"	"	"	"	B	"	"	"	B	"	"	H	H	A	B	"
		"	147	"	"	"	"	"	"	"	"	A	"	"	H	L	B	A	"
		"	148	"	"	L	"	"	"	L	"	"	"	"	L	H	A	"	"
		"	149	"	H	H	"	"	H	H	"	"	"	B	H	H	A	"	"
8	Repeat subgroup 7 at T_C = +125 and T_C = -55°C.																		

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 09 and 13 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	M
			Case 1/ 2		2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20	
			(Device type)		B	Q_B	Q_A	Enable G	Down/ up	Q_C	Q_D	GND	D	C	Load	Max/Min	Ripple carry	Clock	A	V_{CC}	
			09	13																	
9 Tc = +25°C	F_{MAX} 8/	3003 9/	152	150			OUT	GND	GND			GND			5.0 V			IN		5.0 V	C
	t_{PLH10}	"	153	151			OUT					"			IN			GND	5.0 V	"	Lo
		"	154	152	5.0 V	OUT						"			"			"		"	Lo
		"	155	153						OUT		"		5.0 V	"			"		"	Lo
		"	156	154							OUT	"	5.0 V		"			"		"	Lo
	t_{PHL13}	"	157	155			OUT					"			"			"	GND	"	Lo
		"	158	156	GND	OUT						"			"			"		"	Lo
		"	159	157						OUT		"		GND	"			"		"	Lo
		"	160	158							OUT	"	GND		"			"		"	Lo
	t_{PLH11}	"	161	159			OUT	GND	GND			"			5.0 V			IN		"	C
		"	162	160		OUT		"	"			"			"			"		"	C
		"	163	161				"	"	OUT		"			"			"		"	C
		"	164	162				"	"		OUT	"			"			"		"	C
	t_{PHL14}	"	165	163			OUT	"	"			"			"			"		"	C
		"	166	164		OUT		"	"			"			"			"		"	C
		"	167	165				"	"	OUT		"			"			"		"	C
		"	168	166				"	"		OUT	"			"			"		"	C
	t_{PLH12}	"	169	167				"	"			"			"	OUT		"		"	Ck t
	t_{PHL15}	"	170	168				"	"			"			"	OUT		"		"	Ck t

See footnotes at end of device types 09 and 13.

TABLE III. Group A inspection for device types 09 and 13 – Continued.
Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E, F		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	M
			Case 1/ 2		2	3	4	5	7	8	9	10	12	13	14	15	17	18	19	20	
			(Device type)		B	Q_B	Q_A	Enable G	Down/ up	Q_C	Q_D	GND	D	C	Load	Max/Min	Ripple carry	Clock	A	V_{CC}	
			09	13																	
10 Tc = +125°C	F_{MAX} 8/	3003 9/	171	169	Same terminal conditions as for subgroup 9.																C
	t_{PLH10}	"	172	170																	Lo
		"	173	171																	Lo
		"	174	172																	Lo
		"	175	173																	Lo
	t_{PHL13}	"	176	174																	Lo
		"	177	175																	Lo
		"	178	176																	Lo
		"	179	177																	Lo
	t_{PLH11}	"	180	178																	C
		"	181	179																	C
		"	182	180																	C
		"	183	181																	C
	t_{PHL14}	"	184	182																	C
		"	185	183																	C
		"	186	184																	C
		"	187	185																	C
	t_{PLH12}	"	188	186																	Ck
	t_{PHL15}	"	189	187																	Cou
11	Same tests, terminal conditions, and limits as for subgroup 10, except T_C = -55°C.																				

See footnotes at end of device types 09 and 13.

1/ Case 2, pins not referenced are N/C.

2/ Apply 2.0 for device type 09; apply 0.7 V for device type 13.

3/ I_{IL} limits (µA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I_{IL7}	Enable G	-360/-1080	-160/-400	-360/-1080	-360/-1080	-360/-1080	-360/-1080	-360/-1080
I_{IL8}	A, B, C, D	-130/-400	-160/-400	-160/-400	-160/-400	-120/-360	-120/-360	-120/-360
	Down/up	"	"	-150/-380	"	"	"	"
	Clock	"	"	"	"	"	"	"
	Load	-100/-340	"	"	-100/-340	"	"	"

4/ I_{OS} limits (mA) min/max values for circuits shown: -15/-100 for circuits A, C, D, E, F, and G and –15/-110 for circuit B.

5/ Only a summary of attributes data is required.

6/ A = 3.0 V minimum; B = 0.0 V or GND.

7/ H > 1.5 V; L < 1.5 V; X = don't care.

8/ F_{MAX} minimum limit specified is the frequency of the input pulse. The output frequency shall be one-half of the input frequency.

9/ See figure 10 for device type 09 and figure 12 for device type 13.

TABLE III. Group A inspection for device types 10.

Terminal conditions (pins not designated may be H ≥ 2.0 V; or L ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A, B, C, D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Measur termin
			Cases 1/ 2	2	3	4	6	8	9	10	12	13	14	16	18	19	20	
			Test no.	B	NC	NC	NC	V_{CC}	R_O(1)	R_O(2)	Q_D	Q_C	GND	Q_B	Q_A	NC	A	
1 Tc = +25°C	V_{OL}	3007	1	GND				4.5 V	2.0 V	2.0 V			GND		4 mA		2.0 V	Q_A
		"	2	2.0 V				"	"	"			"	4 mA	+I_{IL3} (max)		GND	Q_B
		"	3	"				"	"	"			"				"	Q_C
		"	4	"				"	"	"	4 mA		"				"	Q_D
	V_{OH}	3006	5	GND				"	2/	2/			"		-0.4 mA		2/ 3/	Q_A
		"	6	2/ 3/				"	"	"			"	-0.4 mA			GND	Q_B
		"	7	2/ 4/				"	"	"		-0.4 mA	"				"	Q_C
		"	8	2/ 5/				"	"	"	-0.4 mA		"				"	Q_D
	V_{IC}		9					"					"				-18 mA	A
			10	-18 mA				"					"					B
			11					"	-18 mA				"					R_O(1
			12					"		-18 mA			"					R_O(2
	I_{IL1}	3009	13					5.5 V	0.4 V	5.5 V			"					R_O(1
		"	14					"	5.5 V	0.4 V			"					R_O(2
	I_{IL2}	"	15					"	2/	2/			"				0.4 V	A
	I_{IL3}	"	16	0.4 V				"	"	"			"					B
	I_{IH1}	3010	17					"	2.7 V	GND			"					R_O(1
	I_{IH1}	"	18					"	GND	2.7 V			"					R_O(2
	I_{IH2}	"	19					"	5.5 V	GND			"					R_O(1
	I_{IH2}	"	20					"	GND	5.5 V			"					R_O(2
	I_{IH3}	"	21					"	5.5 V	5.5 V			"				2.7 V	A
	I_{IH4}	"	22					"	"	"			"				5.5 V	A
	I_{IH5}	"	23	2.7 V				"	"	"			"					B
	I_{IH6}	"	24	5.5 V				"	"	"			"					B
	I_{OS}	3011	25	GND				"	2/	2/			"		GND		2/ 3/	Q_A
		"	26	2/ 3/				"	"	"			"	GND			GND	Q_B
		"	27	2/ 4/				"	"	"		GND	"				"	Q_C
		"	28	2/ 5/				"	"	"	GND		"				"	Q_D
	I_{CC}	3005	29	GND				"					"					V_{CC}
2	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = +125°C and V_{IC} tests are omitted.																	
3	Same tests, terminal conditions, and limits as for subgroup 1, except T_C = -55°C and V_{IC} tests are omitted.																	

See footnotes at end of device type 10.

TABLE III. Group A inspection for device type 10– Continued.
Terminal conditions (pins not designated may be high ≥ 2.0 V; or low ≤ 0.7 V; or open).

Subgroup	Symbol	MIL-STD-883 method	Cases E A, B, C, D	1	2	3	4	5	6	7	8	9	10	11	12	13	14	Measu
			Cases1/ 2	2	3	4	6	8	9	10	12	13	14	16	18	19	20	
			Test no.	B	NC	NC	NC	V_{CC}	$R_O(1)$	$R_O(2)$	Q_D	Q_C	GND	Q_B	Q_A	NC	A	termin
7 Tc = +25°C	Func-Tional tests 8/	3014	30	B 9/				4.5 V	A 9/	A 9/	L	L	GND	L	L		B 9/	
		"	31	A				"	"	"	"	"	"	"	"		"	
		"	32	B				"	"	"	"	"	"	"	"		"	
		"	33	B				"	B	"	"	"	"	"	"		"	
		"	34	A				"	"	"	"	"	"	"	"		"	
		"	35	B				"	"	"	"	"	"	H	"		"	
		"	36	B				"	A	"	"	"	"	L	"		"	
		"	37	B				"	"	X	"	"	"	"	"		"	
		"	38	A				"	"	B	"	"	"	"	"		"	
		"	39	B				"	"	"	"	"	"	H	"		"	
		"	40	A				"	"	"	"	"	"	H	"		"	
		"	41	B				"	"	"	"	H	"	L	"		"	
		"	42	A				"	"	"	"	H	"	"	"		"	
		"	43	B				"	"	"	H	L	"	"	"		"	
		"	44	A				"	"	"	"	"	"	"	"		"	
		"	45	B				"	"	"	"	"	"	H	"		"	
		"	46	A				"	"	"	"	"	"	H	"		"	
		"	47	B				"	"	"	"	H	"	L	"		"	
		"	48	B				"	"	A	L	L	"	"	"		"	
		"	49	B				"	B	"	"	"	"	"	"		"	
		"	50	A				"	"	"	"	"	"	"	"		"	
		"	51	B				"	"	"	"	"	"	H	"		"	
		"	52	A				"	"	"	"	"	"	H	"		"	
		"	53	B				"	"	"	"	H	"	L	"		"	
		"	54	A				"	"	"	"	H	"	"	"		"	
		"	55	B				"	"	"	H	L	"	"	"		"	See 1
		"	56	A				"	"	"	"	"	"	"	"		"	
		"	57	B				"	"	"	"	"	"	H	"		"	
		"	58	A				"	"	"	"	"	"	H	"		"	
		"	59	B				"	"	"	"	H	"	L	"		"	
		"	60	A				"	"	"	"	H	"	"	"		"	
		"	61	B				"	"	"	L	L	"	"	"		"	
		"	62	"				"	"	"	"	"	"	"	"		A	
		"	63	"				"	"	"	"	"	"	"	H		B	
		"	64	"				"	"	"	"	"	"	"	H		A	
		"	65	"				"	"	"	"	"	"	"	L		B	
8	Same tests, terminal conditions, and limits as for subgroup 7, except T_C = +125°C and -55°C.																	
9 Tc = +25°C	F_{MAX}	3003	66					5.0 V	GND				GND		OUT		IN 12/	A to G
	t_{PLH1}	(Fig 11)	67					"	11/	A 9/		OUT	"				IN	A to G
	t_{PHL1}	"	68					"	GND			OUT	"				IN	A to G
	t_{PLH2}	"	69	IN				"	11/	A 9/	OUT		"					B to G
	t_{PHL2}	"	70	IN				"	GND		OUT		"					B to G
10 Tc = +125°C	F_{MAX}	"	71					"	GND				"		OUT		IN 12/	A to G
	t_{PLH1}	"	72					"	11/	A 9/		OUT	"				IN	A to G
	t_{PHL1}	"	73					"	GND			OUT	"				IN	A to G
	t_{PLH2}	"	74	IN				"	11/	A 9/	OUT		"					B to G
	t_{PHL2}	"	75	IN				"	GND		OUT		"					B to G
11	Same tests, terminal conditions, and limits as for subgroup 10, except T_C = -55°C.																	

See footnotes at end of device type 10.

1/ Case 2, pins not referenced are N/C.

2/ Apply 4.5 volts pulse, then ground prior to taking measurements to set device in the desired state. Maintain ground for measurement.

3/ Input pulse must be applied one time after R_O pulse.

4/ Input pulse must be applied twice after R_O pulse.

5/ Input pulse must be applied four times after R_O pulse.

6/ I_{IL} limits (mA) min/max values for circuits shown:

Parameter	Terminals	Circuits						
		A	B	C	D	E	F	G
I_{IL1}	$R_O(1)$ $R_O(2)$	-.12/-.36 “	-.03/-.40 “	-.03/-.40 “	-.03/-.40 “		-.12/-.36 “	
I_{IL2}	A	-0.5/-2.0	-1.0/-2.4	-1.0/-2.4	-1.0/-2.4		-0.5/-2.0	
I_{IL3}	B	-0.7/-3.2	-0.7/-3.2	-0.7/-3.2	-0.4/-1.6		-0.7/-3.2	

7/ I_{OS} limits (mA) min/max values for circuits shown:

Parameter	Measured terminals	Circuits						
		A	B	C	D	E	F	G
I_{OS}	Q_A, Q_B, Q_C, Q_D	-15/-100	-15/-100	-30/-130	-15/-100		-15/-100	

8/ Only a summary of attributes data is required.

9/ A = 3.0 V minimum; B = 0.0 V or GND.

10/ H > 1.5 V; L < 1.5 V; X = don’t care.

11/ Momentary 3.0 V (min), then ground. Maintain ground for measurement.

12/ F_{MAX} min limit specified is the frequency of the input pulse. The output frequency shall be one-half of the input frequency.

13/ The minimum limit for circuit F shall be –150 µA.

5. PACKAGING

5.1 Packaging requirements. For acquisition purposes, the packaging requirements shall be as specified in the contract or order (see 6.2). When actual packaging of materiel is to be performed by DoD or in-house contractor personnel, these personnel need to contact the responsible packaging activity to ascertain packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activity within the Military Service or Defense Agency, or within the military service's system command. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contacting the responsible packaging activity.

6. NOTES

(This section contains information of a general or explanatory nature which may be helpful, but is not mandatory.)

6.1 Intended use. Microcircuits conforming to this specification are intended for original equipment design applications and logistic support of existing equipment.

6.2 Acquisition requirements. Acquisition documents should specify the following:

a. Title, number, and date of the specification.

b. PIN and compliance identifier, if applicable (see 1.2).

c. Requirements for delivery of one copy of the conformance inspection data pertinent to the device inspection lot to be supplied with each shipment by the device manufacturer, if applicable.

d. Requirements for certificate of compliance, if applicable.

e. Requirements for notification of change of product or process to contracting activity in addition to notification to the qualifying activity, if applicable.

f. Requirements for failure analysis (including required test condition of method 5003 of MIL-STD-883), corrective action, and reporting of results, if applicable.

g. Requirements for product assurance options.

h. Requirements for special carriers, lead lengths, or lead forming, if applicable. These requirements shall not affect the part number. Unless otherwise specified, these requirements will not apply to direct purchase by or direct shipment to the Government.

I Requirements for "JAN" marking.

j. Packaging Requirements (see 5.1)

6.3 Superseding information. The requirements of MIL-M-38510 have been superseded to take advantage of the available Qualified Manufacturer Listing (QML) system provided by MIL-PRF-38535. Previous references to MIL-M-38510 in this document have been replaced by appropriate references to MIL-PRF-38535. All technical requirements now consist of this specification and MIL-PRF-38535. The MIL-M-38510 specification sheet number and PIN have been retained to avoid adversely impacting existing government logistics systems and contractor's parts lists.

6.4 Qualification. With respect to products requiring qualification, awards will be made only for products which are, at the time of award of contract, qualified for inclusion in Qualified Manufacturers List QML-38535 whether or not such products have actually been so listed by that date. The attention of the contractors is called to these requirements, and manufacturers are urged to arrange to have the products that they propose to offer to the Federal Government tested for qualification in order that they may be eligible to be awarded contracts or purchase orders for the products covered by this specification. Information pertaining to qualification of products may be obtained from DSCC-VQ, 3990 E. Broad Street, Columbus, Ohio 43123-1199.

6.5 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535, MIL-HDBK-1331, and as follows:

GND ..... Ground zero voltage potential
I_{IN} ..... Current flowing into an input terminal
V_{IC} ..... Input clamp voltage
V_{IN} ..... Voltage level at an input terminal

6.6 Logistic support. Lead materials and finishes (see 3.4) are interchangeable. Unless otherwise specified, microcircuits acquired for Government logistic support will be acquired to device class B (see 1.2.2), lead material and finish A (see 3.4). Longer length leads and lead forming should not affect the part number.

6.7 Substitutability. The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges or reliability factors equivalent to MIL-M-38510 device types and may have slight physical variations in relation to case size. The presence of this information should not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-PRF-38535.

Military device type	Generic-industry type
01	54LS90
02	54LS93
03	54LS160
04	54LS161
05	54LS168
06	54LS169
07	54LS192
08	54LS193
09	54LS191
10	54LS92
11	54LS162
12	54LS163
13	54LS190

6.8 Manufacturers' designation. Manufacturers' circuits which form a part of this specification are designated with an "X" as shown in table IV herein.

TABLE IV. Manufacturers' designation.

Device type	Circuit	A	B	G	C	E	F	D
	Manufacturer	Texas Instruments, Incorporated	Signetics Corp.	National Semi-Conductor Corp.	Raytheon Company	Fairchild Semi-conductor	Motorola, Inc.	Advanced Micro Devices Inc.
	Commercial Type							
01	54LS90	X	X		X	X	X	
02	54LS93	X	X	X	X	X	X	
03	54LS160A	X	X	X	X	X	X	X
04	54LS161A	X	X	X	X	X	X	X
05	54LS168			X		X		
06	54LS169A			X		X		
07	54LS192	X	X	X	X	X	X	X
08	54LS193	X	X	X	X	X	X	X
09	54LS191	X	X	X	X	X	X	X
10	54LS92	X		X	X		X	
11	54LS162A	X	X	X	X	X	X	X
12	54LS163A	X	X	X	X	X	X	X
13	54LS190	X	X	X	X	X	X	X

6.9 Change from previous issue. Asterisks are not used in this revision to identify changes with respect to the previous issue, due to the extensiveness of the changes.

Custodians:
Army - CR
Navy - EC
Air Force - 11
DLA - CC

Preparing activity:
DLA - CC

Review activities:
Army – SM, MI
Navy - AS, CG, MC, SH TD
Air Force – 03, 19, 99

(Project 5962-1996)

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Counter ICs ***category:***

Click to view products by E2v ***manufacturer:***

Other Similar products are found below :

HEF4516BT 069748E 569054R 634844F 74HC40102N 74HCT4024N NLV14040BDR2G TC74HC4040AF(EL,F) TC74VHC4040F(E,K,F 74VHC163FT XD4059 CD4015BF3A 74HC193PW,118 74VHC163FT(BJ) SN54HC4024J 74HC4017D.652 74HC4020D.652 74HC393D.652 74HC4040D.652 74HC4040D.653 74HC4060D.653 74HCT393D.652 74HCT4040D.653 74HC191D.652 74HC4060D.652 74HCT4040D.652 HEF4040BT.652 HEF4060BT.653 HEF4521BT.652 HEF4518BT.652 HEF4520BT.652 HEF4017BT.652 74VHC4020FT(BJ) 74HCT4040PW,118 74HCT193PW,118 74HC393BQ-Q100X SN74AS161NSR 74HC390DB,112 74HC4060D-Q100,118 74HC160D,652 74HC390DB,118 TC74HC7292AP(F) SN74ALS169BDR HEF4060BT-Q100J 74HC4017BQ-Q100X 74HC163PW.112 74HC191PW.112 74HC390PW.112 74HC393DB.118 74HC4024D.652